

DS90UB949-Q1 1080p HDMI to FPD-Link III bridge serializer

1 Features

- AEC-Q100 qualified for automotive applications
 - Device temperature grade 2: -40°C to $+105^{\circ}\text{C}$, T_A
- Supports TMDS clock up to 170 MHz for WUXGA (1920x1200) and 1080p60 resolutions with 24-bit color depth
- Single and dual FPD-Link III outputs
- High-definition multimedia (HDMI) v1.4b inputs
- HDMI-mode DisplayPort (DP++) inputs
- HDMI audio extraction for up to 8 channels
- High-speed back channel supporting GPIO up to 2 Mbps
- Supports up to 15 meters of cable with automatic temperature and aging compensation
- Monitors spread-spectrum input clock to reduce EMI
- I2C (master/slave) with 1-Mbps fast-mode plus
- SPI pass-through interface
- Backward-compatible with DS90UB926Q-Q1 and DS90UB928Q-Q1 FPD-Link III deserializers

2 Applications

- Automotive infotainment:
 - IVI head units and HMI modules
 - Rear seat entertainment systems
 - Digital instrument clusters
- Surveillance cameras
- Consumer input HDMI port

3 Description

The DS90UB949-Q1 is an HDMI to FPD-Link III bridge device which, in conjunction with the FPD-Link III DS90UB940-Q1/DS90UB948-Q1 deserializers, supplies 1-lane or 2-lane high-speed serial streams over cost-effective 50- Ω single-ended coaxial or 100- Ω differential shielded twisted-pair (STP) cables. It serializes an HDMI v1.4b input supporting video resolutions up to WUXGA and 1080p60 with 24-bit color depth.

The FPD-Link III interface supports video and audio data transmission and full duplex control, including I2C and SPI communication, over the same differential link. The consolidation of video data and control over two differential pairs can reduce the interconnect size and weight and can simplify system design. EMI is minimized by the use of low-voltage differential signaling, data scrambling, and randomization. In backward-compatible mode, the device supports up to WXGA and 720p resolutions with 24-bit color depth over a single differential link.

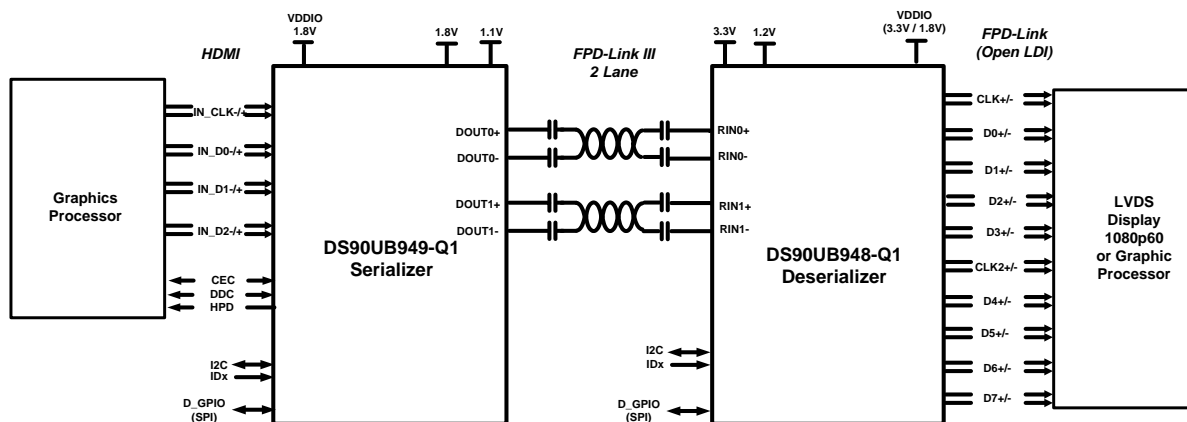
The DS90UB949-Q1 supports multi-channel audio received through HDMI or an external I2S interface. The device also supplies an optional auxiliary audio interface.

Device Information⁽¹⁾

| PART NUMBER | PACKAGE | BODY SIZE (NOM) |
|--------------|-----------|-------------------|
| DS90UB949-Q1 | VQFN (64) | 9.00 mm x 9.00 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Application Diagram



HDMI – High Definition Multimedia Interface



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4 Revision History

Changes from Original (November 2014) to Revision A

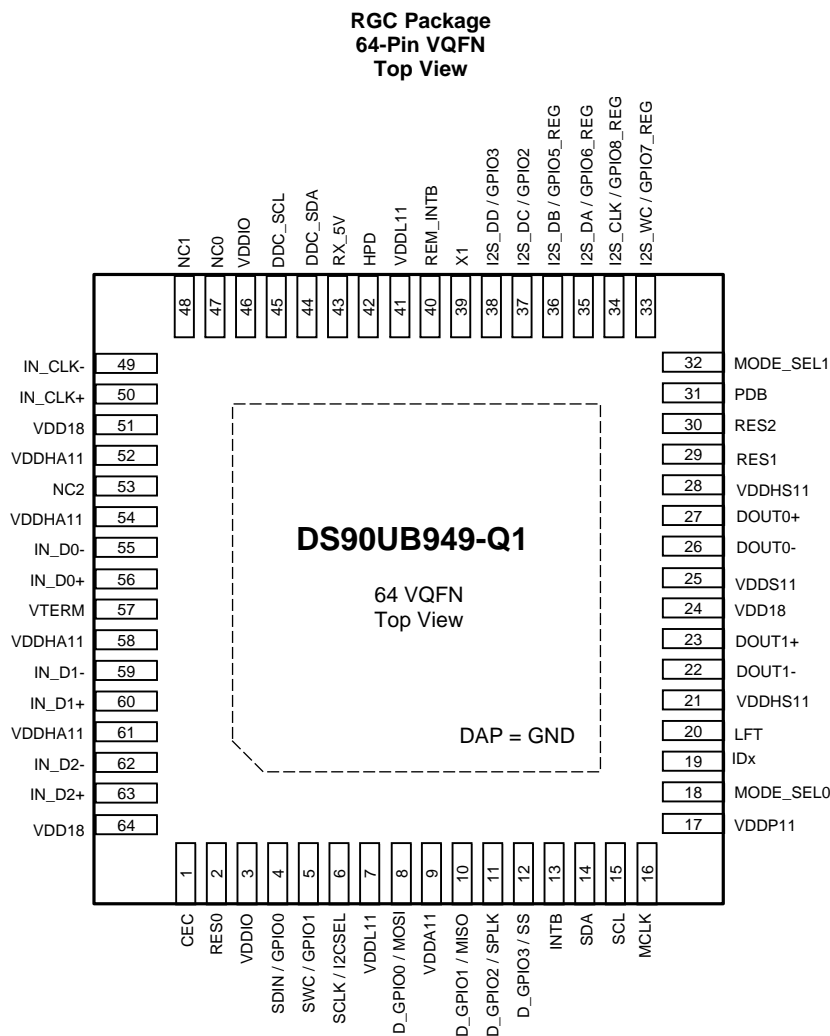
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| | |
|---|-----------|
| • Changed all references of HDMI Clock to TMDS Clock..... | 3 |
| • Changed V_{DD11} maximum from: 1.7 V to: 1.32 V | 6 |
| • Added RX_5V parameter to the <i>Recommended Operating Conditions</i> | 7 |
| • Added $T_{CLH1/2}$ and $T_{CHL1/2}$ parameters to the <i>Recommended Operating Conditions</i> | 7 |
| • Changed the TMDS jitter specification in the <i>AC Electrical Characteristics</i> table..... | 11 |
| • Added additional HSCC information to the <i>SPI Mode Configuration</i> section..... | 23 |
| • Added information about using I2S with the DS90UH926-Q1 in the <i>Audio Modes</i> section | 26 |
| • Deleted Auto Soft Sleep mode from the <i>MODE_SEL[1:0] Settings</i> table | 32 |
| • Added <i>Frequency Detection Circuit</i> section | 34 |
| • Added 5% resistor information to the <i>Serial Control Bus</i> section..... | 34 |
| • Added information to <i>Multi-Master Arbitration Support</i> section | 36 |
| • Added additional information to register 0x01 | 38 |
| • Added registers 0x00, 0x13, 0x15, 0x5B, 0xC0, 0xC2, 0xC3, 0xC6, 0xC8, 0xCE, and 0xD0 to default list | 38 |
| • Changed information about GPIO0 modes x00 and x10 | 42 |
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| • Added Page 0x10 Register..... | 67 |
| • Added Page 0x14 Register..... | 67 |
| • Changed graph caption from: <i>1080p60 Video at 2.6 Gbps Serial Line Rate (One of Two Lanes) to: 720p60 Video at 2.6-Gbps Serial Line Rate, Single Lane FPD-Link III Output</i> | 72 |

Revision History (continued)

- Changed *Power-Up Requirements* section 73

5 Pin Configuration and Functions



Pin Functions

| PIN | | I/O, TYPE | DESCRIPTION |
|------------------------|----------|---------------|---|
| NAME | NO. | | |
| HDMI TMDS INPUT | | | |
| IN_CLK- IN_CLK+ | 49 50 | I, TMDS | TMDS Clock Differential Input |
| IN_D0- IN_D0+ | 55 56 | I, TMDS | TMDS Data Channel 0 Differential Input |
| IN_D1- IN_D1+ | 59 60 | I, TMDS | TMDS Data Channel 1 Differential Input |
| IN_D2- IN_D2+ | 62 63 | I, TMDS | TMDS Data Channel 2 Differential Input |
| OTHER HDMI | | | |
| HPD | 42 | O, Open-Drain | Hot Plug Detect Output. Pull up to RX_5V with a 1-kΩ resistor |

Pin Functions (continued)

| PIN | | I/O, TYPE | DESCRIPTION |
|--|-----|----------------|--|
| NAME | NO. | | |
| RX_5V | 43 | I | HDMI 5-V Detect Input |
| DDC_SDA | 44 | IO, Open-Drain | DDC Slave Serial Data Pullup to RX_5V with a 47-k Ω resistor |
| DDC_SCL | 45 | I, Open-Drain | DDC Slave Serial Clock Pullup to RX_5V with a 47-k Ω resistor |
| CEC | 1 | IO, Open-Drain | Consumer Electronic Control Channel Input/Output Interface. Pullup with a 27-k Ω resistor to 3.3 V |
| X1 | 39 | I, LVCMOS | Optional Oscillator Input: This pin is the optional reference clock for CEC. It must be connected to a 25 MHz 0.1% (1000ppm), 45-55% duty cycle clock source at CMOS-level 1.8 V. Leave it open if unused. |
| FPD-LINK III SERIAL | | | |
| DOUT0- | 26 | O | FPD-Link III Inverting Output 0 The output must be AC-coupled with a 0.1- μ F capacitor for interfacing with 92x deserializers and 33-nF capacitor for 94x deserializers |
| DOUT0+ | 27 | O | FPD-Link III True Output 0 The output must be AC-coupled with a 0.1- μ F capacitor for interfacing with 92x deserializers and 33-nF capacitor for 94x deserializers |
| DOUT1- | 22 | O | FPD-Link III Inverting Output 1 The output must be AC-coupled with a 0.1- μ F capacitor for interfacing with 92x deserializers and 33-nF capacitor for 94x deserializers |
| DOUT1+ | 23 | O | FPD-Link III True Output 1 The output must be AC-coupled with a 0.1- μ F capacitor for interfacing with 92x deserializers and 33-nF capacitor for 94x deserializers |
| LFT | 20 | Analog | FPD-Link III Loop Filter Connect to a 10-nF capacitor to GND |
| CONTROL | | | |
| SDA | 14 | IO, Open-Drain | I2C Data Input / Output Interface Open-drain. Must have an external pullup to resistor to 1.8 V or 3.3 V. See I2CSEL pin. DO NOT FLOAT. Recommended pullup: 4.7 k Ω . |
| SCL | 15 | IO, Open-Drain | I2C Clock Input / Output Interface Open-drain. Must have an external pullup resistor to 1.8 V or 3.3 V. See I2CSEL pin. DO NOT FLOAT. Recommended pullup: 4.7 k Ω . |
| I2CSEL | 6 | I, LVCMOS | I2C Voltage Level Strap Option Tie to V _{DDIO} with a 10-k Ω resistor for 1.8-V I2C operation. Leave floating for 3.3-V I2C operation. This pin is read as an input at power up. |
| IDx | 19 | Analog | I2C Serial Control Bus Device ID Address Select |
| MODE_SEL0 | 18 | Analog | Mode Select 0. See Table 6 . |
| MODE_SEL1 | 32 | Analog | Mode Select 1. See Table 6 . |
| PDB | 31 | I, LVCMOS | Power-Down Mode Input Pin |
| INTB | 13 | O, Open-Drain | Open Drain. Remote interrupt. Active LOW. Pullup to VDDIO with a 4.7-k Ω resistor. |
| REM_INTB | 40 | O, Open-Drain | Remote interrupt. Mirrors status of INTB_IN from the deserializer. Note: External pullup to 1.8 V required. Recommended pullup: 4.7 k Ω . INTB = H, Normal Operation INTB = L, Interrupt Request |
| SPI PINS (DUAL LINK MODE ONLY) | | | |
| MOSI | 8 | IO, LVCMOS | SPI Master Out Slave In. Shared with D_GPIO0 |
| MISO | 10 | IO, LVCMOS | SPI Master In Slave Out. Shared with D_GPIO1 |
| SPLK | 11 | IO, LVCMOS | SPI Clock. Shared with D_GPIO2 |
| SS | 12 | IO, LVCMOS | SPI Slave Select. Shared with D_GPIO3 |
| HIGH-SPEED (HS) BIDIRECTIONAL CONTROL CHANNEL GPIO PINS (DUAL LINK MODE ONLY) | | | |
| D_GPIO0 | 8 | IO, LVCMOS | HS GPIO0. Shared with MOSI |

Pin Functions (continued)

| PIN | | I/O, TYPE | DESCRIPTION |
|--|----------------------|------------|--|
| NAME | NO. | | |
| D_GPIO1 | 10 | IO, LVCMOS | HS GPIO1. Shared with MISO |
| D_GPIO2 | 11 | IO, LVCMOS | HS GPIO2. Shared with SPLK |
| D_GPIO3 | 12 | IO, LVCMOS | HS GPIO3. Shared with SS |
| BIDIRECTIONAL CONTROL CHANNEL (BCC) GPIO PINS | | | |
| GPIO0 | 4 | IO, LVCMOS | BCC GPIO0. Shared with SDIN |
| GPIO1 | 5 | IO, LVCMOS | BCC GPIO1. Shared with SWC |
| GPIO2 | 37 | IO, LVCMOS | BCC GPIO2. Shared with I2S_DC |
| GPIO3 | 38 | IO, LVCMOS | BCC GPIO3. Shared with I2S_DD |
| REGISTER-ONLY GPIO | | | |
| GPIO5_REG | 36 | IO, LVCMOS | General-Purpose Input/Output 5 Local register control only. Shared with I2S_DB |
| GPIO6_REG | 35 | IO, LVCMOS | General-Purpose Input/Output 6 Local register control only. Shared with I2S_DA |
| GPIO7_REG | 33 | IO, LVCMOS | General-Purpose Input/Output 7 Local register control only. Shared with I2S_WC |
| GPIO8_REG | 34 | IO, LVCMOS | General-Purpose Input/Output 8 Local register control only. Shared with I2S_CLK |
| SLAVE MODE LOCAL I2S CHANNEL PINS | | | |
| I2S_WC | 33 | I, LVCMOS | Slave Mode I2S Word Clock Input. Shared with GPIO7_REG |
| I2S_CLK | 34 | I, LVCMOS | Slave Mode I2S Clock Input. Shared with GPIO8_REG |
| I2S_DA | 35 | I, LVCMOS | Slave Mode I2S Data Input. Shared with GPIO6_REG |
| I2S_DB | 36 | I, LVCMOS | Slave Mode I2S Data Input. Shared with GPIO5_REG |
| I2S_DC | 37 | I, LVCMOS | Slave Mode I2S Data Input. Shared with GPIO2 |
| I2S_DD | 38 | I, LVCMOS | Slave Mode I2S Data Input. Shared with GPIO3 |
| AUXILIARY I2S CHANNEL PINS | | | |
| SWC | 5 | O, LVCMOS | Master Mode I2S Word Clock Output. Shared with GPIO1 |
| SCLK | 6 | O, LVCMOS | Master Mode I2S Clock Output. Shared with I2CSEL. This pin is sampled following power-up as I2CSEL, then it will switch to SCLK operation as an output. |
| SDIN | 4 | I, LVCMOS | Master Mode I2S Data Input. Shared with GPIO0 |
| MCLK | 16 | IO, LVCMOS | Master Mode I2S System Clock Input/Output |
| POWER AND GROUND | | | |
| VTERM | 57 | Power | 3.3-V (±5%) Supply for DC-coupled internal termination OR 1.8-V (±5%) Supply for AC-coupled internal termination Refer to Figure 25 or Figure 26 . |
| VDD18 | 24 51 64 | Power | 1.8-V (±5%) Analog supply. Refer to Figure 25 or Figure 26 . |
| VDDA11 | 9 | Power | 1.1-V (±5%) Analog supply. Refer to Figure 25 or Figure 26 . |
| VDDHA11 | 52 54 58 61 | Power | 1.1-V (±5%) TMDS supply. Refer to Figure 25 or Figure 26 . |
| VDDHS11 | 21 28 | Power | 1.1-V (±5%) supply. Refer to Figure 25 or Figure 26 . |
| VDDL11 | 7 41 | Power | 1.1-V (±5%) Digital supply. Refer to Figure 25 or Figure 26 . |
| VDDP11 | 17 | Power | 1.1-V (±5%) PLL supply. Refer to Figure 25 or Figure 26 . |
| VDDS11 | 25 | Power | 1.1-V (±5%) Serializer supply. Refer to Figure 25 or Figure 26 . |
| VDDIO | 3 46 | Power | 1.8-V (±5%) IO supply. Refer to Figure 25 or Figure 26 . |

Pin Functions (continued)

| PIN | | I/O, TYPE | DESCRIPTION |
|--------------|-------------|-----------|---|
| NAME | NO. | | |
| GND | Thermal Pad | GND | Ground. Connect to Ground plane with at least 9 vias. |
| OTHER | | | |
| RES0 | 2 | | Reserved. Tie to GND. |
| RES1 | 29 | | |
| RES2 | 30 | | Reserved. Connect with 50Ω to GND. |
| NC0 | 47 | | No connect. Leave floating. Do not connect to VDD or GND. |
| NC1 | 48 | | |
| NC2 | 53 | | |

6 Specifications

6.1 Absolute Maximum Ratings

 See ⁽¹⁾⁽²⁾

| | | MIN | MAX | UNIT |
|-------------------|-----------------------------|------|-------------------------|------|
| V _{DD11} | Supply Voltage | -0.3 | 1.32 | V |
| V _{DD18} | Supply Voltage | -0.3 | 2.5 | V |
| V _{DDIO} | Supply Voltage | -0.3 | 2.5 | V |
| | OpenLDI Inputs | -0.3 | 2.75 | V |
| | LVC MOS I/O Voltage | -0.3 | V _{DDIO} + 0.3 | V |
| | 1.8-V Tolerant I/O | -0.3 | 2.5 | V |
| | 3.3-V Tolerant I/O | -0.3 | 4.0 | V |
| | 5-V Tolerant I/O | -0.3 | 5.3 | V |
| | FPD-Link III Output Voltage | -0.3 | 1.7 | V |
| | Junction Temperature | | 150 | °C |
| T _{stg} | Storage Temperature | -65 | 150 | °C |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) For soldering specifications, see product folder at www.ti.com and *Absolute Maximum Ratings for Soldering* (SNOA549).

6.2 ESD Ratings

| | | VALUE | UNIT | |
|--------------------|-------------------------|---|--|--------|
| V _(ESD) | Electrostatic discharge | Human body model (HBM), per AEC Q100-002 ⁽¹⁾ HBM ESD Classification Level 2 | ±2000 | |
| | | Charged device model (CDM), per AEC Q100-011 CDM ESD Classification Level C5 | ±750 | |
| | | (IEC 61000-4-2) R _D = 330 Ω, C _S = 150 pF | Air Discharge (D _{OUT0+} , D _{OUT0-} , D _{OUT1+} , D _{OUT1-}) | ±15000 |
| | | | Contact Discharge (D _{OUT0+} , D _{OUT0-} , D _{OUT1+} , D _{OUT1-}) | ±8000 |
| | | (ISO10605) R _D = 330 Ω, C _S = 150 pF R _D = 2 kΩ, C _S = 150 pF or 330 pF | Air Discharge (D _{OUT0+} , D _{OUT0-} , D _{OUT1+} , D _{OUT1-}) | ±15000 |
| | | | Contact Discharge (D _{OUT0+} , D _{OUT0-} , D _{OUT1+} , D _{OUT1-}) | ±8000 |

- (1) AEC Q100-002 indicates HBM stressing is done in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

6.3 Recommended Operating Conditions

| | | MIN | NOM | MAX | UNIT |
|--------------------|--|---------------------|-----|----------------|-------------------|
| V _{DD11} | Supply Voltage | 1.045 | 1.1 | 1.155 | V |
| V _{DD18} | Supply Voltage | 1.71 | 1.8 | 1.89 | V |
| V _{DDIO} | LVC MOS Supply Voltage | 1.71 | 1.8 | 1.89 | V |
| | V _{DDI2C} , 1.8-V Operation | 1.71 | 1.8 | 1.89 | V |
| | V _{DDI2C} , 3.3-V Operation | 3.135 | 3.3 | 3.465 | V |
| | HDMI Termination (V _{TERM}), DC-coupled | 3.135 | 3.3 | 3.465 | V |
| | HDMI Termination (V _{TERM}), AC-coupled | 1.71 | 1.8 | 1.89 | V |
| V _{RX_5V} | HDMI Detect Voltage | 4.25 | 5 | 5.25 | V |
| T _A | Operating Free Air Temperature | -40 | 25 | 105 | °C |
| T _{CLH1} | Allowable ending ambient temperature for continuous PLL lock when ambient temperature is rising under the following condition: -40°C ≤ starting ambient temperature (T _s) < 0°C. ⁽¹⁾ | T _s | | 80 | °C |
| T _{CLH2} | Allowable ending ambient temperature for continuous PLL lock when ambient temperature is rising under the following condition: 0°C ≤ starting ambient temperature (T _s) ≤ 105°C. ⁽¹⁾ | T _s | | 105 | °C |
| T _{CHL1} | Allowable ending ambient temperature for continuous PLL lock when ambient temperature is falling under the following condition: 45°C < starting ambient temperature (T _s) ≤ 105°C. ⁽¹⁾ | 25 | | T _s | °C |
| T _{CHL2} | Allowable ending ambient temperature for continuous PLL lock when ambient temperature is falling under the following condition: -20°C ≤ starting ambient temperature (T _s) ≤ 45°C. ⁽¹⁾ | T _s - 20 | | T _s | °C |
| | TMDS Frequency | 25 | | 170 | MHz |
| | Supply Noise ⁽²⁾ (DC-50MHz) | | | 25 | mV _{P-P} |

- (1) The input and output PLLs are calibrated at the ambient start up temperature (T_s) when the device is powered on or when reset using the PDB pin. The PLLs will stay locked up to the specified ending temperature. A more detailed description can be found in "Handling System Temperature Ramps on the DS90Ux949, DS90Ux929 and DS90Ux947".
- (2) Supply noise testing was done without any capacitors or ferrite beads connected. A sinusoidal signal is AC coupled to the VDD₁₁ supply of the serializer until the deserializer loses lock.

6.4 Thermal Information

| THERMAL METRIC ⁽¹⁾ | | DS90UB949-Q1 | |
|-------------------------------|--|--------------|------|
| | | RGC (VQFN) | |
| | | 64 PINS | |
| Symbol | Description | Value | Unit |
| R _{θJA} | Junction-to-ambient thermal resistance | 25.8 | °C/W |
| R _{θJC(top)} | Junction-to-case (top) thermal resistance | 11.4 | °C/W |
| R _{θJB} | Junction-to-board thermal resistance | 5.1 | °C/W |
| ψ _{JT} | Junction-to-top characterization parameter | 0.2 | °C/W |
| ψ _{JB} | Junction-to-board characterization parameter | 5.1 | °C/W |
| R _{θJC(bot)} | Junction-to-case (bottom) thermal resistance | 0.8 | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report (SPRA953).

6.5 DC Electrical Characteristics

over recommended operating supply and temperature ranges (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | PIN/FREQ. | MIN | TYP | MAX | UNIT |
|--------------------------|-----------------|-----------|-----|-----|-----|------|
| 1.8-V LVC MOS I/O | | | | | | |

DC Electrical Characteristics (continued)

over recommended operating supply and temperature ranges (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | PIN/FREQ. | MIN | TYP | MAX | UNIT |
|--|----------------------------------|---|---|--------------------------|--------------------------|---------------------------|-------------------|
| V _{IH} | High Level Input Voltage | | SCLK/I2CSEL, PDB, D_GPIO0/MOSI, D_GPIO1/MISO, D_GPIO2/SPLK, D_GPIO3/SS, SDIN/GPIO0, SWC/GPIO1, MCLK I2S_DC/GPIO2, I2S_DD/GPIO3, I2S_DB/GPIO5_REG, I2S_DA/GPIO6_REG, I2S_CLK/GPIO8_REG, I2S_WC/GPIO7_REG | 0.65 × V _{DDIO} | | | V |
| V _{IL} | Low Level Input Voltage | | | 0 | 0.35 × V _{DDIO} | | V |
| I _{IN} | Input Current | V _{IN} = 0 V or 1.89 V | | -10 | | 10 | μA |
| V _{OH} | High Level Output Voltage | I _{OH} = -4 mA | Same as above | 0.7 × V _{DDIO} | | V _{DDIO} | V |
| V _{OL} | Low Level Output Voltage | I _{OL} = 4 mA | | GND | 0.26 × V _{DDIO} | | V |
| I _{OS} | Output Short Circuit Current | V _{OUT} = 0 V | | -50 | | | mA |
| I _{OZ} | TRI-STATE™ Output Current | V _{OUT} = 0 V or V _{DDIO} , PDB = L | | -10 | | 10 | μA |
| TMDS INPUTS -- FROM HDMI v1.4b SECTION 4.2.5 | | | | | | | |
| V _{ICM1} | Input Common-Mode Voltage | IN_CLK ≤ 170MHz | IN_D[2:0]+, IN_D[2:0]- IN_CLK+, IN_CLK- V _{TERM} = 1.8V (±5%) or V _{TERM} = 3.3 V (±5%) | V _{TERM} - 400 | V _{TERM} - 37.5 | | mV |
| V _{ICM2} | Input Common-Mode Voltage | | | V _{TERM} - 10 | V _{TERM} + 10 | | mV |
| V _{IDIFF} | Input Differential Voltage Level | | | 150 | 1200 | | mV _{P-P} |
| R _{TMDS} | Termination Resistance | Differential | IN_D[2:0]+, IN_D[2:0]- IN_CLK+, IN_CLK- | 90 | 100 | 110 | Ω |
| HDMI IO -- FROM HDMI v1.4b SECTION 4.2.7 to 4.2.9 | | | | | | | |
| V _{RX_5V} | 5-V Power Signal | | RX_5V | 4.8 | | 5.3 | V |
| I _{5V_Sink} | 5-V Input Current | | | | | | 50 |
| V _{OH,HPD} | High Level Output Voltage, HPD | I _{OH} = -4 mA | HPD, R _{PU} = 1 kΩ | 2.4 | | 5.3 | V |
| V _{OL,HPD} | Low Level Output Voltage, HPD | I _{OL} = 4 mA | | GND | | 0.4 | V |
| I _{Iz,HPD} | Power-Down Input Current, HPD | PDB = L | | -10 | | 10 | uA |
| V _{IL,DDC} | Low Level Input Voltage, DDC | | DDC_SCL, DDC_SDA | | | 0.3 × V _{DD,DDC} | V |
| V _{IH,DDC} | High Level Input Voltage, DDC | | | 2.7 | | | V |
| I _{Iz,DDC} | Power-Down Input Current, DDC | PDB = L | | -10 | | 10 | μA |

DC Electrical Characteristics (continued)

over recommended operating supply and temperature ranges (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | PIN/FREQ. | MIN | TYP | MAX | UNIT |
|----------------|--------------------------------|-----------------|-----------|-----|------|------|------|
| $V_{IH,CEC}$ | High Level Input Voltage, CEC | | CEC | 2 | | | V |
| $V_{IL,CEC}$ | Low Level Input Voltage, CEC | | | | | 0.8 | V |
| $V_{HY,CEC}$ | Input Hysteresis, CEC | | | | 0.4 | | V |
| $V_{OL,CEC}$ | Low Level Output Voltage, CEC | | | GND | | 0.6 | V |
| $V_{OH,CEC}$ | High Level Output Voltage, CEC | | | | 2.5 | 3.63 | V |
| I_{OFF_CEC} | Power-Down Input Current, CEC | PDB = L | | | -1.8 | | 1.8 |

DC Electrical Characteristics (continued)

over recommended operating supply and temperature ranges (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | PIN/FREQ. | MIN | TYP | MAX | UNIT | |
|---|--------------------------------------|----------------------------|---------------------------|-----|-----|------|-------------------|----------|
| FPD-LINK III DIFFERENTIAL DRIVER | | | | | | | | |
| V_{ODP-P} | Output Differential Voltage | | | 900 | | 1200 | mV _{p-p} | |
| ΔV_{OD} | Output Voltage Unbalance | | | | 1 | 50 | mV | |
| V_{OS} | Output Differential Offset Voltage | | DOUT[1:0]+, DOUT[1:0]- | | 550 | | mV | |
| ΔV_{OS} | Offset Voltage Unbalance | | | | 1 | 50 | mV | |
| I_{OS} | Output Short Circuit Current | FPD-Link III Outputs = 0 V | | | | -50 | | mA |
| R_T | Termination Resistance | Single-ended | | | 40 | 50 | 60 | Ω |
| SUPPLY CURRENT ⁽¹⁾ | | | | | | | | |
| I_{DD11} | Supply Current, Normal Operation | Colorbar Pattern | | | | 330 | mA | |
| I_{DD18} | Supply Current, Normal Operation | Colorbar Pattern | | | | 50 | mA | |
| $I_{DD,VTERM}$ | V_{TERM} Current, Normal Operation | Colorbar Pattern | | | 60 | | mA | |
| I_{DDZ11} | Supply Current, Power Down Mode | PDB = L | | | 15 | | mA | |
| I_{DDZ18} | Supply Current, Power Down Mode | | | | | 5 | | mA |
| $I_{DDZ,VTERM}$ | V_{TERM} Current, Power Down Mode | Colorbar Pattern | | | 5 | | mA | |

(1) Specification is tested by bench characterization.

6.6 AC Electrical Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified.

| PARAMETER | | TEST CONDITIONS | PIN/FREQ. | MIN | TYP | MAX | UNIT |
|-------------------------------------|--|---------------------------------------|---|-------------|------------------------|---|------------------------------------|
| GPIO FREQUENCY⁽¹⁾ | | | | | | | |
| R _{b,FC} | Forward Channel GPIO Frequency | Single-Lane, IN_CLK = 25 MHz - 96 MHz | GPIO[3:0], D_GPIO[3:0] | | | 0.25 × IN_CLK | MHz |
| | | Dual-Lane, IN_CLK/2 = 25 MHz - 85 MHz | | | | 0.125 × IN_CLK | |
| t _{GPIO,FC} | GPIO Pulse Width, Forward Channel | Single-Lane, IN_CLK = 25 MHz - 96 MHz | GPIO[3:0], D_GPIO[3:0] | >2 / IN_CLK | | | s |
| | | Dual-Lane, IN_CLK/2 = 25 MHz - 85 MHz | | | | | |
| TMDS INPUT | | | | | | | |
| Skew-Intra | Maximum Intra-Pair Skew | | IN_CLK±, IN_D[2:0]± | | | 0.4 | U _I TMDS ⁽²⁾ |
| Skew-Inter | Maximum Inter-Pair Skew | | | | | 0.2 × T _{char} ⁽³⁾ + 1.78 | ns |
| t _{JIT} | TMDS Clock Input Jitter | Bit Error Rate ≤1E-10 | IN_CLK± | | | 0.3 | U _I TMDS ⁽²⁾ |
| FPD-LINK III OUTPUT | | | | | | | |
| t _{LHT} | Low Voltage Differential Low-to-High Transition Time | | | | 80 | | ps |
| t _{HLT} | Low Voltage Differential High-to-Low Transition Time | | | | 80 | | ps |
| t _{XZD} | Output Active to OFF Delay | PDB = L | | | 100 | | ns |
| t _{PLD} | Lock Time (HDMI Rx) | | | | 5 | | ms |
| t _{SD} | Delay — Latency | | IN_CLK± | | 145 × T ⁽²⁾ | | s |
| t _{DJIT} | Output Total Jitter (Figure 5) | Random Pattern | Single-Lane: High pass filter IN_CLK/20 | | 0.3 | | U _I FPD3 ⁽⁴⁾ |
| | | | Dual-lane: High pass filter IN_CLK/40 | | | | |
| λ _{STXBW} | Jitter Transfer Function (-3-dB Bandwidth) | | | | 960 | | kHz |
| δ _{STX} | Jitter Transfer Function Peaking | | | | 0.1 | | dB |

(1) Back channel rates are available on the companion deserializer datasheet.

(2) One bit period of the TMDS input.

(3) Ten bit periods of the TMDS input.

(4) One bit period of the serializer output.

6.7 DC And AC Serial Control Bus Characteristics

over V_{DDI2C} supply and temperature ranges unless otherwise specified. V_{DDI2C} can be 1.8V ($\pm 5\%$) or 3.3V ($\pm 5\%$) (refer to I2CSEL pin description for 1.8-V or 3.3-V operation).

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|--|------------------------|-----|------------------------|---------------|
| $V_{IH,I2C}$ Input High Level, I2C | SDA and SCL, $V_{DDI2C} = 1.8\text{ V}$ | $0.7 \times V_{DDI2C}$ | | | V |
| | SDA and SCL, $V_{DDI2C} = 3.3\text{ V}$ | $0.7 \times V_{DDI2C}$ | | | V |
| $V_{IL,I2C}$ Input Low Level Voltage, I2C | SDA and SCL, $V_{DDI2C} = 1.8\text{ V}$ | | | $0.3 \times V_{DDI2C}$ | V |
| | SDA and SCL, $V_{DDI2C} = 3.3\text{ V}$ | | | $0.3 \times V_{DDI2C}$ | V |
| V_{HY} Input Hysteresis, I2C | SDA and SCL, $V_{DDI2C} = 1.8\text{ V}$ or 3.3 V | | >50 | | mV |
| $V_{OL,I2C}$ Output Low Level, I2C | SDA and SCL, $V_{DDI2C} = 1.8\text{-V}$, Fast-Mode, 3-mA Sink Current | GND | | $0.2 \times V_{DDI2C}$ | V |
| | SDA and SCL, $V_{DDI2C} = 3.3\text{-V}$, 3-mA Sink Current | GND | | 0.4 | V |
| $I_{IN,I2C}$ Input Current, I2C | SDA and SCL, $V_{DDI2C} = 0\text{ V}$ | -800 | | -600 | μA |
| | SDA and SCL, $V_{DDI2C} = V_{DD18}$ or V_{DD33} | -10 | | 10 | μA |
| $C_{IN,I2C}$ Input Capacitance, I2C | SDA and SCL | | 5 | | pF |

6.8 Recommended Timing for the Serial Control Bus

over I²C supply and temperature ranges unless otherwise specified.

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---------------------|---|-----------------|------|-----|------|------|
| f _{SCL} | SCL Clock Frequency | Standard-Mode | >0 | | 100 | kHz |
| | | Fast-Mode | >0 | | 400 | kHz |
| | | Fast-Mode Plus | >0 | | 1 | MHz |
| t _{LOW} | SCL Low Period | Standard-Mode | 4.7 | | | μs |
| | | Fast-Mode | 1.3 | | | μs |
| | | Fast-Mode Plus | 0.5 | | | μs |
| t _{HIGH} | SCL High Period | Standard-Mode | 4.0 | | | μs |
| | | Fast-Mode | 0.6 | | | μs |
| | | Fast-Mode Plus | 0.26 | | | μs |
| t _{HD;STA} | Hold time for a start or a repeated start condition | Standard-Mode | 4.0 | | | μs |
| | | Fast-Mode | 0.6 | | | μs |
| | | Fast-Mode Plus | 0.26 | | | μs |
| t _{SU;STA} | Set Up time for a start or a repeated start condition | Standard-Mode | 4.7 | | | μs |
| | | Fast-Mode | 0.6 | | | μs |
| | | Fast-Mode Plus | 0.26 | | | μs |
| t _{HD;DAT} | Data Hold Time | Standard-Mode | 0 | | | μs |
| | | Fast-Mode | 0 | | | μs |
| | | Fast-Mode Plus | 0 | | | μs |
| t _{SU;DAT} | Data Set-Up Time | Standard-Mode | 250 | | | ns |
| | | Fast-Mode | 100 | | | ns |
| | | Fast-Mode Plus | 50 | | | ns |
| t _{SU;STO} | Set Up Time for STOP Condition | Standard-Mode | 4.0 | | | μs |
| | | Fast-Mode | 0.6 | | | μs |
| | | Fast-Mode Plus | 0.26 | | | μs |
| t _{BUF} | Bus Free Time Between STOP and START | Standard-Mode | 4.7 | | | μs |
| | | Fast-Mode | 1.3 | | | μs |
| | | Fast-Mode Plus | 0.5 | | | μs |
| t _r | SCL and SDA Rise Time, | Standard-Mode | | | 1000 | ns |
| | | Fast-Mode | | | 300 | ns |
| | | Fast-Mode Plus | | | 120 | ns |
| t _f | SCL and SDA Fall Time, | Standard-Mode | | | 300 | ns |
| | | Fast-Mode | | | 300 | ns |
| | | Fast-Mode Plus | | | 120 | ns |
| t _{SP} | Input Filter | Fast-Mode | | | 50 | ns |
| | | Fast-Mode Plus | | | 50 | ns |

6.9 Timing Diagrams

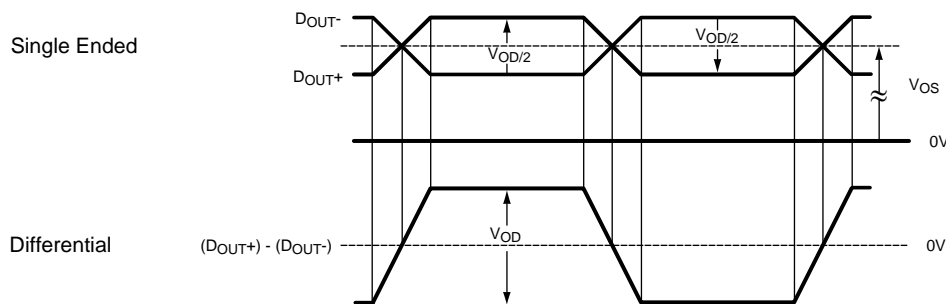
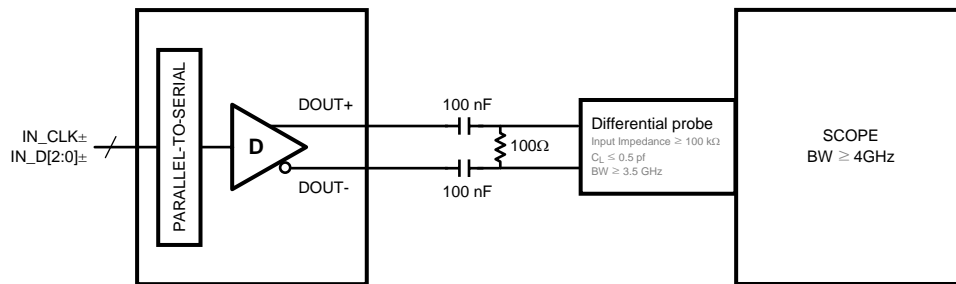


Figure 1. Serializer V_{OD} Output

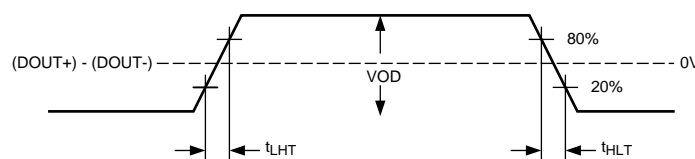


Figure 2. Output Transition Times

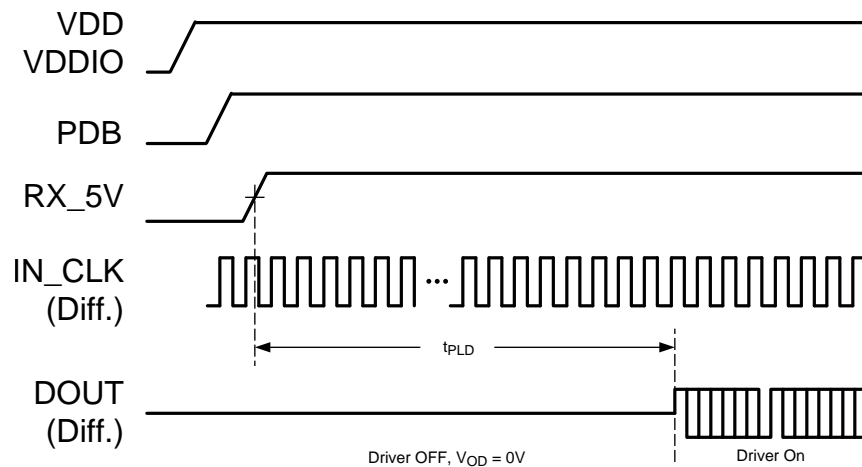


Figure 3. Serializer Lock Time

Timing Diagrams (continued)

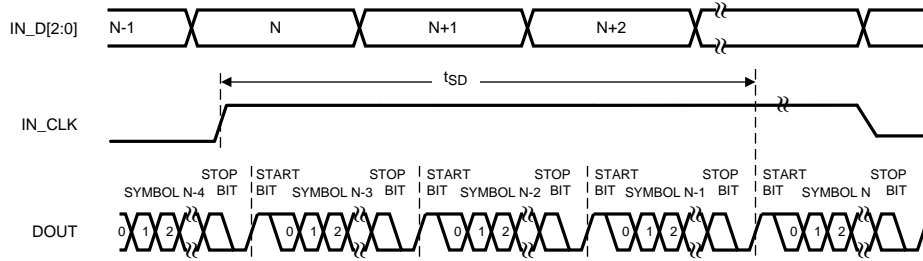


Figure 4. Latency Delay

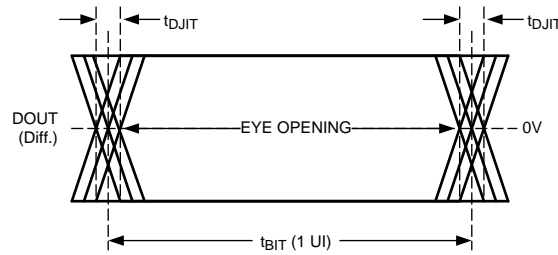


Figure 5. Serializer Output Jitter

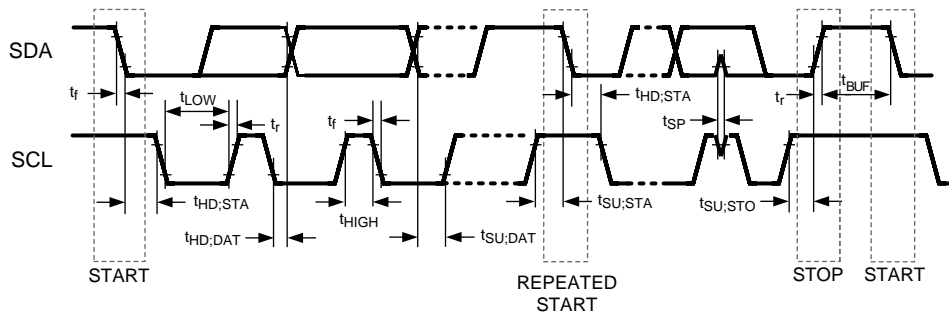


Figure 6. Serial Control Bus Timing Diagram

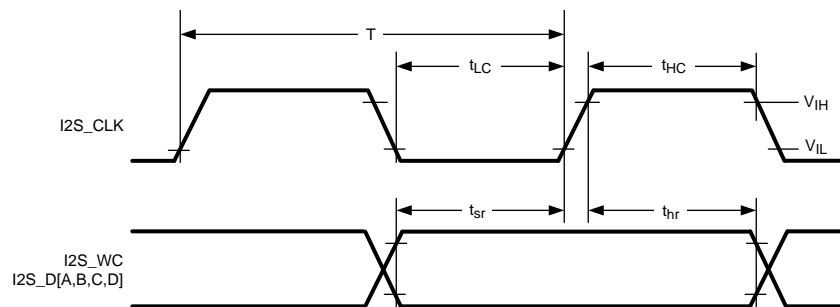
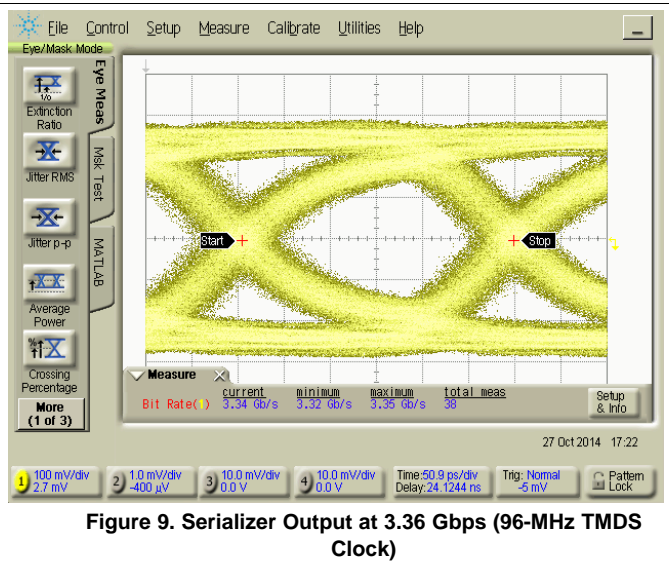
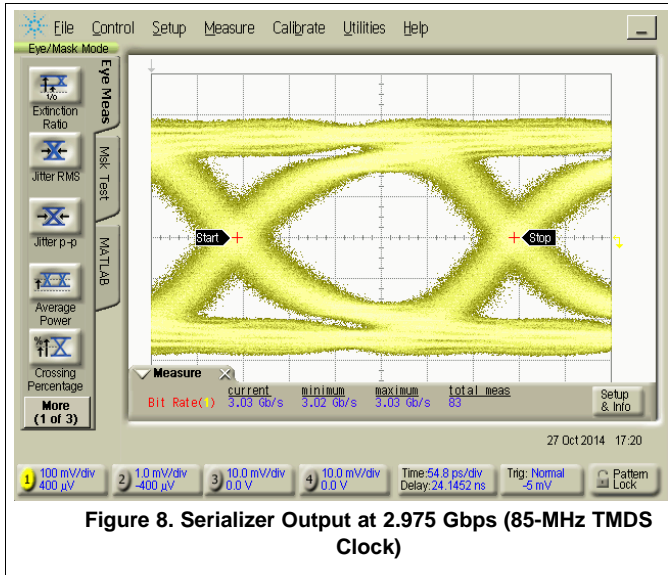


Figure 7. I2S Timing Diagram

6.10 Typical Characteristics



7 Detailed Description

7.1 Overview

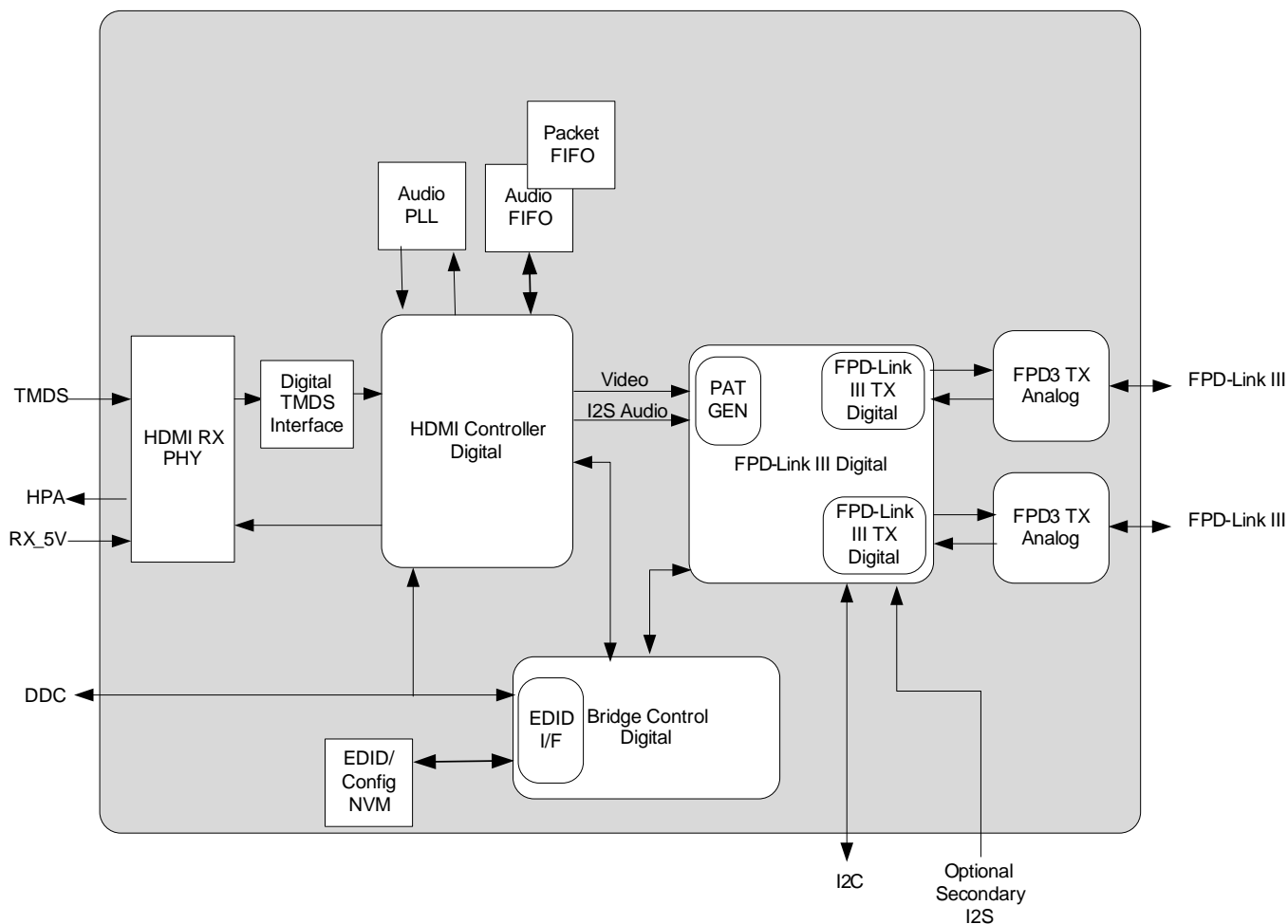
The DS90UB949-Q1 converts an HDMI interface (3 TMDS data channels + 1 TMDS Clock) to an FPD-Link III interface. This device transmits a 35-bit symbol over a single serial pair operating up to 3.36-Gbps line rate, or two serial pairs operating up to 2.975-Gbps line rate. The serial stream contains an embedded clock, video control signals, RGB video data, and audio data. The payload is DC-balanced to enhance signal quality and support AC coupling.

The DS90UB949-Q1 serializer is intended for use with a DS90UB926Q-Q1, DS90UB928Q-Q1, DS90UB940-Q1, DS90UB948-Q1 deserializer.

The DS90UB949-Q1 serializer and companion deserializer incorporate an I2C-compatible interface. The I2C-compatible interface allows programming of serializer or deserializer devices from a local host controller. In addition, the device incorporates a bidirectional control channel (BCC) that allows communication between serializer and deserializer, as well as remote I2C slave devices.

The bidirectional control channel (BCC) is implemented through embedded signaling in the high-speed forward channel (serializer to deserializer) combined with lower speed signaling in the reverse channel (deserializer to serializer). Through this interface, the BCC provides a mechanism to bridge I2C transactions across the serial link from one I2C bus to another. The implementation allows for arbitration with other I2C-compatible masters at either side of the serial link.

7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 High-Definition Multimedia Interface (HDMI)

HDMI is a leading interface standard used to transmit digital video and audio from sources (such as a DVD player) to sinks (such as an LCD display). The interface is capable of transmitting high-definition video and audio. Other HDMI signals consist of various control and status data that travel bidirectionally.

7.3.1.1 HDMI Receive Controller

The HDMI Receiver is an HDMI version 1.4b compliant receiver. The HDMI receiver is capable of operation at greater than 1080p resolutions. The configuration used in the DS90UB949-Q1 does not include version 1.4b features such as the ethernet channel (HEC) or Audio Return Channel (ARC).

7.3.2 Transition Minimized Differential Signaling

HDMI uses Transition Minimized Differential Signaling (TMDS) over four differential pairs (3 TMDS channels and 1 TMDS clock) to transmit video and audio data. TMDS is widely used to transmit high-speed serial data. The technology incorporates a form of 8b/10b encoding and the differential signaling allows the device to reduce electromagnetic interference (EMI) and achieve high skew tolerance.

7.3.3 Enhanced Display Data Channel

The Display Data Channel or DDC is a collection of digital communication protocols between a computer display and a graphics adapter that enables the display to list and send all the supported display modes to the adapter and allow the computer host to adjust monitor parameters, such as brightness and contrast.

7.3.4 Extended Display Identification Data (EDID)

EDID is a data structure provided by a digital display to list all the capabilities of the display to a video source. After receiving this information, the video source can send back video data with proper timing and resolution the display can support. The DS90UB949-Q1 supports several options for delivering display identification (EDID) information to the HDMI graphics source. The EDID information is accessible through the DDC interface and comply with the DDC and EDID requirements given in the HDMI v1.4b specification.

The EDID configurations supported are as follows:

- External local EDID (EEPROM)
- Internal EDID loaded into device memory
- Remote EDID connected to I2C bus at deserializer side
- Internal pre-programmed EDID

The selected EDID mode should be configurable from either the MODE_SEL pins or from internal control registers. For all modes, the EDID information should be accessible at the default address of 0xA0.

7.3.4.1 External Local EDID (EEPROM)

The DS90UB949-Q1 can be configured to allow a local EEPROM EDID device. The local EDID device may implement any EDID configuration allowable by the HDMI v1.4b and DVI 1.0 standards, including multiple extension blocks up to 32KB.

7.3.4.2 Internal EDID (SRAM)

The DS90UB949-Q1 also allows internal loading of an EDID profile up to 256 bytes. This SRAM storage is volatile and requires loading from an external I2C master (local or remote). The internal EDID is reloadable and readable (local/remote) from control registers during normal operation.

7.3.4.3 External Remote EDID

The serializer copies the remote EDID connected to the I2C bus of the remote deserializer into its internal SRAM. The remote EDID device can be a standalone I2C EEPROM, or integrated into the digital display panel. In this mode, the serializer automatically accesses the Bidirectional Control Channel to search for the EDID information at the default address 0xA0. Once found, the serializer copies the remote EDID into local SRAM.

Feature Description (continued)

7.3.4.4 Internal Pre-Programmed EDID

The serializer also has an internal eFuse that is loaded into the internal SRAM with pre-programmed 256-byte EDID data at start-up. This EDID profile supports several generic video (480p, 720p) and audio (2-channel audio) timing profiles within the single-link operating range of the device (25-MHz to 96-MHz pixel clock). In this mode, the internal EDID SRAM data is readable from the DDC interface. The EDID contents are below:

```

0x00 0xFF 0xFF 0xFF 0xFF 0xFF 0xFF 0x00 0x53 0x0E 0x49 0x09 0x01 0x00 0x00 0x00
0x1C 0x18 0x01 0x03 0x80 0x34 0x20 0x78 0x0A 0xEC 0x18 0xA3 0x54 0x46 0x98 0x25
0x0F 0x48 0x4C 0x00 0x00 0x00 0x01 0x01 0x01 0x01 0x01 0x01 0x01 0x01 0x01 0x01
0x01 0x01 0x01 0x01 0x01 0x01 0x01 0x1D 0x00 0x72 0x51 0xD0 0x1E 0x20 0x6E 0x50
0x55 0x00 0x00 0x20 0x21 0x00 0x00 0x18 0x00 0x00 0x00 0xFD 0x00 0x3B 0x3D 0x62
0x64 0x08 0x00 0x0A 0x20 0x20 0x20 0x20 0x20 0x20 0x00 0x00 0x00 0xFC 0x00 0x54
0x49 0x2D 0x44 0x53 0x39 0x30 0x55 0x78 0x39 0x34 0x39 0x0A 0x00 0x00 0x00 0x10
0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x01 0x57
0x02 0x03 0x15 0x40 0x41 0x84 0x23 0x09 0x7F 0x05 0x83 0x01 0x00 0x00 0x66 0x03
0x0C 0x00 0x10 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00
0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00
0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00
0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00
0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00
0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x00 0x28
    
```

7.3.5 Consumer Electronics Control (CEC)

Consumer Electronics Control (CEC) is designed to allow the system user to command and control up-to ten CEC-enabled devices connected through HDMI, using only one of their remote controls (for example by controlling a television set, set-top box, and DVD player using only the remote control of the TV). CEC also allows for individual CEC-enabled devices to command and control each other without user intervention. CEC is a one-wire open drain bus with an external 27-kΩ (±10%) resistor pullup to 3.3 V.

CEC protocol can be implemented using an external clock reference or the 25-MHz internal oscillator inside the DS90UB949-Q1.

7.3.6 +5-V Power Signal

5 V is asserted by the HDMI source through the HDMI interface. The 5-V signal propagates through the connector and cable until it reaches the sink. The 5-V supply is used for various HDMI functions, such as HPD and DDC signals.

7.3.7 Hot Plug Detect (HPD)

The HPD pin is asserted by the sink to let the source know that it is ready to receive the HDMI signal. The source initiates the connection by first providing the 5-V power signal through the HDMI interface. The sink holds HPD low until it is ready to receive signals from the source, at which point it will release HPD to be pulled up to 5 V.

7.3.8 High-Speed Forward Channel Data Transfer

The High-Speed Forward Channel is composed of 35 bits of data containing RGB data, sync signals, I2C, GPIOs, and I2S audio transmitted from serializer to deserializer. Figure 10 shows the serial stream per clock cycle. This data payload is optimized for signal transmission over an AC-coupled link. Data is randomized, balanced, and scrambled.



Figure 10. FPD-Link III Serial Stream

Feature Description (continued)

The device supports TMDS clocks in the range of 25 MHz to 96 MHz over one lane, or 50 MHz to 170 MHz over two lanes. The FPD-Link III serial stream rate is 3.36 Gbps maximum (875 Mbps minimum), or 2.975 Gbps maximum per lane (875 Mbps minimum) when transmitting over both lanes.

7.3.9 Back Channel Data Transfer

The Back Channel provides bidirectional communication between the display and host processor. The information is carried from the deserializer to the serializer as serial frames. The back channel control data is transferred over both serial links along with the high-speed forward data, DC balance coding and embedded clock information. This architecture provides a backward path across the serial link together with a high-speed forward channel. The back channel contains the I2C, CRC and 4 bits of standard GPIO information with 5-Mbps, 10-Mbps, or 20-Mbps line rate (configured by the compatible deserializer).

7.3.10 FPD-Link III Port Register Access

Since the DS90UB949-Q1 contains two downstream ports, some registers need to be duplicated to allow control and monitoring of the two ports. To facilitate this, a TX_PORT_SEL register controls access to the two sets of registers. Registers that are shared between ports (not duplicated) will be available independent of the settings in the TX_PORT_SEL register.

Setting the TX_PORT0_SEL or TX_PORT1_SEL bit will allow a read of the register for the selected port. If both bits are set, port1 registers will be returned. Writes will occur to ports for which the select bit is set, allowing simultaneous writes to both ports if both select bits are set.

Setting the PORT1_I2C_EN bit will enable a second I²C slave address, allowing access to the second port registers through the second I²C address. If this bit is set, the TX_PORT0_SEL and TX_PORT1_SEL bits will be ignored.

7.3.11 Power Down (PDB)

The Serializer has a PDB input pin to ENABLE or POWER DOWN the device. This pin may be controlled by an external device, or through V_{DDIO}, where V_{DDIO} = 1.71 V to 1.89 V. To save power, disable the link when the display is not necessary (PDB = LOW). Ensure that this pin is not driven HIGH before all power supplies have reached final levels. When PDB is driven low, ensure that the pin is driven to 0 V for at least 3 ms before releasing or driving high. In the case where PDB is pulled up to V_{DDIO} directly, a 10-kΩ pullup resistor and a >10-μF capacitor to ground are required (See [Power-Up Requirements and PDB Pin](#)).

Toggling PDB low will POWER DOWN the device and RESET all control registers to default. During this time, PDB must be held low for a minimum of 3 ms before going high again.

7.3.12 Serial Link Fault Detect

The DS90UB949-Q1 can detect fault conditions in the FPD-Link III interconnect. If a fault condition occurs, the Link Detect Status is 0 (cable is not detected) on bit 0 of address 0x0C ([Table 10](#)). The DS90UB949-Q1 will detect any of the following conditions:

1. Cable open
2. "+" to "-" short
3. "+" to GND short
4. "-" to GND short
5. "+" to battery short
6. "-" to battery short
7. Cable is linked incorrectly (DOUT+/DOUT- connections reversed)

The device will detect any of the above conditions, but does not report specifically which one has occurred.

Feature Description (continued)

7.3.13 Interrupt Pin (INTB)

The INTB pin is an active low interrupt output pin that acts as an interrupt for various local and remote interrupt conditions (see registers 0xC6 and 0xC7 of [Register Maps](#)). For the remote interrupt condition, the INTB pin works in conjunction with the INTB_IN pin on the deserializer. This interrupt signal, when configured, will propagate from the deserializer to the serializer.

1. On the Serializer, set register 0xC6[5] = 1 and 0xC6[0] = 1
2. Deserializer INTB_IN pin is set *LOW* by some downstream device.
3. Serializer pulls INTB pin *LOW*. The signal is active *LOW*, so a *LOW* indicates an interrupt condition.
4. External controller detects INTB = *LOW*; to determine interrupt source, read ISR register.
5. A read to ISR will clear the interrupt at the Serializer, releasing INTB.
6. The external controller typically must then access the remote device to determine downstream interrupt source and clear the interrupt driving the Deserializer INTB_IN. This would be when the downstream device releases the INTB_IN pin on the Deserializer. The system is now ready to return to step (2) at next falling edge of INTB_IN.

7.3.14 Remote Interrupt Pin (REM_INTB)

REM_INTB will mirror the status of INTB_IN pin on the deserializer and does not need to be cleared. If the serializer is not linked to the deserializer, REM_INTB will be high.

7.3.15 General-Purpose I/O

7.3.15.1 GPIO[3:0] and D_GPIO[3:0] Configuration

In normal operation, GPIO[3:0] may be used as general-purpose IOs in either forward channel (outputs) or back channel (inputs) mode. GPIO and D_GPIO modes may be configured from the registers. The same registers configure either GPIO or D_GPIO, depending on the status of PORT1_SEL and PORT0_SEL bits (0x1E[1:0]). D_GPIO operation requires 2-lane FPD-Link III mode. See [Table 1](#) for GPIO enable and configuration.

Table 1. GPIO Enable and Configuration

| DESCRIPTION | DEVICE | FORWARD CHANNEL | BACK CHANNEL |
|-----------------|--------------|-----------------|-----------------|
| GPIO3 / D_GPIO3 | Serializer | 0x0F[3:0] = 0x3 | 0x0F[3:0] = 0x5 |
| | Deserializer | 0x1F[3:0] = 0x5 | 0x1F[3:0] = 0x3 |
| GPIO2 / D_GPIO2 | Serializer | 0x0E[7:4] = 0x3 | 0x0E[7:4] = 0x5 |
| | Deserializer | 0x1E[7:4] = 0x5 | 0x1E[7:4] = 0x3 |
| GPIO1 / D_GPIO1 | Serializer | 0x0E[3:0] = 0x3 | 0x0E[3:0] = 0x5 |
| | Deserializer | 0x1E[3:0] = 0x5 | 0x1E[3:0] = 0x3 |
| GPIO0 / D_GPIO0 | Serializer | 0x0D[3:0] = 0x3 | 0x0D[3:0] = 0x5 |
| | Deserializer | 0x1D[3:0] = 0x5 | 0x1D[3:0] = 0x3 |

7.3.15.2 Back Channel Configuration

The D_GPIO[3:0] pins can be configured to obtain different sampling rates depending on the mode as well as back channel frequency. These different modes are controlled by a compatible deserializer. Consult the appropriate deserializer datasheet for details on how to configure the back channel frequency. See [Table 2](#) for details about D_GPIOs in various modes.

Table 2. Back Channel D_GPIO Effective Frequency

| HSCC_MODE (on DES) | MODE | NUMBER OF D_GPIOs | SAMPLES PER FRAME | D_GPIO Effective Frequency ⁽¹⁾ (kHz) | | | D_GPIOs ALLOWED |
|-----------------------|--------|----------------------|----------------------|---|---------------------------|---------------------------|--------------------|
| | | | | 5 Mbps BC ⁽²⁾ | 10 Mbps BC ⁽³⁾ | 20 Mbps BC ⁽⁴⁾ | |
| 000 | Normal | 4 | 1 | 33 | 66 | 133 | D_GPIO[3:0] |
| 011 | Fast | 4 | 6 | 200 | 400 | 800 | D_GPIO[3:0] |
| 010 | Fast | 2 | 10 | 333 | 666 | 1333 | D_GPIO[1:0] |
| 001 | Fast | 1 | 15 | 500 | 1000 | 2000 | D_GPIO0 |

- (1) The effective frequency assumes the worst case back channel frequency (-20%) and a 4X sampling rate.
 (2) 5 Mbps corresponds to BC_FREQ_SELECT = 0 & BC_HS_CTL = 0 on deserializer.
 (3) 10 Mbps corresponds to BC_FREQ_SELECT = 1 & BC_HS_CTL = 0 on deserializer.
 (4) 20 Mbps corresponds to BC_FREQ_SELECT = X & BC_HS_CTL = 1 on deserializer.

7.3.15.3 GPIO_REG[8:5] Configuration

GPIO_REG[8:5] are register-only GPIOs and may be programmed as outputs or read as inputs through local register bits only. Where applicable, these bits are shared with I²S pins and will override I²S input if enabled into GPIO_REG mode. See [Table 3](#) for GPIO enable and configuration.

A local GPIO value may be configured and read either through local register access, or remote register access through the Bidirectional Control Channel. Configuration and state of these pins are not transported from serializer to deserializer as is the case for GPIO[3:0].

Table 3. GPIO_REG and GPIO Local Enable and Configuration

| DESCRIPTION | REGISTER CONFIGURATION | FUNCTION |
|-------------|------------------------|----------------------|
| GPIO_REG8 | 0x11[7:4] = 0x01 | Output, L |
| | 0x11[7:4] = 0x09 | Output, H |
| | 0x11[7:4] = 0x03 | Input, Read: 0x1D[0] |
| GPIO_REG7 | 0x11[3:0] = 0x1 | Output, L |
| | 0x11[3:0] = 0x9 | Output, H |
| | 0x11[3:0] = 0x3 | Input, Read: 0x1C[7] |
| GPIO_REG6 | 0x10[7:4] = 0x1 | Output, L |
| | 0x10[7:4] = 0x9 | Output, H |
| | 0x10[7:4] = 0x3 | Input, Read: 0x1C[6] |
| GPIO_REG5 | 0x10[3:0] = 0x1 | Output, L |
| | 0x10[3:0] = 0x9 | Output, H |
| | 0x10[3:0] = 0x3 | Input, Read: 0x1C[5] |
| GPIO3 | 0x0F[3:0] = 0x1 | Output, L |
| | 0x0F[3:0] = 0x9 | Output, H |
| | 0x0F[3:0] = 0x3 | Input, Read: 0x1C[3] |
| GPIO2 | 0x0E[7:4] = 0x1 | Output, L |
| | 0x0E[7:4] = 0x9 | Output, H |
| | 0x0E[7:4] = 0x3 | Input, Read: 0x1C[2] |
| GPIO1 | 0x0E[3:0] = 0x1 | Output, L |
| | 0x0E[3:0] = 0x9 | Output, H |
| | 0x0E[3:0] = 0x3 | Input, Read: 0x1C[1] |
| GPIO0 | 0x0D[3:0] = 0x1 | Output, L |
| | 0x0D[3:0] = 0x9 | Output, H |
| | 0x0D[3:0] = 0x3 | Input, Read: 0x1C[0] |

7.3.16 SPI Communication

The SPI Control Channel utilizes the secondary link in a 2-lane FPD-Link III implementation. Two possible modes are available, Forward Channel and Reverse Channel modes. In Forward Channel mode, the SPI Master is located at the Serializer, such that the direction of sending SPI data is in the same direction as the video data. In Reverse Channel mode, the SPI Master is located at the Deserializer, such that the direction of sending SPI data is in the opposite direction as the video data.

The SPI Control Channel can operate in a high speed mode when writing data, but must operate at lower frequencies when reading data. During SPI reads, data is clocked from the slave to the master on the SPI clock falling edge. Thus, the SPI read must operate with a clock period that is greater than the round trip data latency. On the other hand, for SPI writes, data can be sent at much higher frequencies where the MISO pin can be ignored by the master.

SPI data rates are not symmetrical for the two modes of operation. Data over the forward channel can be sent much faster than data over the reverse channel.

NOTE

SPI cannot be used to access Serializer / Deserializer registers.

7.3.16.1 SPI Mode Configuration

SPI is configured over I²C using the High-Speed Control Channel Configuration (HSCC_CONTROL) register 0x43 on the deserializer. HSCC_MODE (0x43[2:0]) must be configured for either High-Speed, Forward Channel SPI mode (110) or High-Speed, Reverse Channel SPI mode (111).

The High-Speed Control Channel should be enabled only after Rx lock has been established.

7.3.16.2 Forward Channel SPI Operation

In Forward Channel SPI operation, the SPI master located at the Serializer generates the SPI Clock (SPLK), Master Out / Slave In data (MOSI), and active low Slave Select (SS). The Serializer oversamples the SPI signals directly using the video pixel clock. The three sampled values for SPLK, MOSI, and SS are each sent on data bits in the forward channel frame. At the Deserializer, the SPI signals are regenerated using the pixel clock. To preserve setup and hold time, the Deserializer will hold MOSI data while the SPLK signal is high. In addition, it delays SPLK by one pixel clock relative to the MOSI data, increasing setup by one pixel clock.

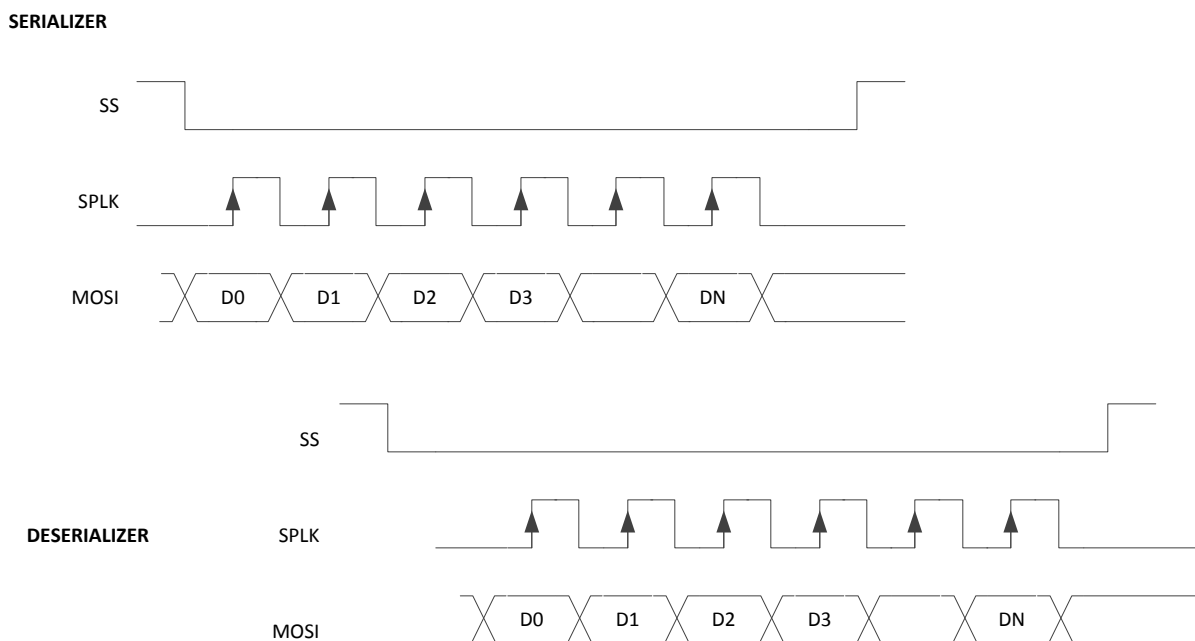


Figure 11. Forward Channel SPI Write

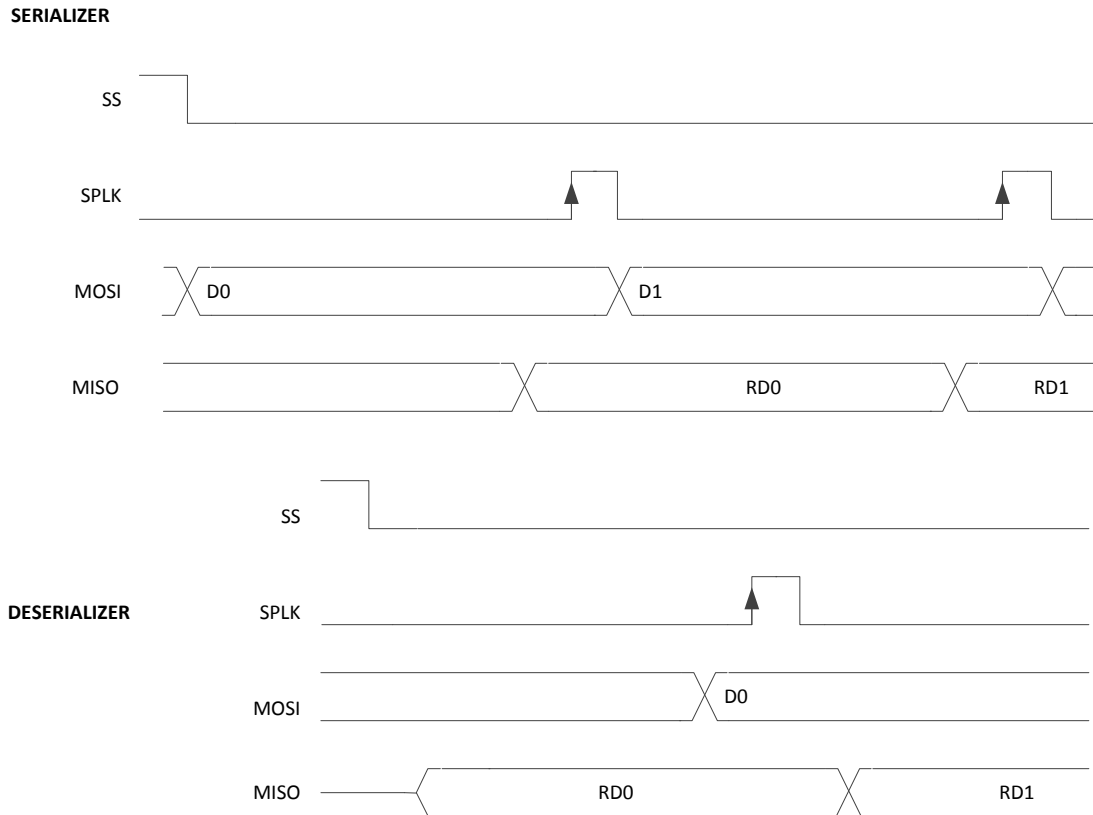


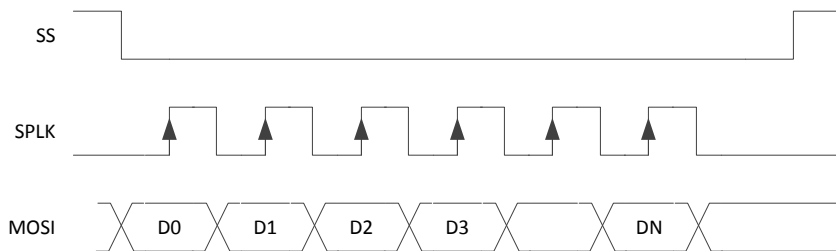
Figure 12. Forward Channel SPI Read

7.3.16.3 Reverse Channel SPI Operation

In Reverse Channel SPI operation, the Deserializer samples the Slave Select (SS), SPI clock (SCLK) into the internal oscillator clock domain. In addition, upon detection of the active SPI clock edge, the Deserializer samples the SPI data (MOSI). The SPI data samples are stored in a buffer to be passed to the Serializer over the back channel. The Deserializer sends SPI information in a back channel frame to the Serializer. In each back channel frame, the Deserializer sends an indication of the Slave Select value. The Slave Select should be inactive (high) for at least one back-channel frame period to ensure propagation to the Serializer.

Because data is delivered in separate back channel frames and buffered, the data may be regenerated in bursts. [Figure 13](#) shows an example of the SPI data regeneration when the data arrives in three back channel frames. The first frame delivered the SS active indication, the second frame delivered the first three data bits, and the third frame delivers the additional data bits.

DESERIALIZER



SERIALIZER

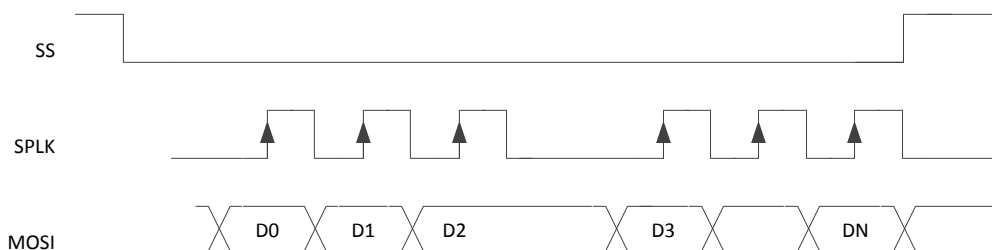
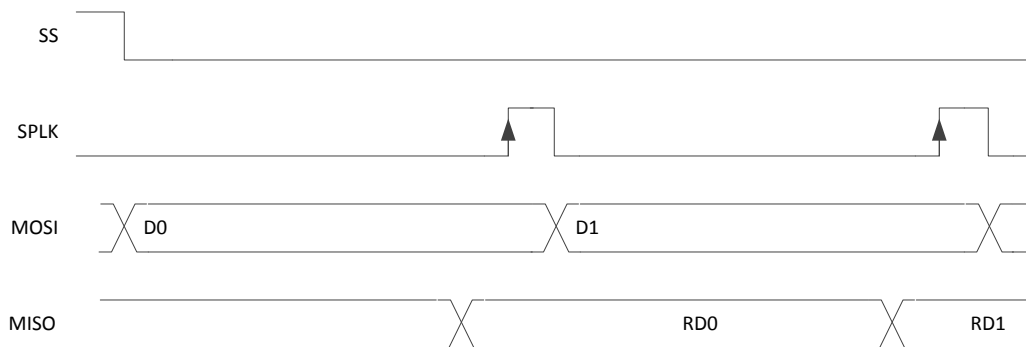


Figure 13. Reverse Channel SPI Write

For Reverse Channel SPI reads, the SPI master must wait for a round-trip response before generating the sampling edge of the SPI clock. This is similar to operation in Forward channel mode. Note that at most one data/clock sample will be sent per back channel frame.

DESERIALIZER



SERIALIZER

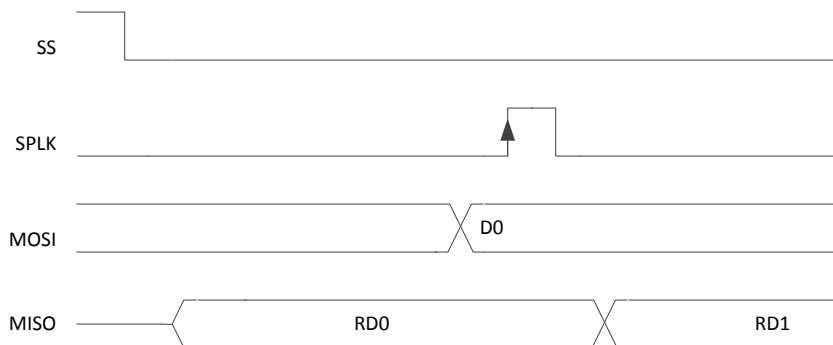


Figure 14. Reverse Channel SPI Read

For both Reverse Channel SPI writes and reads, the SPI_SS signal should be deasserted for at least one back channel frame period.

Table 4. SPI SS Deassertion Requirement

| BACK CHANNEL FREQUENCY | DEASSERTION REQUIREMENT |
|------------------------|-------------------------|
| 5 Mbps | 7.5 μ s |
| 10 Mbps | 3.75 μ s |
| 20 Mbps | 1.875 μ s |

7.3.17 Backward Compatibility

This FPD-Link III serializer is backward-compatible to the DS90UB926Q-Q1 and DS90UB928Q-Q1 for TMDS clock frequencies ranging from 25 MHz to 85 MHz. Backward compatibility does not need to be enabled. When paired with a backward compatible device, the serializer will auto-detect to 1-lane FPD-Link III on the primary channel (DOUT0 \pm).

7.3.18 Audio Modes

The DS90UB949-Q1 supports several audio modes and functions:

- HDMI Mode
- DVI Mode
- AUX Audio Channel

When using with the DS90UH926-Q1 because the default audio mode is I2S Surround Sound and DS90UH926-Q1 can not receive more than 2 channels of audio while in 24-bit mode, the DS90UB949-Q1 will automatically transmit 18-bit video to a DS90UH926-Q1. To transmit 24-bit video to a DS90UH926-Q1, I2S Surround must be disabled by writing to register 0x1A[0]=0.

7.3.18.1 HDMI Audio

The DS90UB949-Q1 allows embedded audio in the HDMI interface to be transported over the FPD-Link III serial link and output on the compatible deserializer. Depending on the number of channels, HDMI audio can be output on several I²S pins on the deserializer, or it can be converted to TDM to output on one audio output pin on the deserializer.

7.3.18.2 DVI I2S Audio Interface

The DS90UB949-Q1 serializer features six I²S input pins that, when paired with a compatible deserializer, supports 7.1 High-Definition (HD) Surround Sound audio applications. The bit clock (I2S_CLK) supports frequencies between 1 MHz and the lesser of IN_CLK/2 or 13 MHz. Four I²S data inputs transport two channels of I²S-formatted digital audio each, with each channel delineated by the word select (I2S_WC) input. Refer to [Figure 15](#) and [Figure 16](#) for I2S connection diagram and timing information.

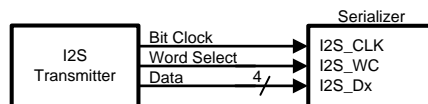


Figure 15. I²S Connection Diagram

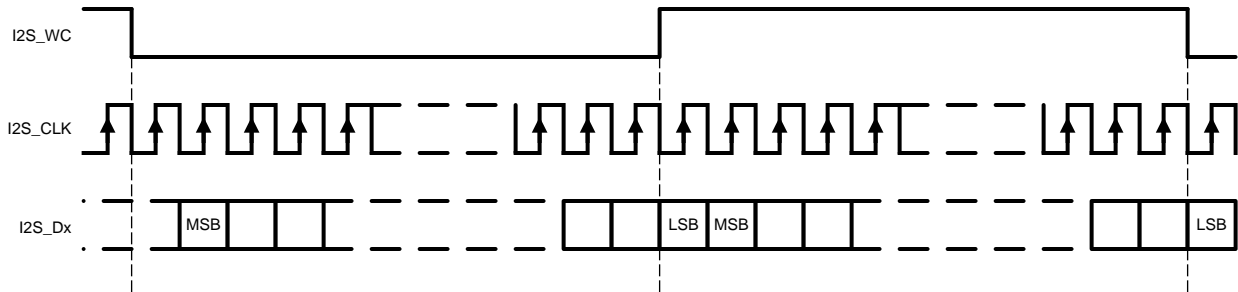


Figure 16. I2S Frame Timing Diagram

Table 5 covers several common I²S sample rates:

Table 5. Audio Interface Frequencies

| SAMPLE RATE (kHz) | I ² S DATA WORD SIZE (BITS) | I ² S CLK (MHz) |
|-------------------|--|----------------------------|
| 32 | 16 | 1.024 |
| 44.1 | 16 | 1.411 |
| 48 | 16 | 1.536 |
| 96 | 16 | 3.072 |
| 192 | 16 | 6.144 |
| 32 | 24 | 1.536 |
| 44.1 | 24 | 2.117 |
| 48 | 24 | 2.304 |
| 96 | 24 | 4.608 |
| 192 | 24 | 9.216 |
| 32 | 32 | 2.048 |
| 44.1 | 32 | 2.822 |
| 48 | 32 | 3.072 |
| 96 | 32 | 6.144 |
| 192 | 32 | 12.288 |

7.3.18.2.1 I2S Transport Modes

By default, audio is packetized and transmitted during video blanking periods in dedicated Data Island Transport frames. Data Island frames may be disabled from control registers if Forward Channel Frame Transport of I²S data is desired. In this mode, only I2S_DA is transmitted to a DS90UB928Q-Q1, DS90UB940-Q1, or a DS90UB948-Q1 deserializer. If connected to a DS90UB926Q-Q1 deserializer, I2S_DA and I2S_DB are transmitted. Surround Sound Mode, which transmits all four I²S data inputs (I2S_D[A..D]), may only be operated in Data Island Transport mode. This mode is only available when connected to a DS90UB928Q-Q1, DS90UB940-Q1, or a DS90UB948-Q1 deserializer.

7.3.18.2.2 I2S Repeater

I²S audio may be fanned-out and propagated in the repeater application. By default, data is propagated through Data Island Transport during the video blanking periods. If frame transport is desired, then the I²S pins should be connected from the deserializer to all serializers. Activating surround sound at the top-level deserializer automatically configures downstream serializers and deserializers for surround sound transport using Data Island Transport. If 4-channel operation using I2S_DA and I2S_DB only is desired, this mode must be explicitly set in each serializer and deserializer control register throughout the repeater tree (Table 10).

7.3.18.3 AUX Audio Channel

The AUX Audio Channel is a single separate I²S audio data channel that may be transported independently of the main audio stream received in either HDMI Mode or DVI Mode. This channel is shared with the GPIO[1:0] interface and is supported by DS90UB940-Q1 and DS90UB948-Q1 deserializers.

7.3.18.4 TDM Audio Interface

In addition to the I²S audio interface, the DS90UB949-Q1 serializer also supports TDM format. Since a number of specifications for TDM format are in common use, the DS90UB949-Q1 offers flexible support for word length, bit clock, number of channels to be multiplexed, and so forth. For example, assume that the word clock signal (I2S_WC) period = 256 × bit clock (I2S_CLK) time period. In this case, the DS90UB949-Q1 can multiplex 4 channels with maximum word length of 64 bits each, or 8 channels with maximum word length of 32 bits each. Figure 17 shows the multiplexing of 8 channels with 24-bit word length, in a format similar to I2S.

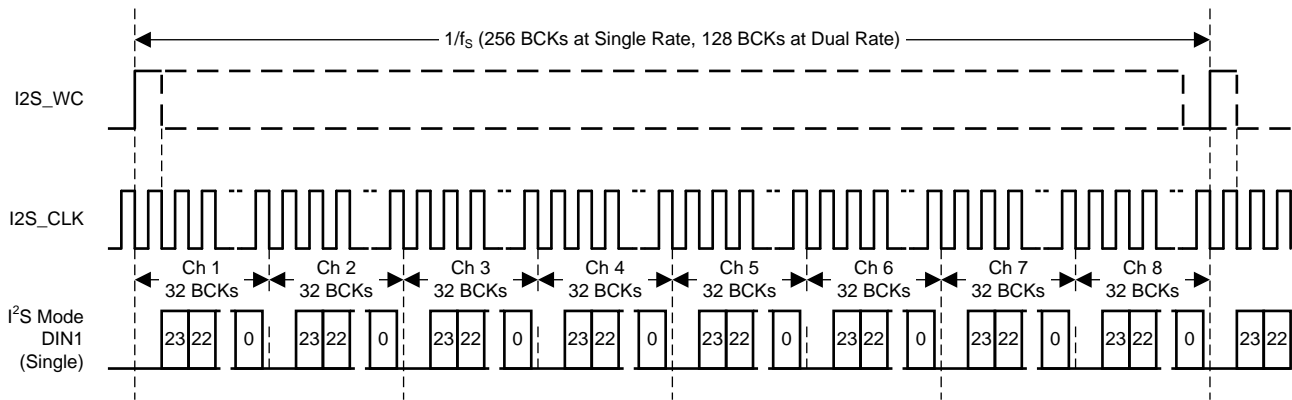


Figure 17. TDM Format

7.3.19 Built-In Self Test (BIST)

An optional At-Speed Built-In Self Test (BIST) feature supports testing of the high-speed serial link and back channel without external data connections. This is useful in the prototype stage, equipment production, in-system test, and system diagnostics.

7.3.19.1 BIST Configuration And Status

The BIST mode is enabled at the deserializer by pin (BISTEN) or BIST configuration register. The test may select either an external TMDS clock or the internal Oscillator clock (OSC) frequency. In the absence of the TMDS clock, the user can select the internal OSC frequency at the deserializer through the BISTC pin or BIST configuration register.

When BIST is activated at the deserializer, a BIST enable signal is sent to the serializer through the Back Channel. The serializer outputs a test pattern and drives the link at speed. The deserializer detects the test pattern and monitors it for errors. The deserializer PASS output pin toggles to flag each frame received containing one or more errors. The serializer also tracks errors indicated by the CRC fields in each back channel frame.

The BIST status can be monitored in real time on the deserializer PASS pin with each detected error resulting in a half-pixel clock period toggled LOW. After BIST is deactivated, the result of the last test is held on the PASS output until reset (new BIST test or Power Down). A High on PASS indicates no errors were detected. A Low on PASS indicates one or more errors were detected. The duration of the test is controlled by the pulse width applied to the deserializer BISTEN pin. LOCK is valid throughout the entire duration of BIST.

See Figure 18 for the BIST mode flow diagram.

Step 1: The Serializer is paired with another FPD-Link III Deserializer, then BIST Mode is enabled through the BISTEN pin or through register on the Deserializer. Right after BIST is enabled, part of the BIST sequence requires bit 0x04[5] be toggled locally on the Serializer (set 0x04[5]=1, then set 0x04[5]=0). The desired clock source is selected through the deserializer BISTC pin or through register on the Deserializer.

Step 2: An all-zeros pattern is balanced, scrambled, randomized, and sent through the FPD-Link III interface to the deserializer. When the serializer and the deserializer are in BIST mode and the deserializer acquires Lock, the PASS pin of the deserializer goes high and BIST starts checking the data stream. If an error in the payload (1 to 35) is detected, the PASS pin will switch low for one-half of the clock period. During the BIST test, the PASS output can be monitored and counted to determine the payload error rate.

Step 3: To stop the BIST mode, the deserializer BISTEN pin is set low. The deserializer stops checking the data. The final test result is held on the PASS pin. If the test ran error-free, the PASS output will remain HIGH. If there one or more errors were detected, the PASS output will output constant LOW. The PASS output state is held until a new BIST is run, the device is reset, or the device is powered down. The BIST duration is user-controlled by the duration of the BISTEN signal.

Step 4: The link returns to normal operation after the deserializer BISTEN pin is low. [Figure 19](#) shows the waveform diagram of a typical BIST test for two cases. Case 1 is error-free, and Case 2 shows one with multiple errors. In most cases, it is difficult to generate errors due to the robustness of the link (differential data transmission and so forth), thus they may be introduced by greatly extending the cable length, faulting the interconnect medium, or reducing signal condition enhancements (Rx Equalization).

For more information on using BIST, refer to the white paper: [Using BIST on 94x](#).

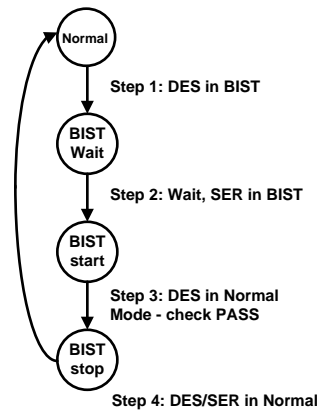


Figure 18. BIST Mode Flow Diagram

7.3.19.2 Forward Channel and Back Channel Error Checking

While in BIST mode, the serializer stops sampling the FPD-Link input pins and switches over to an internal all-zeroes pattern. The internal all-zeroes pattern goes through the scrambler, DC-balancing, and so forth and is transmitted over the serial link to the deserializer. The deserializer, on locking to the serial stream, compares the recovered serial stream with all-zeroes and records any errors in status registers. Errors are also dynamically reported on the PASS pin of the deserializer.

The back-channel data is checked for CRC errors once the serializer locks onto the back-channel serial stream, as indicated by link detect status (register bit 0x0C[0] - [Table 10](#)). CRC errors are recorded in an 8-bit register in the deserializer. The register is cleared when the serializer enters BIST mode. As soon as the serializer enters BIST mode, the functional mode CRC register starts recording any back channel CRC errors. The BIST mode CRC error register is active in BIST mode only, and the register keeps a record of the last BIST run until the register is cleared or the serializer enters BIST mode again.

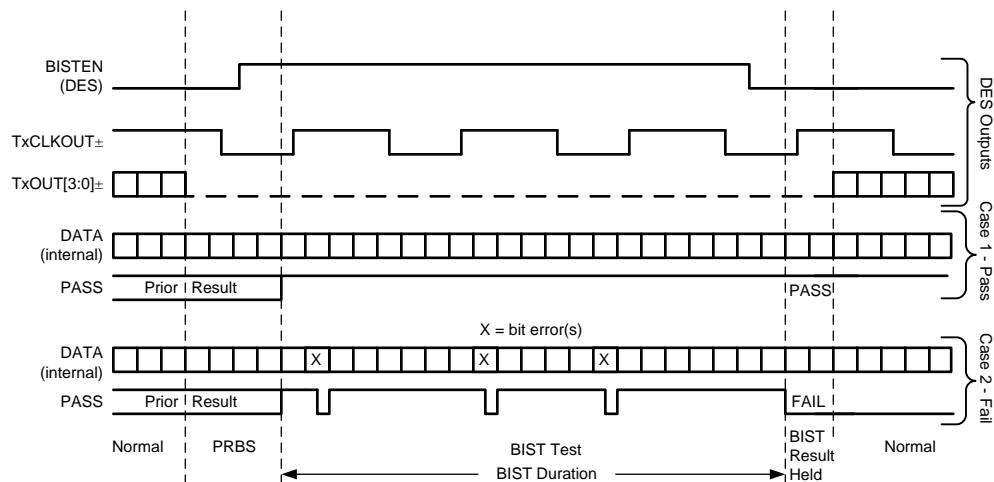


Figure 19. BIST Waveforms, in Conjunction With Deserializer Signals

7.3.20 Internal Pattern Generation

The DS90UB949-Q1 serializer provides an internal pattern generation feature that allows for basic testing and debugging of an integrated panel. The test patterns are simple and repetitive and provide quick visual verification of panel operation. As long as the device is not in power down mode, the test pattern will be displayed even if no input is applied. If no clock is received, the test pattern can be configured to use a programmed oscillator frequency. For more information, refer to [Exploring the Internal Test Pattern Generation Feature of 720p FPD-Link III Devices \(SNLA132\)](#).

7.3.20.1 Pattern Options

The DS90UB949-Q1 serializer pattern generator is capable of generating 17 default patterns designers can use for basic testing and debugging of panels. Each can be inverted using register bits ([Table 10](#)), shown below:

1. White/Black (default/inverted)
2. Black/White
3. Red/Cyan
4. Green/Magenta
5. Blue/Yellow
6. Horizontally Scaled Black to White/White to Black
7. Horizontally Scaled Black to Red/Cyan to White
8. Horizontally Scaled Black to Green/Magenta to White
9. Horizontally Scaled Black to Blue/Yellow to White
10. Vertically Scaled Black to White/White to Black
11. Vertically Scaled Black to Red/Cyan to White
12. Vertically Scaled Black to Green/Magenta to White
13. Vertically Scaled Black to Blue/Yellow to White
14. Custom Color (or its inversion) configured in PGRS
15. Black-White/White-Black Checkerboard (or custom checkerboard color, configured in PGCTL)
16. YCBR/RBCY VCOM pattern, orientation is configurable from PGCTL
17. Color Bars (White, Yellow, Cyan, Green, Magenta, Red, Blue, Black) – Note: not included in the auto-scrolling feature

Additionally, the Pattern Generator incorporates one configurable full-screen, 24-bit color pattern, which is controlled by the PGRS, PGGS, and PGBS registers. This is pattern #14. One of the pattern options is statically selected in the PGCTL register when Auto-Scrolling is disabled. The PGTSC and PGTSO1-8 registers control the pattern selection and order when Auto-Scrolling is enabled.

7.3.20.2 Color Modes

By default, the Pattern Generator operates in 24-bit color mode, where all bits of the Red, Green, and Blue outputs are enabled. 18-bit color mode can be activated from the configuration registers ([Table 10](#)). In 18-bit mode, the 6 most significant bits (bits 7-2) of the Red, Green, and Blue outputs are enabled; the 2 least significant bits will be 0.

7.3.20.3 Video Timing Modes

The Pattern Generator has two video timing modes—external and internal. In external timing mode, the Pattern Generator detects the video frame timing present on the DE and VS inputs. If Vertical Sync signaling is not present on VS, the Pattern Generator determines Vertical Blank by detecting when the number of inactive pixel clocks (DE = 0) exceeds twice the detected active line length. In internal timing mode, the Pattern Generator uses custom video timing as configured in the control registers. The internal timing generation may also be driven by an external clock. By default, external timing mode is enabled. Internal timing or internal timing with external clock are enabled by the control registers ([Table 10](#)).

7.3.20.4 External Timing

In external timing mode, the Pattern Generator passes the incoming DE, HS, and VS signals unmodified to the video control outputs after a two-pixel clock delay. It extracts the active frame dimensions from the incoming signals to properly scale the brightness patterns. If the incoming video stream does not use the VS signal, the Pattern Generator determines the Vertical Blank time by detecting a long period of pixel clocks without DE asserted.

7.3.20.5 Pattern Inversion

The Pattern Generator also incorporates a global inversion control, located in the PGCFG register, which causes the output pattern to be bitwise-inverted. For example, the full screen Red pattern becomes full-screen Cyan, and the Vertically Scaled Black to Green pattern becomes Vertically Scaled White to Magenta.

7.3.20.6 Auto Scrolling

The Pattern Generator supports an Auto-Scrolling mode, in which the output pattern cycles through a list of enabled pattern types. A sequence of up to 16 patterns may be defined in the registers. The patterns may appear in any order in the sequence and may also appear more than once.

7.3.20.7 Additional Features

Additional pattern generator features can be accessed through the Pattern Generator Indirect Register Map. It consists of the Pattern Generator Indirect Address (PGIA reg_0x66 — [Table 10](#)) and the Pattern Generator Indirect Data (PGID reg_0x67 — [Table 10](#)). See [Exploring the Internal Test Pattern Generation Feature of 720p FPD-Link III Devices](#) (SNLA132).

7.3.21 Spread Spectrum Clock Tolerance

The DS90UB949-Q1 (for DVI mode) tolerates a spread spectrum input clock to help reduce EMI. The following triangular SSC profile is supported:

- Frequency deviation $\leq 2.5\%$
- Modulation rate ≤ 100 kHz

Maximum frequency deviation and maximum modulation rate are not supported simultaneously. Some typical examples:

- Frequency deviation: 2.5%, modulation rate: 50 kHz
- Frequency deviation: 1.25%, modulation rate: 100 kHz

7.4 Device Functional Modes

7.4.1 Mode Select Configuration Settings (MODE_SEL[1:0])

Configuration of the device may be done through the MODE_SEL[1:0] input pins, or through the configuration register bits. A pullup resistor and a pulldown resistor of suggested values may be used to set the voltage ratio of the MODE_SEL[1:0] inputs. See [Table 7](#) and [Table 8](#). These values will be latched into the register location during power-up:

Table 6. MODE_SEL[1:0] Settings

| MODE | SETTING | FUNCTION |
|---------------------------------------|---------|--|
| EDID_SEL: Display ID Select | 0 | Look for remote EDID. If none found, use internal SRAM EDID. Can be overridden from register. Remote EDID address may be overridden from default 0xA0. |
| | 1 | Use external local EDID. |
| AUX_I2S: AUX Audio Channel | 0 | HDMI audio. |
| | 1 | HDMI + AUX audio channel. |
| EXT_CTL: External Controller Override | 0 | Internal HDMI control. |
| | 1 | External HDMI control from I2C interface pins. |
| COAX: Cable Type | 0 | Enable FPD-Link III for twisted-pair cabling. |
| | 1 | Enable FPD-Link III for coaxial cabling. |
| REM_EDID_LOAD: Remote EDID Load | 0 | Use internal SRAM EDID. |
| | 1 | If available, remote EDID is copied into internal SRAM EDID. |

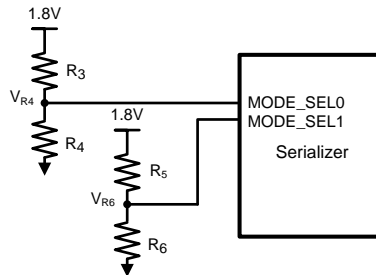


Figure 20. MODE_SEL[1:0] Connection Diagram

Table 7. Configuration Select (MODE_SEL0)

| # | RATIO V_{R4}/V_{DD18} | TARGET V_{R4} (V) | SUGGESTED RESISTOR PULLUP R3 kΩ (1% tol) | SUGGESTED RESISTOR PULLDOWN R4 kΩ (1% tol) | EDID_SEL | AUX_I2S |
|---|-------------------------|---------------------|--|--|----------|---------|
| 1 | 0 | 0 | OPEN | Any value less than 100 ⁽¹⁾ | 0 | 0 |
| 2 | 0.208 | 0.374 | 118 | 30.9 | 0 | 1 |
| 3 | 0.553 | 0.995 | 82.5 | 102 | 1 | 0 |
| 4 | 0.668 | 1.202 | 68.1 | 137 | 1 | 1 |

(1) This resistor does not need to be 1% tolerance. 5% is acceptable.

Table 8. Configuration Select (MODE_SEL1)

| # | RATIO V_{R6}/V_{DD18} | TARGET V_{R6} (V) | SUGGESTED RESISTOR PULLUP R5 kΩ (1% tol) | SUGGESTED RESISTOR PULLDOWN R6 kΩ (1% tol) | EXT_CTL | COAX | REM_EDID_LOAD |
|---|-------------------------|---------------------|--|--|---------|------|---------------|
| 1 | 0 | 0 | OPEN | Any value less than 100 ⁽¹⁾ | 0 | 0 | 0 |

(1) This resistor does not need to be 1% tolerance. 5% is acceptable.

Table 8. Configuration Select (MODE_SEL1) (continued)

| # | RATIO V_{R6}/V_{DD18} | TARGET V_{R6} (V) | SUGGESTED RESISTOR PULLUP R5 k Ω (1% tol) | SUGGESTED RESISTOR PULLDOWN R6 k Ω (1% tol) | EXT_CTL | COAX | REM_EDID_LOAD |
|---|----------------------------|------------------------|---|---|---------|------|---------------|
| 2 | 0.208 | 0.374 | 118 | 30.9 | 0 | 0 | 1 |
| 3 | 0.323 | 0.582 | 107 | 51.1 | 0 | 1 | 0 |
| 4 | 0.440 | 0.792 | 113 | 88.7 | 0 | 1 | 1 |
| 5 | 0.553 | 0.995 | 82.5 | 102 | 1 | 0 | 0 |
| 6 | 0.668 | 1.202 | 68.1 | 137 | 1 | 0 | 1 |
| 7 | 0.789 | 1.420 | 56.2 | 210 | 1 | 1 | 0 |
| 8 | 1 | 1.8 | Any value less than 100 ⁽¹⁾ | OPEN | 1 | 1 | 1 |

The strapped values can be viewed and/or modified in the following locations:

- EDID_SEL : Latched into BRIDGE_CTL[0], EDID_DISABLE (0x4F[0]).
- AUX_I2S : Latched into BRIDGE_CFG[1], AUDIO_MODE[1] (0x54[1]).
- EXT_CTL: Latched into BRIDGE_CFG[7], EXT_CONTROL (0x54[7]).
- COAX : Latched into DUAL_CTL1[7], COAX_MODE (0x5B[7]).
- REM_EDID_LOAD : Latched into BRIDGE_CFG[5] (0x54[5]).

7.4.2 FPD-Link III Modes of Operation

The FPD-Link III transmit logic supports several modes of operation, dependent on the downstream receiver as well as the video being delivered. The following modes are supported:

7.4.2.1 Single Link Operation

Single Link mode transmits the video over a single FPD-Link III to a single receiver. Single link mode supports frequencies up to 96MHz for 24-bit video when paired with the DS90UB940-Q1/DS90UB948-Q1. This mode is compatible with the DS90UB926Q-Q1/DS90UB928Q-Q1 when operating below 85MHz. If the downstream device is capable, the secondary FPD-Link III link could be used for high-speed control.

In Forced Single mode (set via DUAL_CTL1 register), the secondary TX Phy and back channel are disabled.

7.4.2.2 Dual Link Operation

In Dual Link mode, the FPD-Link III TX splits a single video stream and sends alternating pixels on two downstream links. The receiver must be a DS90UB948-Q1 or DS90UB940-Q1, capable of receiving the dual-stream video. Dual link mode is capable of supporting an TMDS clock frequency of up to 170MHz, with each FPD-Link III TX port running at one-half the frequency. This allows support for full 1080p video. The secondary FPD-Link III link could be used for high-speed control.

Dual Link mode may be automatically configured when connected to a DS90UB948-Q1/DS90UB940-Q1, if the video meets minimum frequency requirements. Dual Link mode may also be forced using the DUAL_CTL1 register.

7.4.2.3 Replicate Mode

In this mode, the FPD-Link III TX operates as a 1:2 Repeater. The same video (up to 85MHz, 24-bit color) is delivered to each receiver.

Replicate mode may be automatically configured when connected to two independent Deserializers.

7.4.2.4 Auto-Detection of FPD-Link III Modes

The DS90UB949-Q1 automatically detects the capabilities of downstream links and can resolve whether a single device, dual-capable device, or multiple single link devices are connected.

In addition to the downstream device capabilities, the DS90UB949-Q1 will be able to detect the HDMI pixel clock frequency to select the proper operating mode.

If the DS90UB949-Q1 detects two independent devices, it will operate in Replicate mode, sending the single channel video on both connections. If the device detects a device on the secondary link, but not the first, it can send the video only on the second link.

Auto-detection can be disabled to allow forced modes of operation using the Dual Link Control Register (DUAL_CTL1).

7.4.3 Frequency Detection Circuit May Reset the FPD-Link III PLL During a Temperature Ramp

When ambient temperature around the DS90UB949-Q1 changes by more than 40°C, the frequency detection logic in the device can RESET the FPD-Link III PLL even though the input PCLK has not changed. This behavior may result in a loss of lock in the Deserializer and flicker on the system display.

The following programming sequence is required for all systems. This should be written after the user register configuration of the DS90UB949-Q1 and downstream deserializer configuration.

- Disable the “Reset FPD-Link III PLL on Frequency Change” feature after the DS90UB949-Q1 power-up.
 - Set Reg0x5B[5]=0b (Disable PLL reset feature via RST_PLL_FREQ field in DUAL_CTL1 register)

Any device configuration including this one should be written as a part of the Init A sequence as shown in [Figure 33](#).

7.5 Programming

7.5.1 Serial Control Bus

This serializer may also be configured by the use of a I2C-compatible serial control bus. Multiple devices may share the serial control bus (up to 8 device addresses supported). The device address is set through a resistor divider (R1 and R2 — see [Figure 21](#) below) connected to the IDx pin.

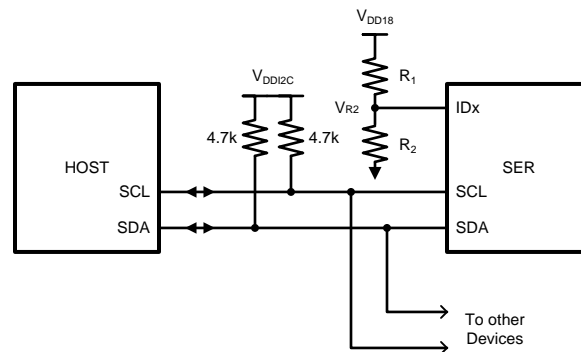


Figure 21. Serial Control Bus Connection

The serial control bus consists of two signals, SCL and SDA. SCL is a Serial Bus Clock Input. SDA is the Serial Bus Data Input / Output signal. Both SCL and SDA signals require an external pullup resistor to V_{DD18} or V_{DD33} . For most applications, a 4.7-kΩ pullup resistor is recommended. However, the pullup resistor value may be adjusted for capacitive loading and data rate requirements. The signals are either pulled High, or driven Low.

The IDx pin configures the control interface to one of 8 possible device addresses. A pullup resistor and a pull-down resistor may be used to set the appropriate voltage on the IDx input pin See [Table 10](#). 1% or 5% resistors can be used.

Table 9. Serial Control Bus Addresses for IDx

| # | RATIO V_{R2} / V_{DD18} | IDEAL V_{R2} (V) | SUGGESTED RESISTOR R1 kΩ (1% tol) | SUGGESTED RESISTOR R2 kΩ (1% tol) | 7-BIT ADDRESS | 8-BIT ADDRESS |
|---|------------------------------|-----------------------|---|---|---------------|---------------|
| 1 | 0 | 0 | OPEN | Any value less than 100 ⁽¹⁾ | 0x0C | 0x18 |
| 2 | 0.208 | 0.374 | 118 | 30.9 | 0x0E | 0x1C |

(1) This resistor does not need to be 1% tolerance. 5% is acceptable.

Programming (continued)

Table 9. Serial Control Bus Addresses for IDx (continued)

| # | RATIO V_{R2} / V_{DD18} | IDEAL V_{R2} (V) | SUGGESTED RESISTOR R1 k Ω (1% tol) | SUGGESTED RESISTOR R2 k Ω (1% tol) | 7-BIT ADDRESS | 8-BIT ADDRESS |
|---|---------------------------|--------------------|---|---|---------------|---------------|
| 3 | 0.323 | 0.582 | 107 | 51.1 | 0x10 | 0x20 |
| 4 | 0.440 | 0.792 | 113 | 88.7 | 0x12 | 0x24 |
| 5 | 0.553 | 0.995 | 82.5 | 102 | 0x14 | 0x28 |
| 6 | 0.668 | 1.202 | 68.1 | 137 | 0x16 | 0x2C |
| 7 | 0.789 | 1.420 | 56.2 | 210 | 0x18 | 0x30 |
| 8 | 1 | 1.8 | Any value less than 100 ⁽¹⁾ | OPEN | 0x1A | 0x34 |

The Serial Bus protocol is controlled by START, START-Repeated, and STOP phases. A START occurs when SCL transitions Low while SDA is High. A STOP occurs when SDA transitions High while SCL is also HIGH. See Figure 22.

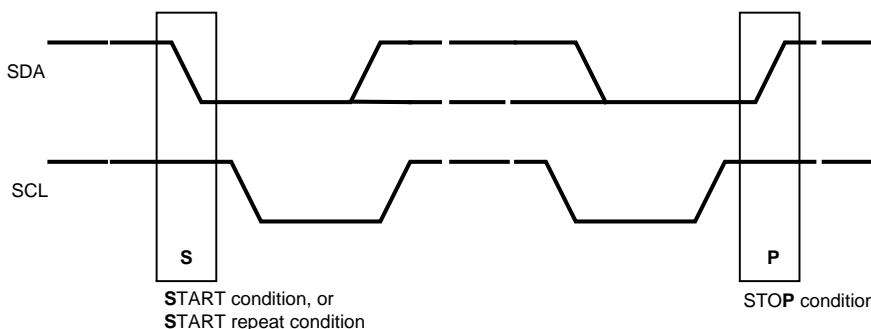


Figure 22. Start and Stop Conditions

To communicate with an I2C slave, the host controller (master) sends the slave address and listens for a response from the slave. This response is referred to as an acknowledge bit (ACK). If a slave on the bus is addressed correctly, it Acknowledges (ACKs) the master by driving the SDA bus Low. If the address does not match a slave address of the device, it Not-acknowledges (NACKs) the master by letting SDA be pulled High. ACKs also occur on the bus when data is being transmitted. When the master is writing data, the slave ACKs after every data byte is successfully received. When the master is reading data, the master ACKs after every data byte is received to let the slave know that the host is ready to receive another data byte. When the master wants to stop reading, it NACKs after the last data byte and creates a stop condition on the bus. All communication on the bus begins with either a Start condition or a Repeated Start condition. All communication on the bus ends with a Stop condition. A READ is shown in Figure 23 and a WRITE is shown in Figure 24.

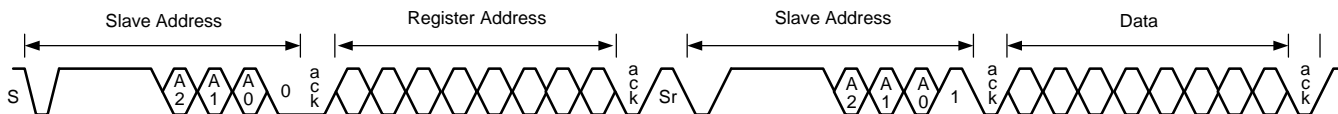


Figure 23. Serial Control Bus — Read



Figure 24. Serial Control Bus — Write

The I2C Master located at the serializer must support I2C clock stretching. For more information on I²C interface requirements and throughput considerations, refer to the TI Application Note [AN-2173 I2C Communication Over FPD-Link III with Bidirectional Control Channel](#) (SNLA131).

7.5.2 Multi-Master Arbitration Support

The Bidirectional Control Channel in the FPD-Link III devices implements I²C-compatible bus arbitration in the proxy I2C master implementation. When sending a data bit, each I2C master senses the value on the SDA line. If the master is sending a logic 1 but senses a logic 0, the master has lost arbitration. It will stop driving SDA, retrying the transaction when the bus becomes idle. Thus, multiple I2C masters may be implemented in the system.

Ensure that all I2C masters on the bus support multi-master arbitration.

Assign I2C addresses with more than a single bit set to 1 for all devices on the I²C bus. 0x6A, 0x7B, and 0x37 are examples of good choices for an I2C address. 0x40 and 0x20 are examples of bad choices for an I2C address.

If the system does require master-slave operation in both directions across the BCC, some method of communication must be used to ensure only one direction of operation occurs at any time. The communication method could include using available read/write registers in the deserializer to allow masters to communicate with each other to pass control between the two masters. An example would be to use register 0x18 or 0x19 in the deserializer as a mailbox register to pass control of the channel from one master to another.

7.5.3 I2C Restrictions on Multi-Master Operation

The I2C specification does not provide for arbitration between masters under certain conditions. The system should make sure the following conditions cannot occur to prevent undefined conditions on the I²C bus:

- One master generates a repeated Start while another master is sending a data bit.
- One master generates a Stop while another master is sending a data bit.
- One master generates a repeated Start while another master sends a Stop.

Note that these restrictions mainly apply to accessing the same register offsets within a specific I2C slave.

7.5.4 Multi-Master Access to Device Registers for Newer FPD-Link III Devices

When using the latest generation of FPD-Link III devices, DS90UB949-Q1 or DS90UB940-Q1/DS90UB948-Q1 registers may be accessed simultaneously from both local and remote I2C masters. These devices have internal logic to properly arbitrate between sources to allow proper read and write access without risk of corruption.

Access to remote I2C slaves would still be allowed in only one direction at a time.

7.5.5 Multi-Master Access to Device Registers for Older FPD-Link III Devices

When using older FPD-Link III devices, simultaneous access to serializer or deserializer registers from both local and remote I2C masters may cause incorrect operation, thus restrictions should be imposed on accessing of serializer and deserializer registers. The likelihood of an error occurrence is relatively small, but it is possible for collision on reads and writes to occur, resulting in an errored read or write.

Two basic options are recommended. The first is to allow device register access only from one controller. This would allow only the Host controller to access the serializer registers (local) and the deserializer registers (remote). A controller at the deserializer would not be allowed to access the deserializer or serializer registers.

The second basic option is to allow local register access only with no access to remote serializer or deserializer registers. The Host controller would be allowed to access the serializer registers while a controller at the deserializer could access those register only. Access to remote I2C slaves would still be allowed in one direction.

In a very limited case, remote and local access could be allowed to the deserializer registers at the same time. Register access can work as intended if both local and remote masters are accessing the same deserializer register. This allows a simple method of passing control of the Bidirectional Control Channel from one master to another.

7.5.6 Restrictions on Control Channel Direction for Multi-Master Operation

Only one direction should be active at any time across the Bidirectional Control Channel. If both directions are required, some method of transferring control between I2C masters should be implemented.

7.6 Register Maps

Table 10. Serial Control Bus Registers

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---|--------|---------------|---------------|----------------|--|
| 0 | 0x00 | I2C Device ID | 7:1 | RW | Strap | DEVICE_ID | 7-bit address of Serializer. Defaults to address configured by the IDx strap pin. |
| | | | 0 | RW | 0x00 | ID Setting | I2C ID setting. 0: Device I2C address is from IDx strap pin (default). 1: Device I2C address is from 0x00[7:1]. |
| 1 | 0x01 | Reset A software I2C reset command issued by writing to register 0x01 is supported only when operating I2C in the 3.3V mode. | 7:5 | | 0x00 | | Reserved. |
| | | | 4 | RW | | HDMI Reset | HDMI Digital Reset. Resets the HDMI digital block. This bit is self-clearing. 0: Normal operation. 1: Reset. |
| | | | 3:2 | | | | Reserved. |
| | | | 1 | RW | | Digital RESET1 | Reset the entire digital block including registers. This bit is self-clearing. 0: Normal operation (default). 1: Reset. Following the setting of this bit, the software should also set bit 0x4F[1] (BRIDGE_CTL register). This will restore register values that are initially loaded from Non-Volatile Memory to their default state. |
| | | | 0 | RW | | Digital RESET0 | Reset the entire digital block except registers. This bit is self-clearing. 0: Normal operation (default). 1: Reset. Registers which are loaded by pin strap will be restored to their original strap value when this bit is set. These registers show 'Strap' as their default value in this table. Registers 0x00, 0x13, 0x15, 0x18, 0x19, 0x1A, 0x48-0x55, 0x58, 0x5B, 0xC0, 0xC2, 0xC3, 0xC6, 0xC8, 0xCE and 0xD0 are also restored to their default value when this bit is set. |

Register Maps (continued)

Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|-----------------------|--------|---------------|---|---|---|
| 3 | 0x03 | General Configuration | 7 | RW | 0xD2 | Back channel CRC Checker Enable | Enable/disable back channel CRC Checker. 0: Disable. 1: Enable (default). |
| | | | 6 | | | <i>Reserved.</i> | |
| | | | 5 | RW | | I2C Remote Write Auto Acknowledge Port0/Port1 | Automatically acknowledge I2C remote writes. When enabled, I2C writes to the Deserializer (or any remote I2C Slave, if I2C PASS ALL is enabled) are immediately acknowledged without waiting for the Deserializer to acknowledge the write. This allows higher throughput on the I2C bus. Note: this mode will prevent any NACK from a remote device from reaching the I2C master. 0: Disable (default). 1: Enable. If PORT1_SEL is set, this register controls Port1 operation. |
| | | | 4 | RW | | Filter Enable | HS, VS, DE two-clock filter. When enabled, pulses less than two full TMDS clock cycles on the DE, HS, and VS inputs will be rejected. 0: Filtering disable. 1: Filtering enable (default). |
| | | | 3 | RW | | I2C Pass-through Port0/Port1 | I2C pass-through mode. Read/Write transactions matching any entry in the Slave Alias registers will be passed through to the remote Deserializer. 0: Pass-through disabled (default). 1: Pass-through enabled. If PORT1_SEL is set, this register controls Port1 operation. |
| | | | 2 | | | <i>Reserved.</i> | |
| | | | 1 | RW | | TMDS Clock Auto | Switch over to internal oscillator in the absence of TMDS Clock. 0: Disable auto-switch. 1: Enable auto-switch (default). |
| | | | 0 | | | <i>Reserved.</i> | |
| | | | 4 | 0x04 | | Mode Select | 7 |
| 6 | | <i>Reserved.</i> | | | | | |
| 5 | RW | CRC Error Reset | | | Clear back channel CRC Error counters. This bit is NOT self-clearing. 0: Normal operation (default). 1: Clear counters. | | |
| 4 | | Video gate | | | Reserved. | | |
| 3:0 | | | | | Reserved. | | |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---------------|--------|---------------|---------------|------------------------------|---|
| 5 | 0x05 | I2C Control | 7:5 | | 0x00 | | Reserved. |
| | | | 4:3 | RW | | SDA Output Delay | Configures output delay on the SDA output. Setting this value will increase output delay in units of 40ns. Nominal output delay values for SCL to SDA are: 00: 240ns (default). 01: 280ns. 10: 320ns. 11: 360ns. |
| | | | 2 | RW | | Local Write Disable | Disable remote writes to local registers. Setting this bit to 1 will prevent remote writes to local device registers from across the control channel. This prevents writes to the Serializer registers from an I2C master attached to the Deserializer. Setting this bit does not affect remote access to I2C slaves at the Serializer. 0: Enable (default). 1: Disable. |
| | | | 1 | RW | | I2C Bus Timer Speedup | Speed up I2C bus Watchdog Timer. 0: Watchdog Timer expires after approximately 1s (default). 1: Watchdog Timer expires after approximately 50µs. |
| | | | 0 | RW | | I2C Bus Timer Disable | Disable I2C bus Watchdog Timer. The I2C Watchdog Timer may be used to detect when the I2C bus is free or hung up following an invalid termination of a transaction. If SDA is high and no signaling occurs for approximately 1s, the I2C bus will be assumed to be free. If SDA is low and no signaling occurs, the device will attempt to clear the bus by driving 9 clocks on SCL. 0: Enable (default). 1: Disable. |
| 6 | 0x06 | DES ID | 7:1 | RW | 0x00 | DES Device ID Port0/Port1 | 7-bit I2C address of the remote Deserializer. A value of 0 in this field disables I2C access to the remote Deserializer. This field is automatically configured by the Bidirectional Control Channel once RX Lock has been detected. Software may overwrite this value, but should also assert the FREEZE DEVICE ID bit to prevent overwriting by the Bidirectional Control Channel. If PORT1_SEL is set, this register indicates the Deserializer Device ID for the Deserializer attached to Port1. |
| | | | 0 | RW | | Freeze Device ID Port0/Port1 | Freeze Deserializer Device ID. 1: Prevents auto-loading of the Deserializer Device ID by the Bidirectional Control Channel. The ID will be frozen at the value written. 0: Allows auto-loading of the Deserializer Device ID from the Bidirectional Control Channel. If PORT1_SEL is set, this register is with reference to Port1. |

Register Maps (continued)

Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|----------------|--------|---------------|---------------|------------------------------|---|
| 7 | 0x07 | Slave ID[0] | 7:1 | RW | 0x00 | Slave ID 0 Port0/Port1 | 7-bit I2C address of the remote Slave 0 attached to the remote Deserializer. If an I2C transaction is addressed to Slave Alias ID 0, the transaction will be remapped to this address before passing the transaction across the Bidirectional Control Channel to the Deserializer. A value of 0 in this field disables access to the remote Slave 0. If PORT1_SEL is set, this register is with reference to Port1. |
| | | | 0 | | | | Reserved. |
| 8 | 0x08 | Slave Alias[0] | 7:1 | RW | 0x00 | Slave Alias ID 0 Port0/Port1 | 7-bit Slave Alias ID of the remote Slave 0 attached to the remote Deserializer. The transaction will be remapped to the address specified in the Slave ID 0 register. A value of 0 in this field disables access to the remote Slave 0. If PORT1_SEL is set, this register is with reference to Port1. |
| | | | 0 | | | | Reserved. |
| 10 | 0x0A | CRC Errors | 7:0 | R | 0x00 | CRC Error LSB Port0/Port1 | Number of back channel CRC errors – 8 least significant bits. Cleared by 0x04[5]. If PORT1_SEL is set, this register is with reference to Port1. |
| 11 | 0x0B | | 7:0 | R | | CRC Error MSB Port0/Port1 | Number of back channel CRC errors – 8 most significant bits. Cleared by 0x04[5]. If PORT1_SEL is set, this register is with reference to Port1. |
| 12 | 0x0C | General Status | 7:5 | | 0x00 | | Reserved. |
| | | | 4 | | | Link Lost Port0/Port1 | Link lost flag for selected port: This bit indicates that loss of link has been detected. This register bit will stay high until cleared using the CRC Error Reset in register 0x04. If PORT1_SEL is set, this register is with reference to Port1. |
| | | | 3 | R | | BIST CRC Error Port0/Port1 | Back channel CRC error(s) during BIST communication with Deserializer. This bit is cleared upon loss of link, restart of BIST, or assertion of CRC Error Reset bit in 0x04[5]. 0: No CRC errors detected during BIST. 1: CRC error(s) detected during BIST. If PORT1_SEL is set, this register is with reference to Port1. |
| | | | 2 | R | | TMDS Clock Detect | Pixel clock status: 0: Valid clock not detected at HDMI input. 1: Valid clock detected at HDMI input. |
| | | | 1 | R | | DES Error Port0/Port1 | CRC error(s) during normal communication with Deserializer. This bit is cleared upon loss of link or assertion of 0x04[5]. 0: No CRC errors detected. 1: CRC error(s) detected. If PORT1_SEL is set, this register is with reference to Port1. |
| | | | 0 | R | | Link Detect Port0/Port1 | Link detect status: 0: Cable link not detected. 1: Cable link detected. If PORT1_SEL is set, this register is with reference to Port1. |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---------------------|--------|---------------|---------------|--|---|
| 13 | 0x0D | GPIO0 Configuration | 7:4 | R | | Revision ID | Revision ID. |
| | | | 3 | RW | 0x00 | GPIO0 Output Value D_GPIO0 Output Value | Local GPIO Output Value. This value is output on the GPIO pin when the GPIO function is enabled, the local GPIO direction is set to output, and remote GPIO control is disabled. 0: Output LOW (default). 1: Output HIGH. If PORT1_SEL is set, this register controls the D_GPIO0 pin. |
| | | | 2:0 | RW | | GPIO0 ModeD_GPIO0 Mode | Determines operating mode for the GPIO pin: x00: Functional input mode. x10: TRI-STATE™ 001: GPIO mode, output. 011: GPIO mode, input. 101: Remote-hold mode. The GPIO pin will be an output, and the value is received from the remote Deserializer. In remote-hold mode, data is maintained on link loss. 111: Remote-default mode. The GPIO pin will be an output, and the value is received from the remote Deserializer. In remote-default mode, GPIO's Output Value bit is output on link loss. If PORT1_SEL is set, this register controls the D_GPIO0 pin. |

Register Maps (continued)

Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|--|--------|---------------|---------------|--|--|
| 14 | 0x0E | GPIO1 and GPIO2 ConfigurationD_GPIO1 and D_GPIO2 Configuration | 7 | RW | 0x00 | GPIO2 Output ValueD_GPIO2 Output Value | Local GPIO Output Value. This value is output on the GPIO pin when the GPIO function is enabled, the local GPIO direction is set to output, and remote GPIO control is disabled. 0: Output LOW (default). 1: Output HIGH. If PORT1_SEL is set, this register controls the D_GPIO2 pin. |
| | | | 6:4 | RW | | GPIO2 ModeD_GPIO2 Mode | Determines operating mode for the GPIO pin: x00: Functional input mode. x10: TRI-STATE™. 001: GPIO mode, output. 011: GPIO mode, input. 101: Remote-hold mode. The GPIO pin will be an output, and the value is received from the remote Deserializer. In remote-hold mode, data is maintained on link loss. 111: Remote-default mode. The GPIO pin will be an output, and the value is received from the remote Deserializer. In remote-default mode, GPIO's Output Value bit is output on link loss. If PORT1_SEL is set, this register controls the D_GPIO2 pin. |
| | | | 3 | RW | | GPIO1 Output ValueD_GPIO1 Output Value | Local GPIO Output Value. This value is output on the GPIO pin when the GPIO function is enabled, the local GPIO direction is set to output, and remote GPIO control is disabled. 0: Output LOW (default). 1: Output HIGH. If PORT1_SEL is set, this register controls the D_GPIO1 pin. |
| | | | 2:0 | RW | | GPIO1 ModeD_GPIO1 Mode | Determines operating mode for the GPIO pin: x00: Functional input mode. x10: TRI-STATE™. 001: GPIO mode, output. 011: GPIO mode, input. 101: Remote-hold mode. The GPIO pin will be an output, and the value is received from the remote Deserializer. In remote-hold mode, data is maintained on link loss. 111: Remote-default mode. The GPIO pin will be an output, and the value is received from the remote Deserializer. In remote-default mode, GPIO's Output Value bit is output on link loss. If PORT1_SEL is set, this register controls the D_GPIO1 pin. |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---|--------|---------------|---------------|--|--|
| 15 | 0x0F | GPIO3 ConfigurationD_ GPIO3 Configuration | 7:4 | | 0x00 | | Reserved. |
| | | | 3 | RW | | GPIO3 Output ValueD_ GPIO 3 Output Value | Local GPIO Output Value. This value is output on the GPIO pin when the GPIO function is enabled, the local GPIO direction is set to output, and remote GPIO control is disabled. 0: Output LOW (default). 1: Output HIGH. If PORT1_SEL is set, this register controls the D_ GPIO3 pin. |
| | | | 2:0 | RW | | GPIO3 ModeD_ GPIO3 Mode | Determines operating mode for the GPIO pin: x00: Functional input mode. x10: TRI-STATE. 001: GPIO mode, output. 011: GPIO mode, input. 101: Remote-hold mode. The GPIO pin will be an output, and the value is received from the remote Deserializer. In remote-hold mode, data is maintained on link loss. 111: Remote-default mode. The GPIO pin will be an output, and the value is received from the remote Deserializer. In remote-default mode, GPIO's Output Value bit is output on link loss. If PORT1_SEL is set, this register controls the D_ GPIO3 pin. |
| 16 | 0x10 | GPIO5_REG and GPIO6_REG Configuration | 7 | RW | 0x00 | GPIO6_REG Output Value | Local GPIO Output Value. This value is output on the GPIO pin when the GPIO function is enabled and the local GPIO direction is set to output. 0: Output LOW (default). 1: Output HIGH. |
| | | | 6 | | | | Reserved. |
| | | | 5:4 | RW | | GPIO6_REG Mode | Determines operating mode for the GPIO pin: 00: Functional input mode. 10: TRI-STATE™. 01: GPIO mode, output. 11: GPIO mode; input. |
| | | | 3 | RW | | GPIO5_REG Output Value | Local GPIO Output Value. This value is output on the GPIO pin when the GPIO function is enabled and the local GPIO direction is set to output. 0: Output LOW (default). 1: Output HIGH. |
| | | | 2 | | | | Reserved. |
| | | | 1:0 | RW | | GPIO5_REG Mode | Determines operating mode for the GPIO pin: 00: Functional input mode. 10: TRI-STATE™. 01: GPIO mode, output. 11: GPIO mode; input. |

Register Maps (continued)

Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---------------------------------------|--------|---------------|---------------|------------------------|---|
| 17 | 0x11 | GPIO7_REG and GPIO8_REG Configuration | 7 | RW | 0x00 | GPIO8_REG Output Value | Local GPIO Output Value. This value is output on the GPIO pin when the GPIO function is enabled and the local GPIO direction is set to output. 0: Output LOW (default). 1: Output HIGH. |
| | | | 6 | | | | Reserved. |
| | | | 5:4 | RW | | GPIO8_REG Mode | Determines operating mode for the GPIO pin: 00: Functional input mode. 10: TRI-STATE. 01: GPIO mode, output. 11: GPIO mode; input. |
| | | | 3 | RW | | GPIO7_REG Output Value | Local GPIO Output Value. This value is output on the GPIO pin when the GPIO function is enabled and the local GPIO direction is set to output. 0: Output LOW (default). 1: Output HIGH. |
| | | | 2 | | | | Reserved. |
| | | | 1:0 | RW | | GPIO7_REG Mode | Determines operating mode for the GPIO pin: 00: Functional input mode. 10: TRI-STATE. 01: GPIO mode, output. 11: GPIO mode; input. |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|-------------------------|--------|---------------|---------------|-------------------------------|---|
| 18 | 0x12 | Data Path Control | 7 | | 0x00 | | <i>Reserved.</i> |
| | | | 6 | RW | | Pass RGB | Setting this bit causes RGB data to be sent independent of DE. However, setting this bit blocks packetized audio. This bit does not need to be set in UB serializers. 0: Normal operation. 1: Pass RGB independent of DE. |
| | | | 5 | RW | | DE Polarity | This bit indicates the polarity of the DE (Data Enable) signal. 0: DE is positive (active high, idle low). 1: DE is inverted (active low, idle high). |
| | | | 4 | RW | | I2S Repeater Regen | Regenerate I2S data from Repeater I2S pins. 0: Repeater pass through I2S from video pins (default). 1: Repeater regenerate I2S from I2S pins. |
| | | | 3 | RW | | I2S Channel B Enable Override | I2S Channel B Enable Override. 0: Disable I2S Channel B override. 1: Set I2S Channel B Enable from 0x12[0]. |
| | | | 2 | RW | | 18-Bit Video Select | 0: Select 24-bit video mode. 1: Select 18-bit video mode. |
| | | | 1 | RW | | I2S Transport Select | Select I2S transport mode: 0: Enable I2S Data Island transport (default). 1: Enable I2S Data Forward Channel Frame transport. |
| | | | 0 | RW | | I2S Channel B Enable | I2S Channel B Enable. 0: I2S Channel B disabled. 1: Enable I2S Channel B on B1 input. Note that in a repeater, this bit may be overridden by the in-band I2S mode detection. |
| 19 | 0x13 | General Purpose Control | 7 | R | 0x88 | MODE_SEL1 Done | Indicates MODE_SEL1 value has stabilized and has been latched. |
| | | | 6:4 | R | | MODE_SEL1 Decode | Returns the 3-bit decode of the MODE_SEL1 pin. |
| | | | 3 | R | | MODE_SEL0 Done | Indicates MODE_SEL0 value has stabilized and has been latched. |
| | | | 2:0 | R | | MODE_SEL0 Decode | Returns the 3-bit decode of the MODE_SEL0 pin. |

Register Maps (continued)

Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|----------------------|--------|---------------|---------------|--------------------|--|
| 20 | 0x14 | BIST Control | 7:3 | | 0x00 | | Reserved. |
| | | | 2:1 | RW | | OSC Clock Source | Allows choosing different OSC clock frequencies for forward channel frame. OSC clock frequency in functional mode when TMDS clock is not present and 0x03[2]=1: 00: 50 MHz oscillator. 01: 50 MHz oscillator. 10: 100 MHz oscillator. 11: 25 MHz oscillator. Clock source in BIST mode i.e. when 0x14[0]=1: 00: External pixel clock. 01: 33 MHz oscillator. 1x: 100 MHz oscillator. |
| | | | 0 | RW | | BIST Enable | BIST control: 0: Disabled (default). 1: Enabled. |
| 21 | 0x15 | I2C Voltage Select | 7:0 | RW | 0x01 | I2C Voltage Select | Selects 1.8 or 3.3V for the I2C_SDA and I2C_SCL pins. This register is loaded from the I2C_VSEL strap option from the SCLK pin at power-up. At power-up, a logic LOW will select 3.3V operation, while a logic HIGH (pull-up resistor attached) will select 1.8V signaling. Issuing either of the digital resets via register 0x01 will cause the I2C_VSEL value to be reset to 3.3V operation. Reads of this register return the status of the I2C_VSEL control: 0: Select 1.8V signaling. 1: Select 3.3V signaling. This bit may be overwritten via register access or via eFuse program by writing an 8-bit value to this register: Write 0xb5 to set I2C_VSEL. Write 0xb6 to clear I2C_VSEL. |
| 22 | 0x16 | BCC Watchdog Control | 7:1 | RW | 0xFE | Timer Value | The watchdog timer allows termination of a control channel transaction if it fails to complete within a programmed amount of time. This field sets the Bidirectional Control Channel Watchdog Timeout value in units of 2 milliseconds. This field should not be set to 0. Set to 0x01. |
| | | | 0 | RW | | Timer Control | Disable Bidirectional Control Channel (BCC) Watchdog Timer: 0: Enable BCC Watchdog Timer operation (default). 1: Disable BCC Watchdog Timer operation. |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---------------------|--------|---------------|---------------|--------------------------|---|
| 23 | 0x17 | I2C Control | 7 | RW | 0x1E | I2C Pass All Port0/Port1 | 0: Enable Forward Control Channel pass-through only of I2C accesses to I2C Slave IDs matching either the remote Deserializer Slave ID or the remote Slave ID (default). 1: Enable Forward Control Channel pass-through of all I2C accesses to I2C Slave IDs that do not match the Serializer I2C Slave ID. If PORT1_SEL is set, this bit controls Port1 operation. |
| | | | 6:4 | RW | | SDA Hold Time | Internal SDA hold time: Configures the amount of internal hold time provided for the SDA input relative to the SCL input. Units are 40 nanoseconds. |
| | | | 3:0 | RW | | I2C Filter Depth | Configures the maximum width of glitch pulses on the SCL and SDA inputs that will be rejected. Units are 5 nanoseconds. |
| 24 | 0x18 | SCL High Time | 7:0 | RW | 0x7F | TX_SCL_HIGH | I2C Master SCL high time: This field configures the high pulse width of the SCL output when the Serializer is the Master on the local I2C bus. Units are 40 ns for the nominal oscillator clock frequency. The default value is set to provide a minimum 5us SCL high time with the internal oscillator clock running at 26.25MHz rather than the nominal 25MHz. Delay includes 5 additional oscillator clock periods. $Min_delay = 38.0952ns * (TX_SCL_HIGH + 5)$. |
| 25 | 0x19 | SCL Low Time | 7:0 | RW | 0x7F | TX_SCL_LOW | I2C Master SCL low time: This field configures the low pulse width of the SCL output when the Serializer is the Master on the local I2C bus. This value is also used as the SDA setup time by the I2C Slave for providing data prior to releasing SCL during accesses over the Bidirectional Control Channel. Units are 40 ns for the nominal oscillator clock frequency. The default value is set to provide a minimum 5us SCL low time with the internal oscillator clock running at 26.25MHz rather than the nominal 25MHz. Delay includes 5 additional clock periods. $Min_delay = 38.0952ns * (TX_SCL_LOW + 5)$. |
| 26 | 0x1A | Data Path Control 2 | 7:4 | | | | Reserved. |
| | | | 3 | R | Strap | SECONDARY_AUDIO | Enable Secondary Audio. This register indicates that the AUX audio channel is enabled. The control for this function is via the AUX_AUDIO bit in the BRIDGE_CFG register register offset 0x54). The AUX_AUDIO control is strapped from the MODE_SEL0 pin at power-up. |
| | | | 2 | | 0x01 | | Reserved. |
| | | | 1 | RW | | MODE_28B | Enable 28-bit Serializer Mode. 0: 24-bit high-speed data + 3 low-speed control (DE, HS, VS). 1: 28-bit high-speed data mode. |
| | | | 0 | RW | | I2S Surround | Enable 5.1- or 7.1-channel I2S audio transport: 0: 2-channel or 4-channel I2S audio is enabled as configured in register 0x12 bits 3 and 0. 1: 5.1- or 7.1-channel audio is enabled. Note that I2S Data Island Transport is the only option for surround audio. Also note that in a repeater, this bit may be overridden by the in-band I2S mode detection (default). |

Register Maps (continued)

Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---------------------|--------|---------------|---------------|--|--|
| 27 | 0x1B | BIST BC Error Count | 7:0 | R | 0x00 | BIST BC Error Port0/Port1 | BIST back channel CRC error counter. This register stores the back channel CRC error count during BIST Mode (saturates at 255 errors). Clears when a new BIST is initiated or by 0x04[5]. If PORT1_SEL is set, this register indicates Port1 status. |
| 28 | 0x1C | GPIO Pin Status 1 | 7 | R | 0x00 | GPIO7_REG Pin Status | GPIO7_REG input pin status. Note: status valid only if pin is set to GPI (input) mode. |
| | | | 6 | R | | GPIO6_REG Pin Status | GPIO6_REG input pin status. Note: status valid only if pin is set to GPI (input) mode. |
| | | | 5 | R | | GPIO5_REG Pin Status | GPIO5_REG input pin status. Note: status valid only if pin is set to GPI (input) mode. |
| | | | 4 | | | | Reserved. |
| | | | 3 | R | | GPIO3 Pin Status D_GPIO3 Pin Status | GPIO3 input pin status. Note: status valid only if pin is set to GPI (input) mode. If PORT1_SEL is set, this register indicates D_GPIO3 input pin status. |
| | | | 2 | R | | GPIO2 Pin Status D_GPIO2 Pin Status | GPIO2 input pin status. Note: status valid only if pin is set to GPI (input) mode. If PORT1_SEL is set, this register indicates D_GPIO2 input pin status. |
| | | | 1 | R | | GPIO1 Pin Status D_GPIO1 Pin Status | GPIO1 input pin status. Note: status valid only if pin is set to GPI (input) mode. If PORT1_SEL is set, this register indicates D_GPIO1 input pin status. |
| | | | 0 | R | | GPIO0 Pin Status D_GPIO0 Pin Status | GPIO0 input pin status. Note: status valid only if pin is set to GPI (input) mode. If PORT1_SEL is set, this register indicates D_GPIO0 input pin status. |
| 29 | 0x1D | GPIO Pin Status 2 | 7:1 | | 0x00 | | Reserved |
| | | | 0 | R | | GPIO8_REG Pin Status | GPIO8_REG input pin status. Note: status valid only if pin is set to GPI (input) mode. |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|-------------------------|--------|---------------|---------------|-----------------|---|
| 30 | 0x1E | Transmitter Port Select | 7:3 | | | | Reserved. |
| | | | 2 | RW | 0x01 | PORT1_I2C_EN | Port1 I2C Enable. Enables secondary I2C address. The second I2C address provides access to Port1 registers as well as registers that are shared between Port0 and Port1. The second I2C address value will be set to DeviceID + 1 (7-bit format). The PORT1_I2C_EN bit must also be set to allow accessing remote devices over the second link when the device is in Replicate mode. |
| | | | 1 | RW | | PORT1_SEL | Selects Port1 for register access from primary I2C address. For writes, Port1 registers and shared registers will both be written. For reads, Port1 registers and shared registers will be read. This bit must be cleared to read Port0 registers. This bit is ignored if PORT1_I2C_EN is set. |
| | | | 0 | RW | | PORT0_SEL | Selects Port0 for register access from primary I2C address. For writes, Port0 registers and shared registers will both be written. For reads, Port0 registers and shared registers will be read. Note that if PORT1_SEL is also set, then Port1 registers will be read. This bit is ignored if PORT1_I2C_EN is set. |
| 31 | 0x1F | Frequency Counter | 7:0 | RW | 0x00 | Frequency Count | Frequency counter control. A write to this register will enable a frequency counter to count the number of pixel clock during a specified time interval. The time interval is equal to the value written multiplied by the oscillator clock period (nominally 40ns). A read of the register returns the number of pixel clock edges seen during the enabled interval. The frequency counter will freeze at 0xff if it reaches the maximum value. The frequency counter will provide a rough estimate of the pixel clock period. If the pixel clock frequency is known, the frequency counter may be used to determine the actual oscillator clock frequency. |

Register Maps (continued)

Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|-----------------------------|--------|---------------|---------------|-------------------------------|--|
| 32 | 0x20 | Deserializer Capabilities 1 | 7 | RW | 0x00 | FREEZE_DES_CAP Port0/Port1 | Freeze Deserializer Capabilities. Prevent auto-loading of the Deserializer Capabilities by the Bidirectional Control Channel. The Capabilities will be frozen at the values written in registers 0x20 and 0x21. If PORT1_SEL is set, this register indicates Port1 capabilities. |
| | | | 6 | RW | 0x00 | HSCC_MODE[0] Port0/Port1 | High-Speed Control Channel bit 0. Lowest bit of the 3-bit HSCC indication. The other 2 bits are contained in Deserializer Capabilities 2. This field is automatically configured by the Bidirectional Control Channel once RX Lock has been detected. Software may overwrite this value, but must also set the FREEZE DES CAP bit to prevent overwriting by the Bidirectional Control Channel. If PORT1_SEL is set, this register indicates Port1 capabilities. |
| | | | 5 | | | SEND_FREQ Port0/Port1 | Send Frequency Training Pattern. Indicates the DS90UB949-Q1 should send the Frequency Training Pattern. This field is automatically configured by the Bidirectional Control Channel once RX Lock has been detected. Software may overwrite this value, but must also set the FREEZE DES CAP bit to prevent overwriting by the Bidirectional Control Channel. If PORT1_SEL is set, this register indicates Port1 capabilities. |
| | | | 4 | RW | 0x00 | SEND_EQ Port0/Port1 | Send Equalization Training Pattern. Indicates the DS90UB949-Q1 should send the Equalization Training Pattern. This field is automatically configured by the Bidirectional Control Channel once RX Lock has been detected. Software may overwrite this value, but must also set the FREEZE DES CAP bit to prevent overwriting by the Bidirectional Control Channel. If PORT1_SEL is set, this register indicates Port1 capabilities. |
| | | | 3 | RW | | DUAL_LINK_CAP Port0/Port1 | Dual link Capabilities. Indicates if the Deserializer is capable of dual link operation. This field is automatically configured by the Bidirectional Control Channel once RX Lock has been detected. Software may overwrite this value, but must also set the FREEZE DES CAP bit to prevent overwriting by the Bidirectional Control Channel. If PORT1_SEL is set, this register indicates Port1 capabilities. |
| | | | 2 | RW | | DUAL_CHANNEL Port0/Port1 | Dual Channel 0/1 Indication. In a dual-link capable device, indicates if this is the primary or secondary channel. 0: Primary channel (channel 0). 1: Secondary channel (channel 1). This field is automatically configured by the Bidirectional Control Channel once RX Lock has been detected. Software may overwrite this value, but must also set the FREEZE DES CAP bit to prevent overwriting by the Bidirectional Control Channel. If PORT1_SEL is set, this register indicates Port1 capabilities. |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|-----------------------------|--------|---------------|---------------|-----------------------------|---|
| 32 | 0x20 | Deserializer Capabilities 1 | 1 | RW | 0x00 | VID_24B_HD_AUD Port0/Port1 | Deserializer supports 24-bit video concurrently with HD audio. This field is automatically configured by the Bidirectional Control Channel once RX Lock has been detected. Software may overwrite this value, but must also set the FREEZE DES CAP bit to prevent overwriting by the Bidirectional Control Channel. If PORT1_SEL is set, this register indicates Port1 capabilities. |
| | | | 0 | RW | | DES_CAP_FC_GPIO Port0/Port1 | Deserializer supports GPIO in the Forward Channel Frame. This field is automatically configured by the Bidirectional Control Channel once RX Lock has been detected. Software may overwrite this value, but must also set the FREEZE DES CAP bit to prevent overwriting by the Bidirectional Control Channel. If PORT1_SEL is set, this register indicates Port1 capabilities. |
| 33 | 0x21 | Deserializer Capabilities 2 | 7:2 | | | | Reserved. |
| | | | 1:0 | RW | 0x00 | HSCC_MODE[2:1] Port0/Port1 | High-Speed Control Channel bits [2:1]. Upper bits of the 3-bit HSCC indication. The lowest bit is contained in Deserializer Capabilities 1. 000: Normal back channel frame, GPIO mode. 001: High Speed GPIO mode, 1 GPIO. 010: High Speed GPIO mode, 2 GPIOs. 011: High Speed GPIO mode: 4 GPIOs. 100: Reserved. 101: Reserved. 110: High Speed, Forward Channel SPI mode. 111: High Speed, Reverse Channel SPI mode. In Single Link devices, only Normal back channel frame modes are supported. If PORT1_SEL is set, this register indicates Port1 capabilities. |
| 38 | 0x26 | Link Detect Control | 7:3 | | | | Reserved. |
| | | | 2:0 | RW | 0x00 | LINK DETECT TIMER | Bidirectional Control Channel Link Detect Timer. This field configures the link detection timeout period. If the timer expires without valid communication over the reverse channel, link detect will be deasserted. 000: 162 microseconds. 001: 325 microseconds. 010: 650 microseconds. 011: 1.3 milliseconds. 100: 10.25 microseconds. 101: 20.5 microseconds. 110: 41 microseconds. 111: 82 microseconds. |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|----------------|--------|---------------|---------------|-----------------|--|
| 48 | 0x30 | SCLK_CTRL | 7 | RW | 0x00 | SCLK/WS | SCLK to Word Select Ratio. 0 : 64. 1 : 32. |
| | | | 6:5 | RW | | MCLK/SCLK | MCLK to SCLK Select Ratio. 00 : 4. 01 : 2. 10 : 1. 11 : 8. |
| | | | 4:3 | RW | | CLEAN CLOCK_DIV | Clock Cleaner divider. 00 : FPD_VCO_CLOCK/8. 01 : FPD_VCO_CLOCK/4. 10 : FPD_VCO_CLOCK/2. 11 : AON_OSC. |
| | | | 2:1 | RW | | CLEAN Mode | If non-zero, the SCLK Input or HDMI N/CTS generated Audio Clock is cleaned digitally before being used. 00 : Off. 01 : ratio of 1. 10 : ratio of 2. 11 : ratio of 4. |
| | | | 0 | RW | | MASTER | If set, the SCLK I/O and the WS_IO are used as an output and the Clock Generation Circuits are enabled, otherwise they are inputs. |
| 49 | 0x31 | AUDIO_CTS0 | 7:0 | RW | 0x00 | CTS[7:0] | If non-zero, the CTS value is used to generate a new clock from the PFD PLLs VCO. |
| 50 | 0x32 | AUDIO_CTS1 | 7:0 | RW | 0x00 | CTS[15:8] | If non-zero, the CTS value is used to generate a new clock from the PFD PLLs VCO. |
| 51 | 0x33 | AUDIO_CTS2 | 7:0 | RW | 0x00 | CTS[23:16] | If non-zero, the CTS value is used to generate a new clock from the PFD PLLs VCO. |
| 52 | 0x34 | AUDIO_N0 | 7:0 | RW | 0x00 | N[7:0] | If non-zero, the CTS value is used to generate a new clock from the PFD PLLs VCO. |
| 53 | 0x35 | AUDIO_N1 | 7:0 | RW | 0x00 | N[15:8] | If non-zero, the CTS value is used to generate a new clock from the PFD PLLs VCO. |
| 54 | 0x36 | AUDIO_N2_COEFF | 7:4 | RW | 0x00 | COEFF[3:0] | Selects the LPF_COEFF in the Clock Cleaner (Feedback is divided by 2^COEFF). |
| | | | 3:0 | RW | 0x00 | N[19:16] | If non-zero, the CTS value is used to generate a new clock from the PFD PLLs VCO. |
| 55 | 0x37 | CLK_CLEAN_ST S | 7:6 | | | | Reserved. |
| | | | 5:3 | R | 0x00 | IN_FIFO_LVL | Clock Cleaner Input FIFO Level. |
| | | | 2:0 | R | 0x00 | OUT_FIFO_LVL | Clock Cleaner Output FIFO Level. |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---------------|--------|---------------|---------------|--------------|--|
| 64 | 0x40 | ANA_IA_CNTL | 7:5 | | 0x00 | | Reserved. |
| | | | 4:2 | RW | | ANA_IA_SEL | Analog register select Selects target for register access 000b: Disabled 001b - 011b: Reserved 100b: HDMI Registers 101b: FPD3 TX Registers 11xb: Reserved |
| | | | 1 | RW | | ANA_AUTO_INC | Analog Register Auto Increment 0: Disable auto-increment mode 1: Enable auto-increment mode. Upon completion of a read or write, the register address will automatically be incremented by 1. |
| | | | 0 | RW | | ANA_IA_READ | Start Analog Register Read 0: Write analog register 1: Read analog register |
| 65 | 0x41 | ANA_IA_ADDR | 7:0 | RW | 0x00 | ANA_IA_ADDR | Analog register offset This register contains the 8-bit register offset for the indirect access. |
| 66 | 0x42 | ANA_IA_DATA | 7:0 | RW | 0x00 | ANA_IA_DATA | Analog register data Writing this register will cause an indirect write of the ANA_IA_DATA value to the selected analog block register. Reading this register will return the value of the selected analog block register. |
| 72 | 0x48 | APB_CTL | 7:5 | | 0x00 | | Reserved. |
| | | | 4:3 | RW | | APB_SELECT | APB Select: Selects target for register access. 00 : HDMI APB interface. 01 : EDID SRAM. 10 : Configuration Data (read only). 11 : Die ID (read only). |
| | | | 2 | RW | | APB_AUTO_INC | APB Auto Increment: Enables auto-increment mode. Upon completion of an APB read or write, the APB address will automatically be incremented by 0x4 for HDMI registers or by 0x1 for others. |
| | | | 1 | RW | | APB_READ | Start APB Read: Setting this bit to a 1 will begin an APB read. Read data will be available in the APB_DATAx registers. The APB_ADRx registers should be programmed prior to setting this bit. This bit will be cleared when the read is complete. |
| | | | 0 | RW | | APB_ENABLE | APB Interface Enable: Set to a 1 to enable the APB interface. The APB_SELECT bits indicate what device is selected. |
| 73 | 0x49 | APB_ADR0 | 7:0 | RW | 0x00 | APB_ADR0 | APB Address byte 0 (LSB). |
| 74 | 0x4A | APB_ADR1 | 7:0 | RW | 0x00 | APB_ADR1 | APB Address byte 1 (MSB). |
| 75 | 0x4B | APB_DATA0 | 7:0 | RW | 0x00 | APB_DATA0 | Byte 0 (LSB) of the APB Interface Data. |
| 76 | 0x4C | APB_DATA1 | 7:0 | RW | 0x00 | APB_DATA1 | Byte 1 of the APB Interface Data. |

Register Maps (continued)

Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---------------|--------|---------------|---------------|---------------|---|
| 77 | 0x4D | APB_DATA2 | 7:0 | RW | 0x00 | APB_DATA2 | Byte 2 of the APB Interface Data. |
| 78 | 0x4E | APB_DATA3 | 7:0 | RW | 0x00 | APB_DATA3 | Byte 3 (MSB) of the APB Interface Data. |
| 79 | 0x4F | BRIDGE_CTL | 7:5 | | | | Reserved. |
| | | | 4 | RW | 0x00 | CEC_CLK_SRC | CEC Clock Source Select: Selects clock source for generating the 32.768kHz clock for CEC operations in the HDMI Receive Controller. 0 : Selects internal generated clock. 1 : Selects external 25MHz oscillator clock. |
| | | | 3 | RW | | CEC_CLK_EN | CEC Clock Enable: Enable CEC clock generation. Enables generation of the 32.768kHz clock for the HDMI Receive controller. This bit should be set prior to enabling CEC operation via the HDMI controller registers. |
| | | | 2 | RW | | EDID_CLEAR | Clear EDID SRAM: Set to 1 to enable clearing the EDID SRAM. The EDID_INIT bit must be set at the same time for the clear to occur. This bit will be cleared when the initialization is complete. |
| | | | 1 | RW | | EDID_INIT | Initialize EDID SRAM from EEPROM: Causes a reload of the EDID SRAM from the non-volatile EDID EEPROM. This bit will be cleared when the initialization is complete. |
| | | | 0 | R | Strap | EDID_DISABLE | Disable EDID access via DDC/I2C: Disables access to the EDID SRAM via the HDMI DDC interface. This value is loaded from the MODE_SEL0 pin at power-up. |
| 80 | 0x50 | BRIDGE_STS | 7 | R | 0x03 | RX5V_DETECT | RX +5V detect: Indicates status of the RX_5V pin. When asserted, indicates the HDMI interface has detected valid voltage on the RX_5V input. |
| | | | 6 | R | | HDMI_INT | HDMI Interrupt Status: Indicates an HDMI Interrupt is pending. HDMI interrupts are serviced through the HDMI Registers via the APB Interface. |
| | | | 5 | | | | Reserved. |
| | | | 4 | R | | INIT_DONE | Initialization Done: Initialization sequence has completed. This step will complete after configuration complete (CFG_DONE). |
| | | | 3 | R | | REM_EDID_LOAD | Remote EDID Loaded: Indicates EDID SRAM has been loaded from a remote EDID EEPROM device over the Bidirectional Control Channel. The EDID_CKSUM value indicates if the EDID load was successful. |
| | | | 2 | R | | CFG_DONE | Configuration Complete: Indicates automatic configuration has completed. This step will complete prior to initialization complete (INIT_DONE). |
| | | | 1 | R | | CFG_CKSUM | Configuration checksum status: Indicates result of Configuration checksum during initialization. The device verifies the 2's complement checksum in the last 128 bytes of the EEPROM. A value of 1 indicates the checksum passed. |
| | | | 0 | R | | EDID_CKSUM | EDID checksum Status: Indicates result of EDID checksum during EDID initialization. The device verifies the 2's complement checksum in the first 256 bytes of the EEPROM. A value of 1 indicates the checksum passed. |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---------------|--------|---------------|---------------|-----------------|--|
| 81 | 0x51 | EDID_ID | 7:1 | RW | 0x50 | EDID_ID | EDID I2C Slave Address: I2C address used for accessing the EDID information. These are the upper 7 bits in 8-bit format addressing, where the lowest bit is the Read/Write control. |
| | | | 0 | RW | 0 | EDID_RDONLY | EDID Read Only: Set to a 1 puts the EDID SRAM memory in read-only mode for access via the HDMI DDC interface. Setting to a 0 allows writes to the EDID SRAM memory. |
| 82 | 0x52 | EDID_CFG0 | 7 | | | | Reserved. |
| | | | 6:4 | RW | 0x01 | EDID_SDA_HOLD | Internal SDA Hold Time: This field configures the amount of internal hold time provided for the DDC_SDA input relative to the DDC_SCL input. Units are 40 nanoseconds. The hold time is used to qualify the start detection to avoid false detection of Start or Stop conditions. |
| | | | 3:0 | RW | 0x0E | EDID_FLTR_DEPTH | I2C Glitch Filter Depth: This field configures the maximum width of glitch pulses on the DDC_SCL and DDC_SDA inputs that will be rejected. Units are 5 nanoseconds. |
| 83 | 0x53 | EDID_CFG1 | 7:2 | | | | Reserved. |
| | | | 1:0 | RW | 0x00 | EDID_SDA_DELAY | SDA Output Delay: This field configures output delay on the DDC_SDA output when the EDID memory is accessed. Setting this value will increase output delay in units of 40ns. Nominal output delay values for DDC_SCL to DDC_SDA are: 00 : 240ns. 01 : 280ns. 10 : 320ns. 11 : 360ns. |

Register Maps (continued)

Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---------------|--------|---------------|---------------|---------------|---|
| 84 | 0x54 | BRIDGE_CFG | 7 | RW | Strap | EXT_CTL | External Control: When this bit is set, the internal bridge control function is disabled. This disables initialization of the HDMI Receiver. These operations must be controlled by an external controller attached to the I2C interface. This value is loaded from the MODE_SEL1 pin at power-up. |
| | | | 6 | RW | 0x00 | HDMI_INT_EN | HDMI Interrupt Enable: When this bit is set, Interrupts from the HDMI Receive controller will be reported on the INTB pin. Software may check the BRIDGE_STS register to determine if the interrupt is from the HDMI Receiver. |
| | | | 5 | RW | Strap | DIS_REM_EDID | Disable Remote EDID load: Disables automatic load of EDID SRAM from a remote EDID EEPROM. By default, the device will check the remote I2C bus for an EEPROM with a valid EDID, and load the EDID data to local EDID SRAM. If this bit is set to a 1, the remote EDID load will be bypassed. This value is loaded from the MODE_SEL1 pin at power-up. |
| | | | 4 | RW | 0x00 | AUTO_INIT_DIS | Disable Automatic initialization: The Bridge control will automatically initialize the HDMI Receiver for operation. Setting this bit to a 1 will disable automatic initialization of the HDMI Receiver. In this mode, initialization of the HDMI Receiver must be done through EEPROM configuration or via external control. |
| | | | 3 | | | | Reserved. |
| | | | 2 | RW | 0x00 | AUDIO_TDM | Enable TDM Audio: Setting this bit to a 1 will enable TDM audio for the HDMI audio. |
| | | | 1 | RW | | AUDIO_MODE | Audio Mode: Selects source for audio to be sent over the FPD-Link III downstream link. 0 : HDMI audio. 1 : Local/DVI audio. Local audio is sourced from the device I2S pins rather than from HDMI, and is useful in modes such as DVI that do not include audio. |
| | | | 0 | RW | Strap | AUX_AUDIO_EN | AUX Audio Channel Enable: Setting this bit to a 1 will enable the AUX audio channel. This allows sending additional 2-channel audio in addition to the HDMI or DVI audio. This bit is loaded from the MODE_SEL0 pin at power-up. |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---------------|--------|---------------|---------------|-----------------|--|
| 85 | 0x55 | AUDIO_CFG | 7 | RW | 0x00 | TDM_2_PARALLEL | Enable I2S TDM to parallel audio conversion: When this bit is set, the i2s tdm to parallel conversion module is enabled. The clock output from the i2s tdm to parallel conversion module is then used to send data to the deserializer. |
| | | | 6 | RW | | HDMI_I2S_OUT | HDMI Audio Output Enable: When this bit is set, the HDMI I2S audio data will be output on the I2S audio interface pins. This control is ignored if the BRIDGE_CFG:AUDIO_MODE is not set to 00 (HDMI audio only). |
| | | | 5:4 | | | | Reserved. |
| | | | 3 | RW | 0x0C | RST_ON_TYPE | Reset Audio FIFO on Type Change: When this bit is set, the internal bridge control function will reset the HDMI Audio FIFO on a change in the Audio type. |
| | | | 2 | RW | | RST_ON_AIF | Reset Audio FIFO on Audio Infoframe: When this bit is set, the internal bridge control function will reset the HDMI Audio FIFO on a change in the Audio Infoframe checksum. |
| | | | 1 | RW | | RST_ON_AVI | Reset Audio FIFO on Audio Video Information Infoframe: When this bit is set, the internal bridge control function will reset the HDMI Audio FIFO on a change in the Audio Video Information Infoframe checksum. |
| | | | 0 | RW | | RST_ON_ACR | Reset Audio FIFO on Audio Control Frame: When this bit is set, the internal bridge control function will reset the HDMI Audio FIFO on a change in the Audio Control Frame N or CTS fields. |
| 90 | 0x5A | DUAL_STS | 7 | R | 0x00 | FPD3_LINK_READY | This bit indicates that the FPD-Link III has detected a valid downstream connection and determined capabilities for the downstream link. |
| | | | 6 | R | | FPD3_TX_STS | FPD-Link III transmit status: This bit indicates that the FPD-Link III transmitter is active and the receiver is LOCKED to the transmit clock. It is only asserted once a valid input has been detected, and the FPD-Link III transmit connection has entered the correct mode (Single vs. Dual mode). |
| | | | 5:4 | R | | FPD3_PORT_STS | FPD3 Port Status: If FPD3_TX_STS is set to a 1, this field indicates the port mode status as follows: 00: Dual FPD-Link III Transmitter mode. 01: Single FPD-Link III Transmit on port 0. 10: Single FPD-Link III Transmit on port 1. 11: Replicate FPD-Link III Transmit on both ports. |
| | | | 3 | R | | TMDS_VALID | HDMI TMDS Valid: This bit indicates the TMDS interface is recovering valid TMDS data from HDMI. |
| | | | 2 | R | | HDMI_PLL_LOCK | HDMI PLL lock status: Indicates the HDMI PLL has locked to the incoming TMDS clock. |
| | | | 1 | R | | NO_HDMI_CLOCK | No TMDS Clock Detected: This bit indicates the Frequency Detect circuit did not detect an TMDS clock greater than the value specified in the FREQ_LOW register. |
| | | | 0 | R | | FREQ_STABLE | HDMI Frequency is Stable: Indicates the Frequency Detection circuit has detected a stable TMDS clock frequency. |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---------------|--------|---------------|---------------|----------------|--|
| 91 | 0x5B | DUAL_CTL1 | 7 | RW | Strap | FPD3_COAX_MODE | FPD3 Coax Mode: Enables configuration for the FPD3 Interface cabling type. 0 : Twisted Pair. 1 : Coax This bit is loaded from the MODE_SEL1 pin at power-up. |
| | | | 6 | RW | 0 | DUAL_SWAP | Dual Swap Control: Indicates current status of the Dual Swap control. If automatic correction of Dual Swap is disabled via the DISABLE_DUAL_SWAP control, this bit may be modified by software. |
| | | | 5 | RW | 1 | RST_PLL_FREQ | Reset FPD3 PLL on Frequency Change: When set to a 1, frequency changes detected by the Frequency Detect circuit will result in a reset of the FPD3 PLL. Set to 0. |
| | | | 4 | RW | 0 | FREQ_DET_PLL | Frequency Detect Select PLL Clock: Determines the clock source for the Frequency detection circuit: 0 : TMDS clock (prior to PLL). 1: HDMI PLL clock. |
| | | | 3 | RW | 0 | DUAL_ALIGN_DE | Dual align on DE (valid in dual-link mode): 0: Data will be sent on alternating links without regard to odd/even pixel position. 1: Odd/Even data will be sent on the primary/secondary links, respectively, based on the assertion of DE. |
| | | | 2 | RW | 0 | DISABLE_DUAL | Disable Dual Mode: During Auto-detect operation, setting this bit to a 1 will disable Dual FPD-Link III operation. 0: Normal Auto-detect operation. 1: Only Single or Replicate operation supported. This bit will have no effect if FORCE_LINK is set. |
| | | | 1 | RW | 0 | FORCE_DUAL | Force dual mode: When FORCE_LINK bit is set, the value on this bit controls single versus dual operation: 0: Single FPD-Link III Transmitter mode. 1: Dual FPD-Link III Transmitter mode. |
| | | | 0 | RW | 0 | FORCE_LINK | Force Link Mode: Forces link to dual or single mode, based on the FORCE_DUAL control setting. If this bit is 0, mode setting will be automatically set based on downstream device capabilities as well as the incoming data frequency. 0 : Auto-Detect FPD-Link III mode. 1 : Forced Single or Dual FPD-Link III mode. |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|----------------|--------|---------------|---------------|-------------------|---|
| 92 | 0x5C | DUAL_CTL2 | 7 | RW | 0 | DISABLE_DUAL_SWAP | Disable Dual Swap: Prevents automatic correction of swapped Dual link connection. Setting this bit allows writes to the DUAL_SWAP control in the DUAL_CTL1 register. |
| | | | 6 | RW | 0x00 | FORCE_LINK_RDY | Force Link Ready: Forces link ready indication, bypassing back channel link detection. |
| | | | 5 | RW | | FORCE_CLK_DET | Force Clock Detect: Forces the HDMI/OpenLDI clock detect circuit to indicate presence of a valid input clock. This bypasses the clock detect circuit, allowing operation with an input clock that does not meet frequency or stability requirements. |
| | | | 4:3 | RW | | FREQ_STBL_THR | Frequency Stability Threshold: The Frequency detect circuit can be used to detect a stable clock frequency. The Stability Threshold determines the amount of time required for the clock frequency to stay within the FREQ_HYST range to be considered stable: 00 : 40us. 01 : 80us. 10 : 320us. 11 : 1.28ms. |
| | | | 2:0 | RW | 0x02 | FREQ_HYST | Frequency Detect Hysteresis: The Frequency detect hysteresis setting allows ignoring minor fluctuations in frequency. A new frequency measurement will be captured only if the measured frequency differs from the current measured frequency by more than the FREQ_HYST setting. The FREQ_HYST setting is in MHz. |
| 93 | 0x5D | FREQ_LOW | 7 | | | | Reserved. |
| | | | 6 | RW | 0 | HDMI_RST_MODE | HDMI Phy Reset Mode: 0 : Reset HDMI Phy on change in mode or frequency. 1 : Don't reset HDMI Phy on change in mode or frequency if +5 V is asserted. |
| | | | 5:0 | RW | 6 | FREQ_LO_THR | Frequency Low Threshold: Sets the low threshold for the TMDS Clock frequency detect circuit in MHz. This value is used to determine if the TMDS clock frequency is too low for proper operation. |
| 94 | 0x5E | FREQ_HIGH | 7 | | | | Reserved. |
| | | | 6:0 | RW | 44 | FREQ_HI_THR | Frequency High Threshold: Sets the high threshold for the TMDS Clock frequency detect circuit in MHz. |
| 95 | 0x5F | HDMI Frequency | 7:0 | R | 0x00 | HDMI_FREQ | HDMI frequency: Returns the value of the HDMI frequency in MHz. A value of 0 indicates the HDMI receiver is not detecting a valid signal. |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---------------|--------|---------------|---------------|--------------|---|
| 96 | 0x60 | SPI_TIMING1 | 7:4 | RW | 0x02 | SPI_HOLD | SPI Data Hold from SPI clock: These bits set the minimum hold time for SPI data following the SPI clock sampling edge. In addition, this also sets the minimum active pulse width for the SPI output clock. 0: Do not use. 0x1-0xF: Hold = (SPI_HOLD + 1) * 40ns. For example, default setting of 2 will result in 120ns data hold time. |
| | | | 3:0 | RW | 0x02 | SPI_SETUP | SPI Data Setup to SPI Clock: These bits set the minimum setup time for SPI data to the SPI clock active edge. In addition, this also sets the minimum inactive width for the SPI output clock. 0: Do not use. 0x1-0xF: Hold = (SPI_SETUP + 1) * 40ns. For example, default setting of 2 will result in 120ns data setup time. |
| 97 | 0x61 | SPI_TIMING2 | 7:4 | | | | Reserved. |
| | | | 3:0 | RW | 0x00 | SPI_SS_SETUP | SPI Slave Select Setup: This field controls the delay from assertion of the Slave Select low to initial data timing. Delays are in units of 40ns. Delay = (SPI_SS_SETUP + 1) * 40ns. |
| 98 | 0x62 | SPI_CONFIG | 7:2 | | | | Reserved. |
| | | | 1 | R | 0x00 | SPI_CPHA | SPI Clock Phase setting: Determines which phase of the SPI clock is used for sampling data. 0: Data sampled on leading (first) clock edge. 1: Data sampled on trailing (second) clock edge. This bit is read-only, with a value of 0. There is no support for CPHA of 1. |
| | | | 0 | RW | | SPI_CPOL | SPI Clock Polarity setting: Determines the base (inactive) value of the SPI clock. 0: base value of the clock is 0. 1: base value of the clock is 1. This bit affects both capture and propagation of SPI signals. |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---------------------------|--------|---------------|--------------------------|---|---|
| 100 | 0x64 | Pattern Generator Control | 7:4 | RW | 0x10 | Pattern Generator Select | Fixed Pattern Select Selects the pattern to output when in Fixed Pattern Mode. Scaled patterns are evenly distributed across the horizontal or vertical active regions. This field is ignored when Auto-Scrolling Mode is enabled. xxxx: normal/inverted. 0000: Checkerboard. 0001: White/Black (default). 0010: Black/White. 0011: Red/Cyan. 0100: Green/Magenta. 0101: Blue/Yellow. 0110: Horizontal Black-White/White-Black. 0111: Horizontal Black-Red/White-Cyan. 1000: Horizontal Black-Green/White-Magenta. 1001: Horizontal Black-Blue/White-Yellow. 1010: Vertical Black-White/White-Black. 1011: Vertical Black-Red/White-Cyan. 1100: Vertical Black-Green/White-Magenta. 1101: Vertical Black-Blue/White-Yellow. 1110: Custom color (or its inversion) configured in PGRS, PGGS, PGBS registers. 1111: VCOM. See TI App Note AN-2198. |
| | | | 3 | | | Reserved. | |
| | | | 2 | RW | Color Bars Pattern | Enable color bars: 0: Color Bars disabled (default). 1: Color Bars enabled. Overrides the selection from reg_0x64[7:4]. | |
| | | | 1 | RW | VCOM Pattern Reverse | Reverse order of color bands in VCOM pattern: 0: Color sequence from top left is (YCBR) (default). 1: Color sequence from top left is (RBCY). | |
| | | | 0 | RW | Pattern Generator Enable | Pattern Generator enable: 0: Disable Pattern Generator (default). 1: Enable Pattern Generator. | |

Register Maps (continued)

Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---------------------------------|--------|---------------|---------------|---------------------|---|
| 101 | 0x65 | Pattern Generator Configuration | 7 | | 0x00 | | Reserved. |
| | | | 6 | RW | | Checkerboard Scale | Scale Checkered Patterns: 0: Normal operation (each square is 1x1 pixel) (default). 1: Scale checkered patterns (VCOM and checkerboard) by 8 (each square is 8x8 pixels). Setting this bit gives better visibility of the checkered patterns. |
| | | | 5 | RW | | Custom Checkerboard | Use Custom Checkerboard Color: 0: Use white and black in the Checkerboard pattern (default). 1: Use the Custom Color and black in the Checkerboard pattern. |
| | | | 4 | RW | | PG 18-bit Mode | 18-bit Mode Select: 0: Enable 24-bit pattern generation. Scaled patterns use 256 levels of brightness (default). 1: Enable 18-bit color pattern generation. Scaled patterns will have 64 levels of brightness and the R, G, and B outputs use the six most significant color bits. |
| | | | 3 | RW | | External Clock | Select External Clock Source: 0: Selects the internal divided clock when using internal timing (default). 1: Selects the external pixel clock when using internal timing. This bit has no effect in external timing mode (PATGEN_TSEL = 0). |
| | | | 2 | RW | | Timing Select | Timing Select Control: 0: The Pattern Generator uses external video timing from the pixel clock, Data Enable, Horizontal Sync, and Vertical Sync signals (default). 1: The Pattern Generator creates its own video timing as configured in the Pattern Generator Total Frame Size, Active Frame Size, Horizontal Sync Width, Vertical Sync Width, Horizontal Back Porch, Vertical Back Porch, and Sync Configuration registers. See Exploring the Internal Test Pattern Generation Feature of 720p FPD-Link III Devices (SNLA132) . |
| | | | 1 | RW | | Color Invert | Enable Inverted Color Patterns: 0: Do not invert the color output (default). 1: Invert the color output. See Exploring the Internal Test Pattern Generation Feature of 720p FPD-Link III Devices (SNLA132) . |
| | | | 0 | RW | | Auto Scroll | Auto Scroll Enable: 0: The Pattern Generator retains the current pattern (default). 1: The Pattern Generator will automatically move to the next enabled pattern after the number of frames specified in the Pattern Generator Frame Time (PGFT) register. See Exploring the Internal Test Pattern Generation Feature of 720p FPD-Link III Devices (SNLA132) . |
| 102 | 0x66 | PGIA | 7:0 | RW | 0x00 | PG Indirect Address | This 8-bit field sets the indirect address for accesses to indirectly-mapped registers. It should be written prior to reading or writing the Pattern Generator Indirect Data register. See Exploring the Internal Test Pattern Generation Feature of 720p FPD-Link III Devices (SNLA132) . |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---------------|--------|---------------|---------------|------------------------|---|
| 103 | 0x67 | PGID | 7:0 | RW | 0x00 | PG Indirect Data | When writing to indirect registers, this register contains the data to be written. When reading from indirect registers, this register contains the read back value. See Exploring the Internal Test Pattern Generation Feature of 720p FPD-Link III Devices (SNLA132) . |
| 112 | 0x70 | Slave ID[1] | 7:1 | RW | 0x00 | Slave ID 1 Port0/Port1 | 7-bit I2C address of the remote Slave 1 attached to the remote Deserializer. If an I2C transaction is addressed to Slave Alias ID 1, the transaction will be remapped to this address before passing the transaction across the Bidirectional Control Channel to the Deserializer. A value of 0 in this field disables access to the remote Slave 1. If PORT1_SEL is set, this register controls Port 1 Slave ID. |
| | | | 0 | | | | Reserved. |
| 113 | 0x71 | Slave ID[2] | 7:1 | RW | 0x00 | Slave ID 2 Port0/Port1 | 7-bit I2C address of the remote Slave 2 attached to the remote Deserializer. If an I2C transaction is addressed to Slave Alias ID 2, the transaction will be remapped to this address before passing the transaction across the Bidirectional Control Channel to the Deserializer. A value of 0 in this field disables access to the remote Slave 2. If PORT1_SEL is set, this register controls Port 1 Slave ID. |
| | | | 0 | | | | Reserved. |
| 114 | 0x72 | Slave ID[3] | 7:1 | RW | 0x00 | Slave ID 3 Port0/Port1 | 7-bit I2C address of the remote Slave 3 attached to the remote Deserializer. If an I2C transaction is addressed to Slave Alias ID 3, the transaction will be remapped to this address before passing the transaction across the Bidirectional Control Channel to the Deserializer. A value of 0 in this field disables access to the remote Slave 3. If PORT1_SEL is set, this register controls Port 1 Slave ID. |
| | | | 0 | | | | Reserved. |
| 115 | 0x73 | Slave ID[4] | 7:1 | RW | 0x00 | Slave ID 4 Port0/Port1 | 7-bit I2C address of the remote Slave 4 attached to the remote Deserializer. If an I2C transaction is addressed to Slave Alias ID 4, the transaction will be remapped to this address before passing the transaction across the Bidirectional Control Channel to the Deserializer. A value of 0 in this field disables access to the remote Slave 4. If PORT1_SEL is set, this register controls Port 1 Slave ID. |
| | | | 0 | | | | Reserved. |
| 116 | 0x74 | Slave ID[5] | 7:1 | RW | 0x00 | Slave ID 5 Port0/Port1 | 7-bit I2C address of the remote Slave 5 attached to the remote Deserializer. If an I2C transaction is addressed to Slave Alias ID 5, the transaction will be remapped to this address before passing the transaction across the Bidirectional Control Channel to the Deserializer. A value of 0 in this field disables access to the remote Slave 5. If PORT1_SEL is set, this register controls Port 1 Slave ID. |
| | | | 0 | | | | Reserved. |
| 117 | 0x75 | Slave ID[6] | 7:1 | RW | 0x00 | Slave ID 6 Port0/Port1 | 7-bit I2C address of the remote Slave 6 attached to the remote Deserializer. If an I2C transaction is addressed to Slave Alias ID 6, the transaction will be remapped to this address before passing the transaction across the Bidirectional Control Channel to the Deserializer. A value of 0 in this field disables access to the remote Slave 6. If PORT1_SEL is set, this register controls Port 1 Slave ID. |
| | | | 0 | | | | Reserved. |

Register Maps (continued)

Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|----------------|--------|---------------|---------------|------------------------------|---|
| 118 | 0x76 | Slave ID[7] | 7:1 | RW | 0x00 | Slave ID 7 Port0/Port1 | 7-bit I2C address of the remote Slave 7 attached to the remote Deserializer. If an I2C transaction is addressed to Slave Alias ID 7, the transaction will be remapped to this address before passing the transaction across the Bidirectional Control Channel to the Deserializer. A value of 0 in this field disables access to the remote Slave 7. If PORT1_SEL is set, this register controls Port 1 Slave ID. |
| | | | 0 | | | | Reserved. |
| 119 | 0x77 | Slave Alias[1] | 7:1 | RW | 0x00 | Slave Alias ID 1 Port0/Port1 | 7-bit Slave Alias ID of the remote Slave 1 attached to the remote Deserializer. The transaction will be remapped to the address specified in the Slave ID 1 register. A value of 0 in this field disables access to the remote Slave 1. If PORT1_SEL is set, this register controls Port 1 Slave Alias. |
| | | | 0 | | | | Reserved. |
| 120 | 0x78 | Slave Alias[2] | 7:1 | RW | 0x00 | Slave Alias ID 2 Port0/Port1 | 7-bit Slave Alias ID of the remote Slave 2 attached to the remote Deserializer. The transaction will be remapped to the address specified in the Slave ID 2 register. A value of 0 in this field disables access to the remote Slave 2. If PORT1_SEL is set, this register controls Port 1 Slave Alias. |
| | | | 0 | | | | Reserved. |
| 121 | 0x79 | Slave Alias[3] | 7:1 | RW | 0x00 | Slave Alias ID 3 Port0/Port1 | 7-bit Slave Alias ID of the remote Slave 3 attached to the remote Deserializer. The transaction will be remapped to the address specified in the Slave ID 3 register. A value of 0 in this field disables access to the remote Slave 3. If PORT1_SEL is set, this register controls Port 1 Slave Alias. |
| | | | 0 | | | | Reserved. |
| 122 | 0x7A | Slave Alias[4] | 7:1 | RW | 0x00 | Slave Alias ID 4 Port0/Port1 | 7-bit Slave Alias ID of the remote Slave 4 attached to the remote Deserializer. The transaction will be remapped to the address specified in the Slave ID 4 register. A value of 0 in this field disables access to the remote Slave 4. If PORT1_SEL is set, this register controls Port 1 Slave Alias. |
| | | | 0 | | | | Reserved. |
| 123 | 0x7B | Slave Alias[5] | 7:1 | RW | 0x00 | Slave Alias ID 5 Port0/Port1 | 7-bit Slave Alias ID of the remote Slave 5 attached to the remote Deserializer. The transaction will be remapped to the address specified in the Slave ID 5 register. A value of 0 in this field disables access to the remote Slave 5. If PORT1_SEL is set, this register controls Port 1 Slave Alias. |
| | | | 0 | | | | Reserved. |
| 124 | 0x7C | Slave Alias[6] | 7:1 | RW | 0x00 | Slave Alias ID 6 Port0/Port1 | 7-bit Slave Alias ID of the remote Slave 6 attached to the remote Deserializer. The transaction will be remapped to the address specified in the Slave ID 6 register. A value of 0 in this field disables access to the remote Slave 6. If PORT1_SEL is set, this register controls Port 1 Slave Alias. |
| | | | 0 | | | | Reserved. |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|----------------|--------|---------------|---------------|------------------------------|---|
| 125 | 0x7D | Slave Alias[7] | 7:1 | RW | 0x00 | Slave Alias ID 7 Port0/Port1 | 7-bit Slave Alias ID of the remote Slave 7 attached to the remote Deserializer. The transaction will be remapped to the address specified in the Slave ID 7 register. A value of 0 in this field disables access to the remote Slave 7. If PORT1_SEL is set, this register controls Port 1 Slave Alias. |
| | | | 0 | | | | Reserved. |
| 198 | 0xC6 | ICR | 7 | RW | 0x00 | IE_IND_ACC | Interrupt on Indirect Access Complete: Enables interrupt on completion of Indirect Register Access. |
| | | | 6 | RW | | IE_RXDET_INT | Interrupt on Receiver Detect: Enables interrupt on detection of a downstream Receiver. |
| | | | 5 | RW | | IE_RX_INT | Interrupt on Receiver interrupt: Enables interrupt on indication from the Receiver. Allows propagation of interrupts from downstream devices. |
| | | | 4 | RW | | IE_LIST_RDY | Interrupt on KSV List Ready: Enables interrupt on KSV List Ready. |
| | | | 3 | RW | | IE_KSV_RDY | Interrupt on KSV Ready: Enables interrupt on KSV Ready. |
| | | | 2 | RW | | IE_AUTH_FAIL | Interrupt on Authentication Failure: Enables interrupt on authentication failure or loss of authentication. |
| | | | 1 | RW | | IE_AUTH_PAS S | Interrupt on Authentication Pass: Enables interrupt on successful completion of authentication. |
| | | | 0 | RW | | INT_EN | Global Interrupt Enable: Enables interrupt on the interrupt signal to the controller. |
| 199 | 0xC7 | ISR | 7 | R | 0x00 | IS_IND_ACC | Interrupt on Indirect Access Complete: Indirect Register Access has completed. |
| | | | 6 | R | | IS_RXDET_INT | Interrupt on Receiver Detect interrupt: A downstream receiver has been detected. |
| | | | 5 | R | | IS_RX_INT | Interrupt on Receiver interrupt: Receiver has indicated an interrupt request from downstream device. |
| | | | 4 | R | | IS_LIST_RDY | Interrupt on KSV List Ready: The KSV list is ready for reading by the controller. |
| | | | 3 | R | | IS_KSV_RDY | Interrupt on KSV Ready: The Receiver KSV is ready for reading by the controller. |
| | | | 2 | R | | IS_AUTH_FAIL | Interrupt on Authentication Failure: Authentication failure or loss of authentication has occurred. |
| | | | 1 | R | | IS_AUTH_PAS S | Interrupt on Authentication Pass: Authentication has completed successfully. |
| | | | 0 | R | | INT | Global Interrupt: Set if any enabled interrupt is indicated. |

Register Maps (continued)
Table 10. Serial Control Bus Registers (continued)

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|---------------|--------|---------------|---------------|----------|------------------------------|
| 240 | 0xF0 | TX ID | 7:0 | R | 0x5F | ID0 | First byte ID code: "_". |
| 241 | 0xF1 | | 7:0 | R | 0x55 | ID1 | Second byte of ID code: "U". |
| 242 | 0xF2 | | 7:0 | R | 0x42 | ID2 | Third byte of ID code: "B". |
| 243 | 0xF3 | | 7:0 | R | 0x39 | ID3 | Fourth byte of ID code: "9". |
| 244 | 0xF4 | | 7:0 | R | 0x34 | ID4 | Fifth byte of ID code: "4". |
| 245 | 0xF5 | | 7:0 | R | 0x39 | ID5 | Sixth byte of ID code: "9". |

NOTE

Registers 0x40, 0x41, and 0x42 of the Serial Control Bus Registers are used to access the Page 0x10 and 0x14 registers.

Table 11. Page 0x10 Register

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|------------------------|--------|---------------|---------------|---------------------|---|
| 73 | 0x49 | OLDI_PLL_STATE_MC_CNTL | 7:5 | RW | 0x00 | | Reserved |
| | | | 4 | | | OLDI_STATE_MC_RESET | Enable HDMI PLL reset state 0: Disable state machine reset (normal operation). 1: Enable state machine reset. |
| | | | 3:0 | | | | Reserved, when writing to this register always write '0000b to these bits. |

Table 12. Page 0x14 Register

| ADD (dec) | ADD (hex) | REGISTER NAME | BIT(S) | REGISTER TYPE | DEFAULT (hex) | FUNCTION | DESCRIPTION |
|-----------|-----------|-----------------------|--------|---------------|---------------|--------------------|--|
| 73 | 0x49 | FPD_PLL_STATE_MC_CNTL | 7:5 | RW | 0x00 | | Reserved |
| | | | 4 | | | FPD_STATE_MC_RESET | Enable FPD PLL reset state 0: Disable state machine reset (normal operation). 1: Enable state machine reset. |
| | | | 3:0 | | | | Reserved, when writing to this register always write '0000b to these bits. |

8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Applications Information

The DS90UB949-Q1, in conjunction with the DS90UB940-Q1/DS90UB948-Q1 deserializer, is intended to interface between a host (graphics processor) and a display, supporting 24-bit color depth (RGB888) and high definition (1080p) digital video format. It can receive an 8-bit RGB stream with a pixel clock rate up to 170 MHz together with four I2S audio streams when paired with the DS90UB940-Q1/DS90UB948-Q1 deserializer.

8.2 Typical Applications

Bypass capacitors should be placed near the power supply pins. A capacitor and resistor are placed on the PDB pin to delay the enabling of the device until power is stable. See and for typical STP and coax connection diagrams.

Typical Applications (continued)

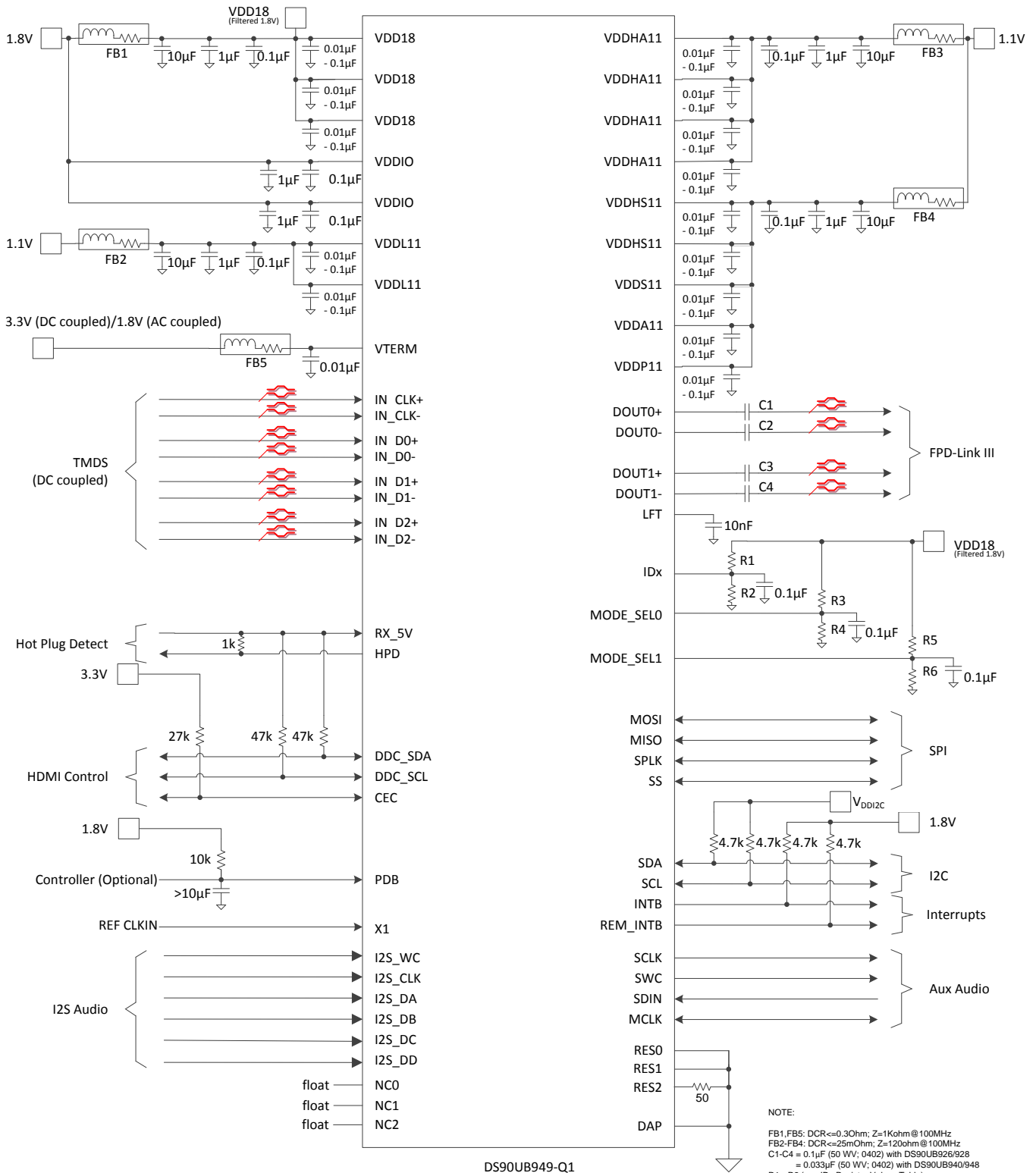


Figure 25. Typical Application Connection -- STP

Typical Applications (continued)

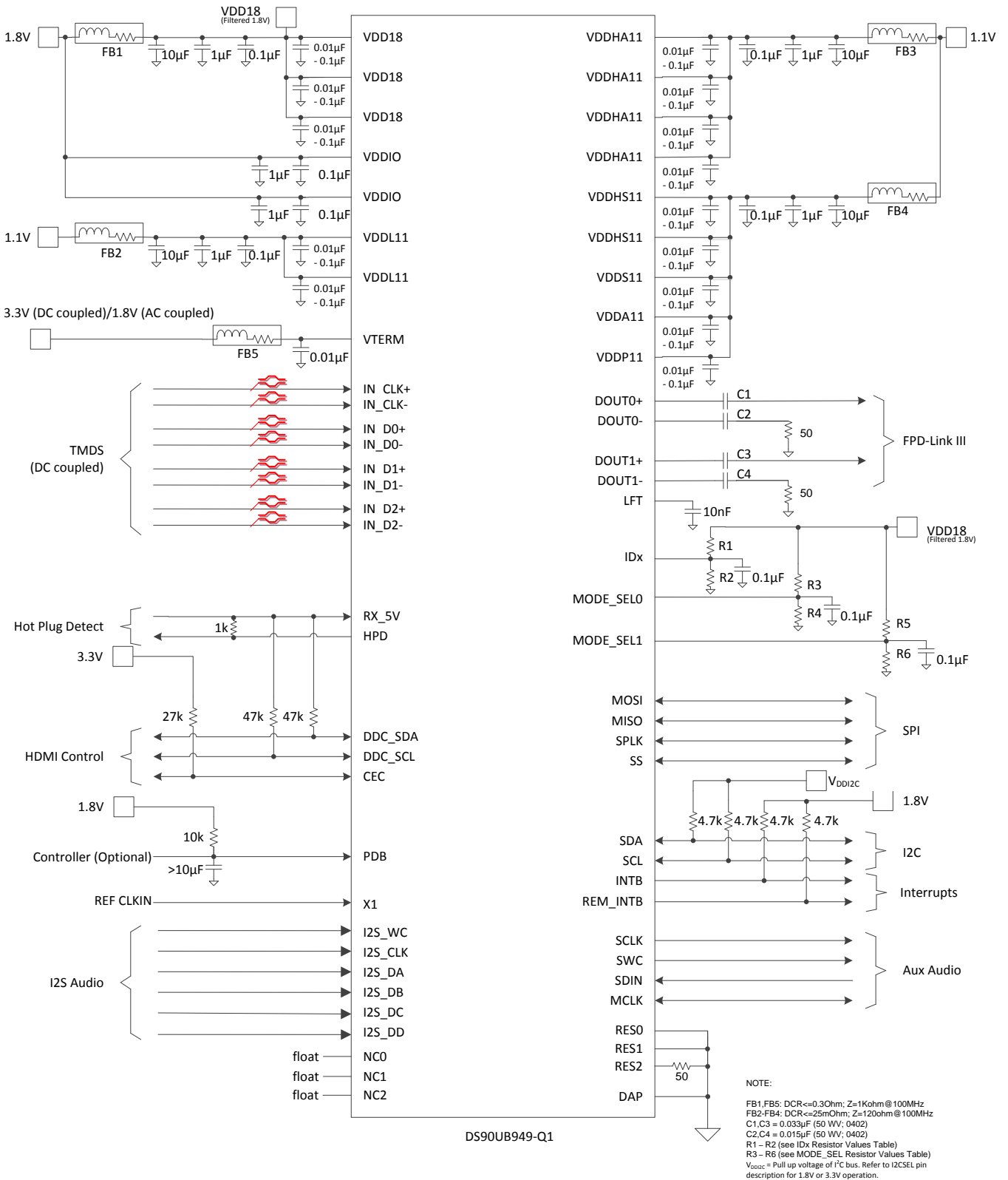
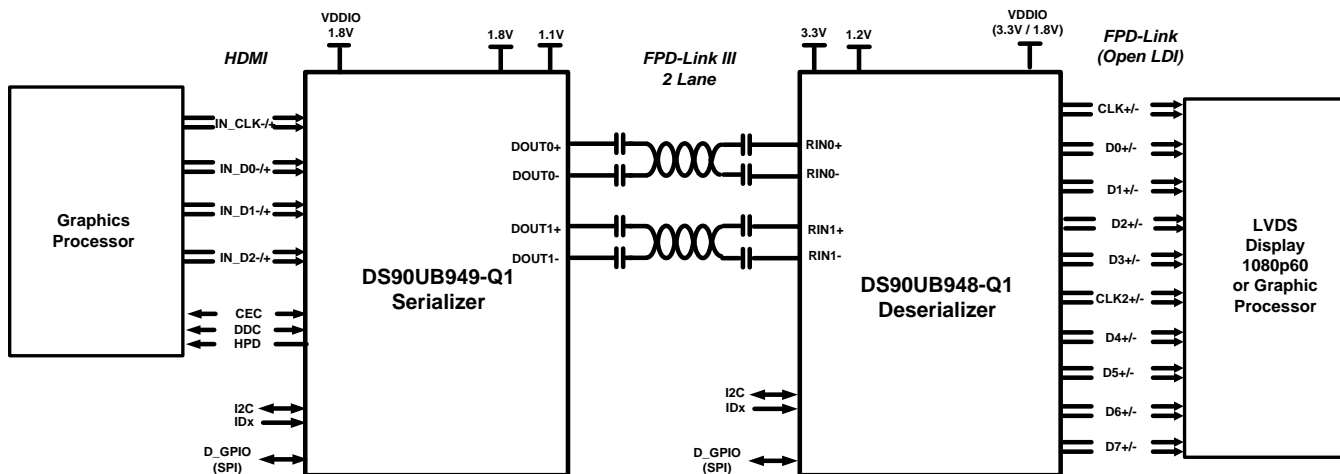


Figure 26. Typical Application Connection -- Coax

Typical Applications (continued)



HDMI – High Definition Multimedia Interface

Figure 27. Typical System Diagram

8.2.1 Design Requirements

The SER/DES supports only AC-coupled interconnects through an integrated DC-balanced decoding scheme. External AC-coupling capacitors must be placed in series in the FPD-Link III signal path as shown in Figure 28.

Table 13. Design Parameters

| DESIGN PARAMETER | EXAMPLE VALUE |
|--|---------------|
| VDDIO | 1.8 V |
| AC-Coupling Capacitor for DOUT0± and DOUT1± with 92x deserializers | 100 nF |
| AC-Coupling Capacitor for DOUT0± and DOUT1± with 94x deserializers | 33 nF |

For applications using single-ended 50-Ω coaxial cable, the unused data pins (DOUT0-, DOUT1-) should use a 15-nF capacitor and should be terminated with a 50-Ω resistor.

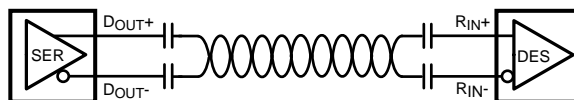


Figure 28. AC-Coupled Connection (STP)

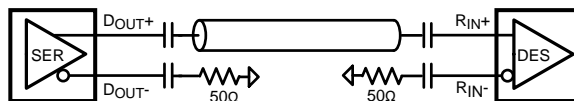


Figure 29. AC-Coupled Connection (Coaxial)

For high-speed FPD-Link III transmissions, the smallest available package should be used for the AC-coupling capacitor. This will help minimize degradation of signal quality due to package parasitics.

8.2.2 Detailed Design Procedure

8.2.2.1 High-Speed Interconnect Guidelines

See [LVDS SerDes Gen I PCB and Interconnect Design-In Guidelines](#) (SNLA008) and [Transmission Line RAPIDESIGNER Operation and Applications Guide](#) (SNLA035) for full details.

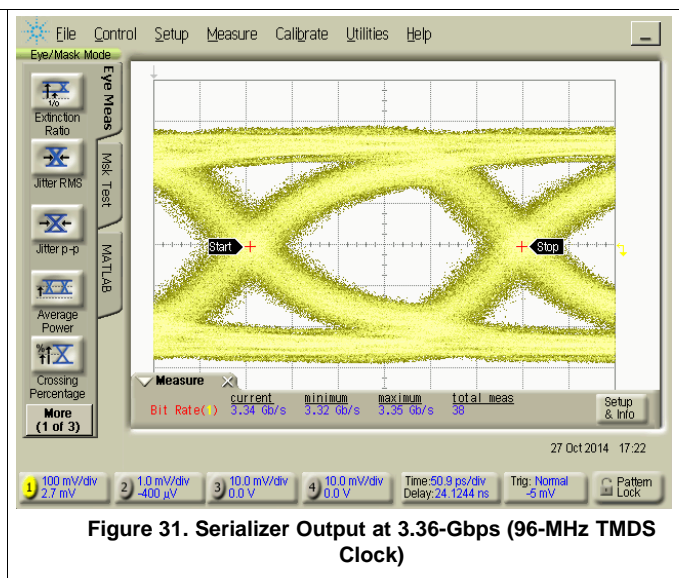
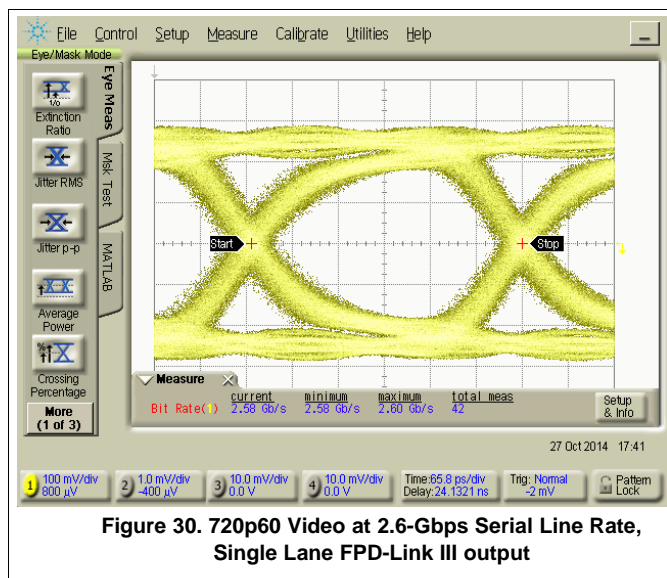
- Use 100-Ω coupled differential pairs
- Use the S/2S/3S rule in spacings
 - S = space between the pair
 - 2S = space between pairs
 - 3S = space to LVCMOS signal
- Minimize the number of Vias
- Use differential connectors when operating above 500-Mbps line speed
- Maintain balance of the traces
- Minimize skew within the pair
- Terminate as close to the TX outputs and RX inputs as possible

Additional general guidance can be found in the LVDS Owner's Manual - available in PDF format from the Texas Instruments web site at: [LVDS Owner's Manual](#) (SNLA187).

8.2.3 Application Curves

8.2.3.1 Application Performance Plots

Figure 30 corresponds to 720p60 video application with single lane FPD-Link III output. Figure 31 corresponds to 3.36-Gbps single-lane output from 96-MHz input TMDS clock.



9 Power Supply Recommendations

This device provides separate power and ground pins for different portions of the circuit. This is done to isolate switching noise effects between different sections of the circuit. Separate planes on the PCB are typically not required. The Pin Functions table in the [Pin Configuration and Functions](#) section provides guidance on which circuit blocks are connected to which power pins. In some cases, an external filter may be used to provide clean power to sensitive circuits such as PLLs.

9.1 Power-Up Requirements and PDB Pin

The power supply ramp should be faster than 1.5 ms with a monotonic rise. A large capacitor on the PDB pin may be used to ensure PDB arrives after all the supply pins have settled to the recommended operating voltage. When PDB pin is pulled up to V_{DDIO} , a 10-k Ω pullup and a >10- μ F capacitor to GND are required to delay the PDB input signal rise. All inputs must not be driven until all power supplies have reached steady state.

The recommended power up sequence is as follows:

- V_{DD18}
- V_{TERM}
- V_{DD11}
- Wait until all supplies have settled
- Activate PDB
- Apply HDMI input

There will be no functional impact to using a different sequence than shown below, but the current draw on V_{TERM} during power up may be higher in other cases.

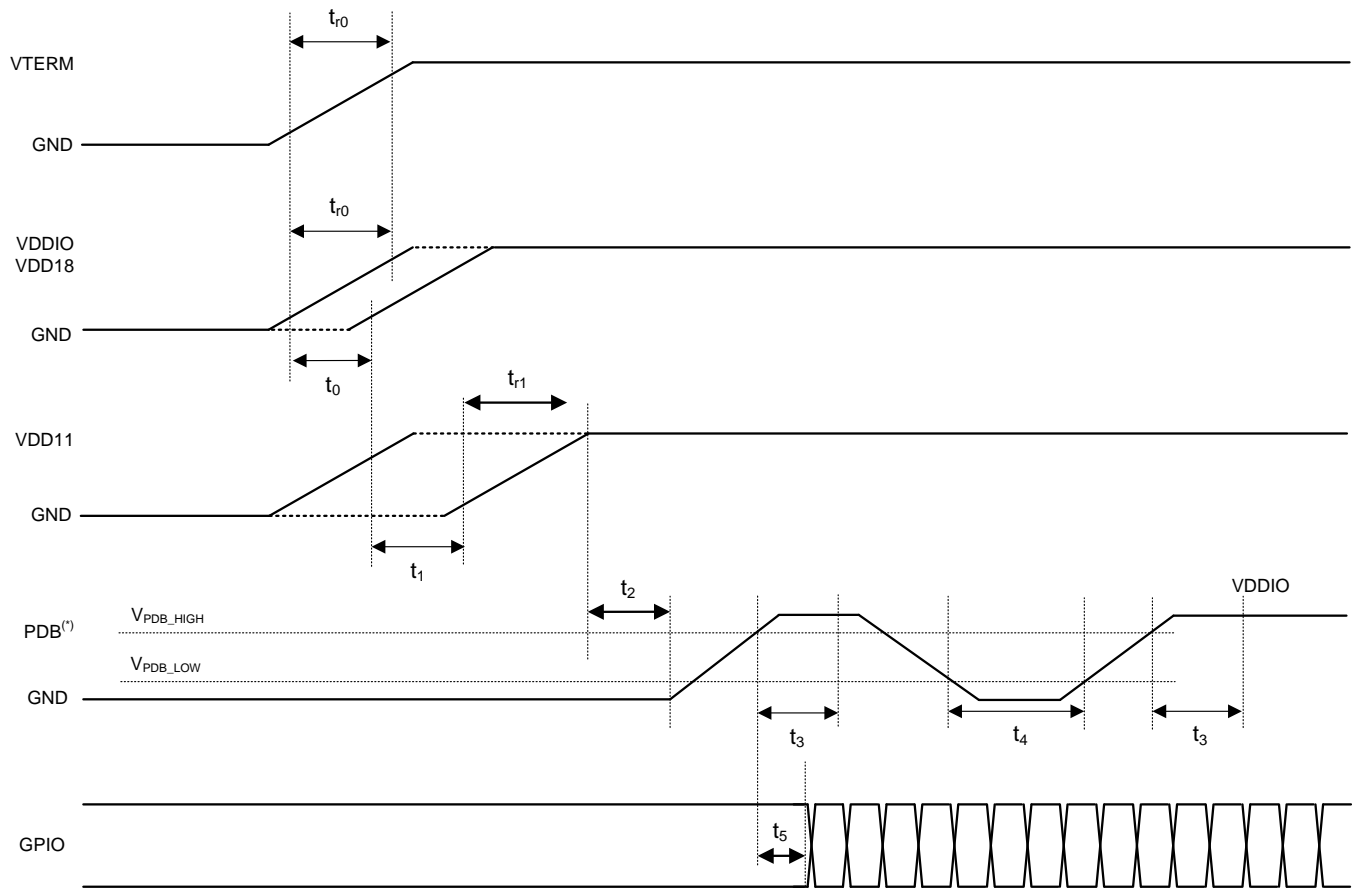
The initialization sequence A shown in [Figure 33](#) consists of any user-defined device configurations and the following:

1. Set Register 0x5B bit 5 to 0. This disables the FPD3 PLL from resetting when a frequency change is detected.
2. Set Register 0x16 to 0x02. This minimizes the duration of inadvertent I2C events.

The initialization sequence B shown in [Figure 33](#) should be performed after the TMDS clock has stabilized. Sequence B consists of the following:

1. Reset the HDMI PLL by writing the following registers:
 - Register 0x40 = 0x10
 - Register 0x41 = 0x49
 - Register 0x42 = 0x10
 - Register 0x42 = 0x00
2. Reset the FPD PLL by writing the following registers:
 - Register 0x40 = 0x14
 - Register 0x41 = 0x49
 - Register 0x42 = 0x10
 - Register 0x42 = 0x00

Power-Up Requirements and PDB Pin (continued)



^(*) TI recommends that the designer assert PDB (active High) with a microcontroller rather than an RC filter network to help ensure proper sequencing of PDB pin after settling of power supplies.

Figure 32. Recommended Power Sequencing

Power-Up Requirements and PDB Pin (continued)

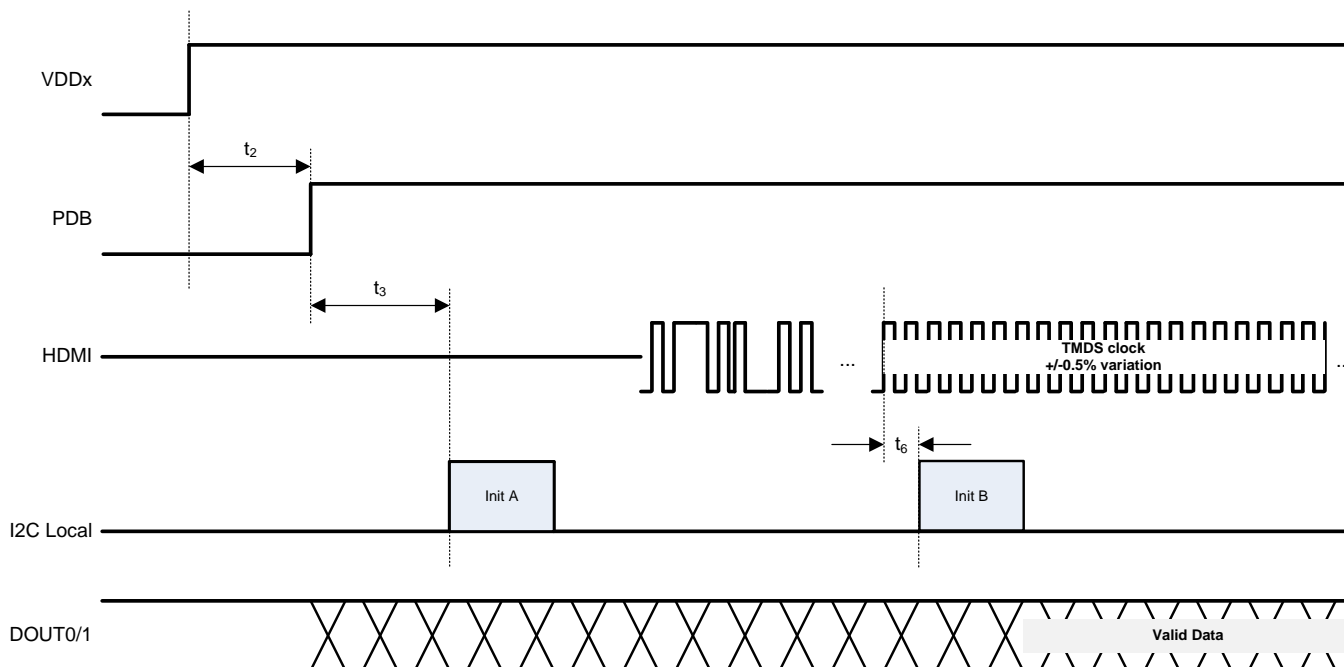


Figure 33. Initialization Sequencing

Table 14. Power-Up Sequencing Constraints

| SYMBOL | DESCRIPTION | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------------------|--|---|--------------|-----|--------------|------|
| VDD18, VDDIO | VDD18 / VDDIO voltage range | | 1.71 | | 1.89 | V |
| VTERM | VTERM voltage range | DC-coupled HDMI termination | 3.135 | | 3.465 | V |
| | | AC-coupled HDMI termination | 1.71 | | 1.89 | V |
| VDD11 | VDD11 voltage range | | 1.045 | | 1.155 | V |
| V _{PDB_LOW} | PDB LOW threshold Note: V _{PDB} should not exceed limit for respective I/O voltage before 90% voltage of VDD12 | VDDIO = 1.8V ± 5% | 0.35 * VDDIO | | | V |
| V _{PDB_HIGH} | PDB HIGH threshold | VDDIO = 1.8V ± 5% | | | 0.65 * VDDIO | V |
| t ₀ | VTERM / VDDIO / VDD18 rise time | These time constants are specified for rise time of power supply voltage ramp (10% -90%). | | | 1.5 | ms |
| t ₁ | VDD11 rise time | These time constants are specified for rise time of power supply voltage ramp (10% -90%). | | | 1.5 | ms |
| t ₀ | VDDIO / VDD18 delay time | VTERM needs to ramp-up before VDD18 and VDDIO. | 0 | | | ms |
| t ₁ | VDD11 delay time | VDDIO and VDD18 need to ramp-up before VDD11. | 0 | | | ms |
| t ₂ | PDB delay time | PDB should be released after all supplies are stable. | 0 | | | ms |
| t ₃ | I2C ready time | Starting from PDB high, the local I2C access is available after this time. | 2 | | | ms |
| t ₄ | Hard reset time | PDB negative pulse width required for the device reset. | 2 | | | ms |

Power-Up Requirements and PDB Pin (continued)
Table 14. Power-Up Sequencing Constraints (continued)

| SYMBOL | DESCRIPTION | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--------|---|--|-----|-----|-----|---------|
| t_5 | PDB to HDMI delay time | Keep GPIOs low or high until after PDB release. | 0 | | | ms |
| t_6 | TMDS Clock Stable to PLL Reset (Init B) | TMDS Clock must be within 0.5% of the target frequency and stable. | 1 | | | μ s |

10 Layout

10.1 Layout Guidelines

Circuit board layout and stack-up for the LVDS serializer and deserializer devices should be designed to provide low-noise power to the device. Good layout practice will also separate high frequency or high-level inputs and outputs to minimize unwanted stray noise, feedback and interference. Power system performance may be greatly improved by using thin dielectrics (2 to 4 mil) for power / ground sandwiches. This arrangement uses the plane capacitance for the PCB power system and has low-inductance, which has proven effectiveness especially at high frequencies, and makes the value and placement of external bypass capacitors less critical. External bypass capacitors should include both RF ceramic and tantalum electrolytic types. RF capacitors may use values in the range of 0.01- μ F to 10- μ F. Tantalum capacitors may be in the 2.2- μ F to 10- μ F range. The voltage rating of the tantalum capacitors should be at least 5X the power supply voltage being used.

MLCC surface mount capacitors are recommended due to their smaller parasitic properties. When using multiple capacitors per supply pin, place the smaller value closer to the pin. A large bulk capacitor is recommended at the point of power entry. This is typically in the 50- μ F to 100- μ F range and will smooth low frequency switching noise. TI recommends to connect power and ground pins directly to the power and ground planes with bypass capacitors connected to the plane with via on both ends of the capacitor. Connecting power or ground pins to an external bypass capacitor will increase the inductance of the path. A small body size X7R chip capacitor, such as 0603 or 0805, is recommended for external bypass. A small body sized capacitor has less inductance. The user must pay attention to the resonance frequency of these external bypass capacitors, usually in the range of 20 MHz to 30 MHz. To provide effective bypassing, multiple capacitors are often used to achieve low impedance between the supply rails over the frequency of interest. At high frequency, it is also a common practice to use two vias from power and ground pins to the planes, reducing the impedance at high frequency.

Some devices provide separate power and ground pins for different portions of the circuit. This is done to isolate switching noise effects between different sections of the circuit. Separate planes on the PCB are typically not required. Pin Description tables typically provide guidance on which circuit blocks are connected to which power pin pairs. In some cases, an external filter may be used to provide clean power to sensitive circuits such as PLLs. For DS90UB949-Q1, only one common ground plane is required to connect all device related ground pins.

Use at least a four-layer board with a power and ground plane. Place LVCMOS signals away from the LVDS lines to prevent coupling from the LVCMOS lines to the LVDS lines. Closely coupled differential lines of 100 Ω are typically recommended for LVDS interconnect. The closely coupled lines help to ensure that coupled noise will appear as common mode and thus is rejected by the receivers. The tightly coupled lines will also radiate less.

At least 9 thermal vias are necessary from the device center DAP to the ground plane. They connect the device ground to the PCB ground plane, as well as conduct heat from the exposed pad of the package to the PCB ground plane. More information on the LLP style package, including PCB design and manufacturing requirements, is provided in TI [Application Note: AN-1187 \(SNOA401\)](#).

10.2 Layout Example

Figure 34 is derived from a layout design of the DS90UB949-Q1. This graphic is used to demonstrate proper high-speed routing when designing in the Serializer.

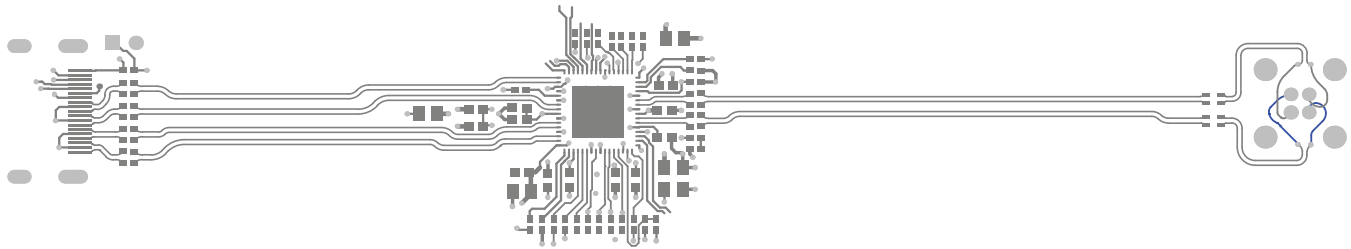


Figure 34. DS90UB949-Q1 Serializer Layout Example

11 Device and Documentation Support

11.1 Documentation Support

11.1.1 Related Documentation

For related documentation see the following:

- [Absolute maximum ratings for soldering](#) (SNOA549)
- [Semiconductor and IC package thermal metrics](#) (SPRA953)
- [Channel-link PCB and interconnect design-in guidelines](#) (SNLA008)
- [Transmission line RAPIDESIGNER operation and application guide](#) (SNLA035)
- [Leadless leadframe package \(LLP\) application report](#) (SNOA401)
- [LVDS owner's manual](#) (SNLA187)
- [I2C communication over FPD-Link III with bidirectional control channel](#) (SNLA131)
- [Using the I2S audio interface of DS90Ux92x FPD-Link III devices](#) (SNLA221)
- [Exploring the internal test pattern generation feature of 720p FPD-Link III devices](#) (SNLA132)

11.2 Trademarks

TRI-STATE is a trademark of Texas Instruments.
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11.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

11.4 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

12 Mechanical, Packaging and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead/Ball Finish (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|-------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| DS90UB949TRGCRQ1 | ACTIVE | VQFN | RGC | 64 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-3-260C-168 HR | -40 to 105 | UB949Q | Samples |
| DS90UB949TRGCTQ1 | ACTIVE | VQFN | RGC | 64 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-3-260C-168 HR | -40 to 105 | UB949Q | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| DS90UB949TRGCRQ1 | VQFN | RGC | 64 | 2000 | 330.0 | 16.4 | 9.3 | 9.3 | 1.1 | 12.0 | 16.0 | Q2 |
| DS90UB949TRGCTQ1 | VQFN | RGC | 64 | 250 | 180.0 | 16.4 | 9.3 | 9.3 | 1.1 | 12.0 | 16.0 | Q2 |

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| DS90UB949TRGCRQ1 | VQFN | RGC | 64 | 2000 | 367.0 | 367.0 | 38.0 |
| DS90UB949TRGCTQ1 | VQFN | RGC | 64 | 250 | 210.0 | 185.0 | 35.0 |

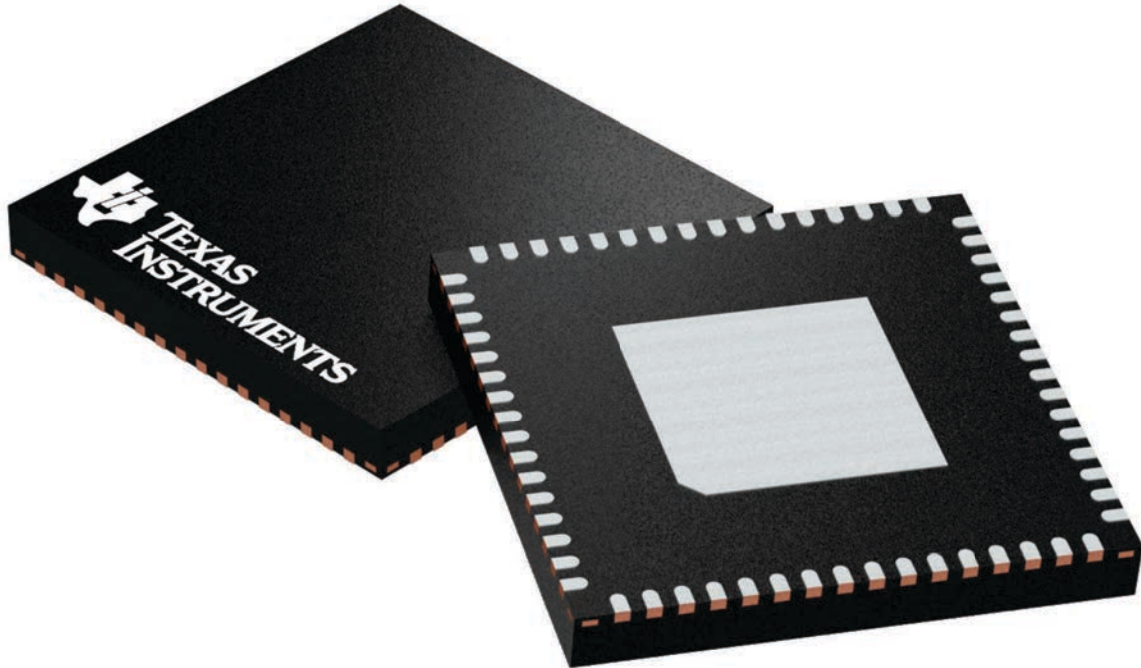
GENERIC PACKAGE VIEW

RGC 64

VQFN - 1 mm max height

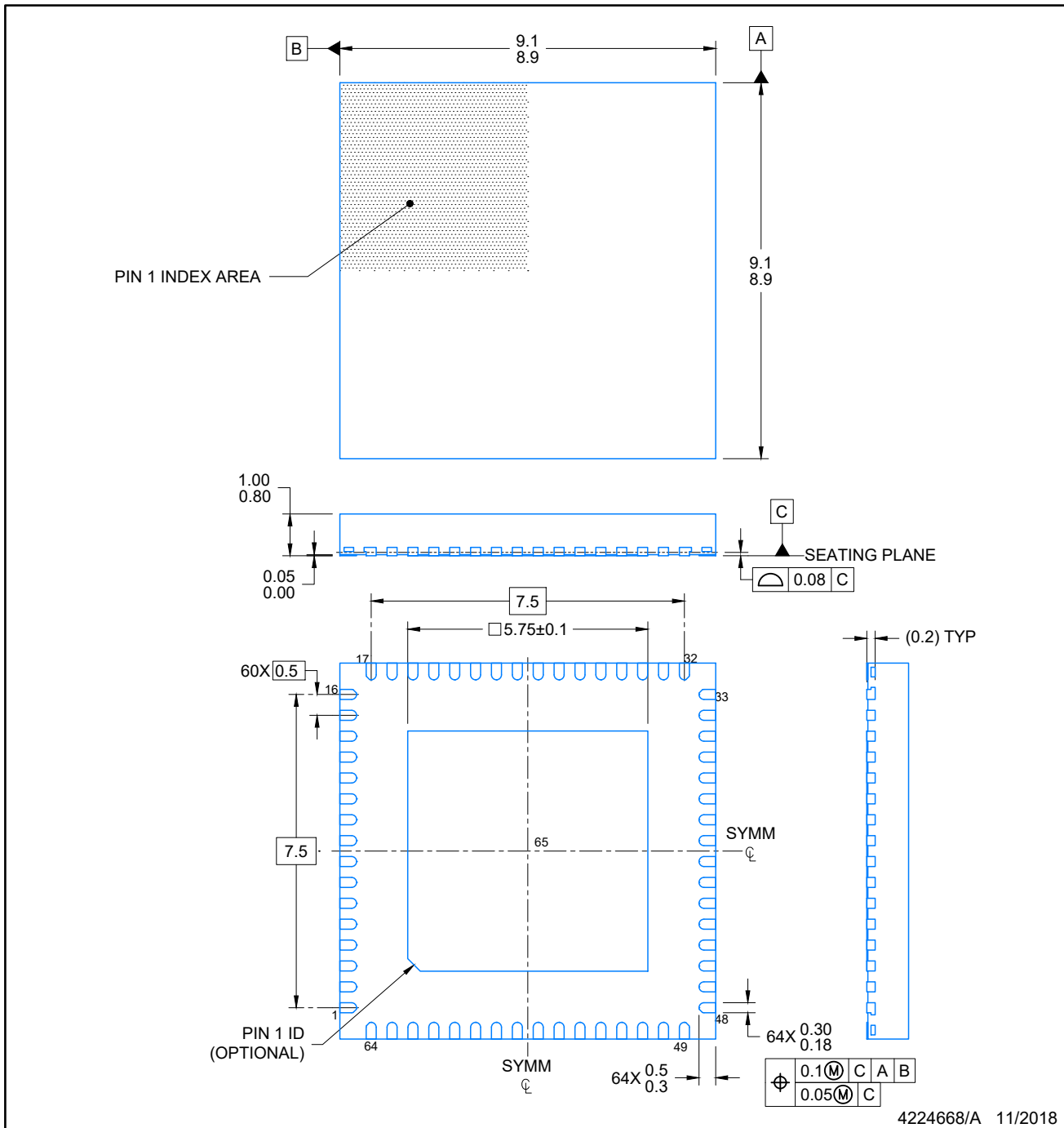
9 x 9, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

4224597/A



NOTES:

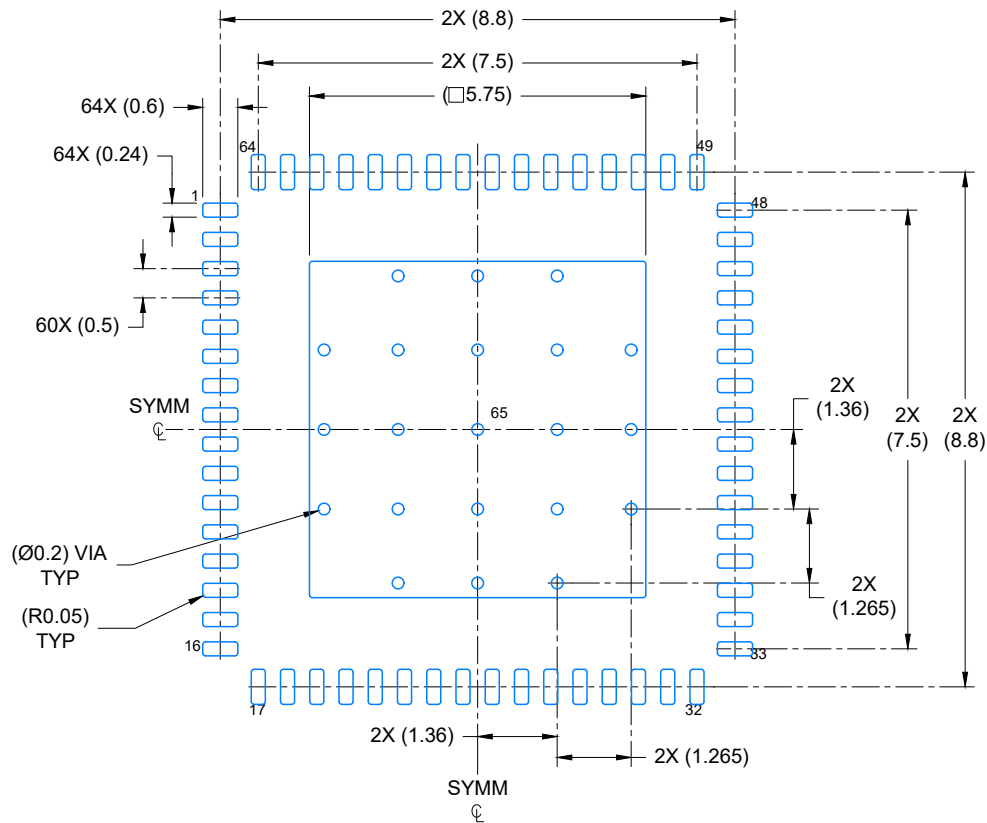
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for optimal thermal and mechanical performance.

EXAMPLE BOARD LAYOUT

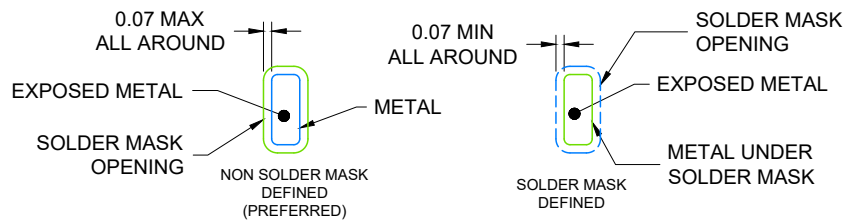
VQFN - 1 mm max height

RGC0064K

PLASTIC QUAD FLAT PACK- NO LEAD



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 8X

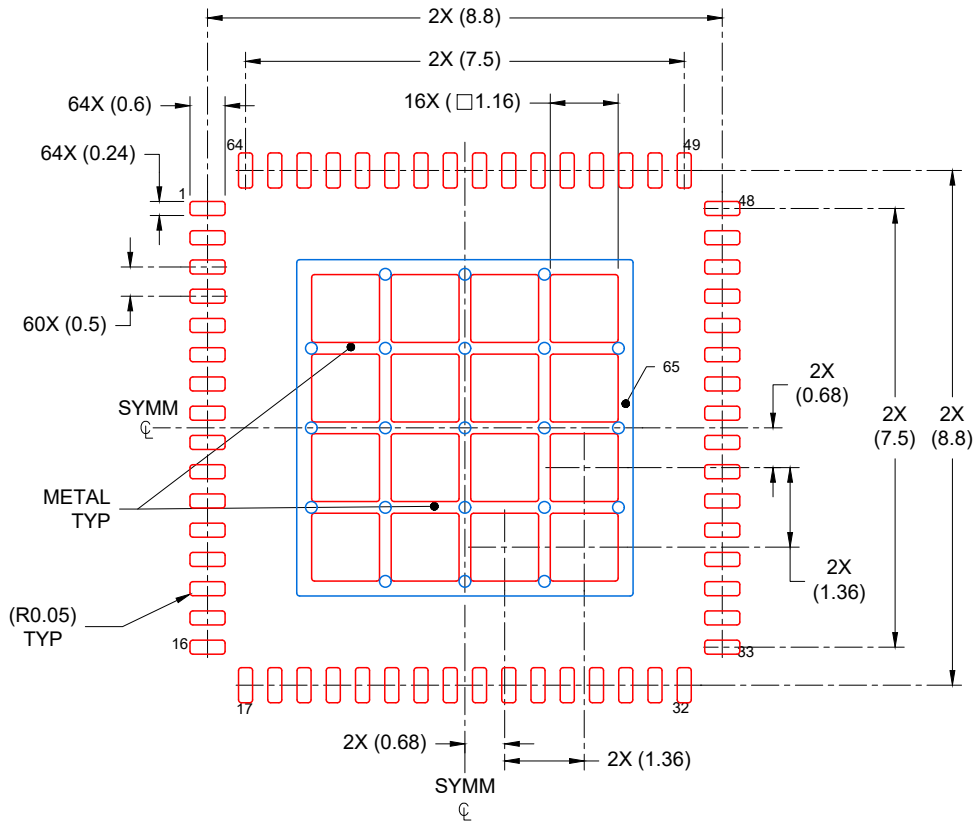


SOLDER MASK DETAILS

4224668/A 11/2018

NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/sluea271).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



SOLDER PASTE EXAMPLE
 BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD
 65% PRINTED COVERAGE BY AREA
 SCALE: 8X

4224668/A 11/2018

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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